

# ZSSC3240

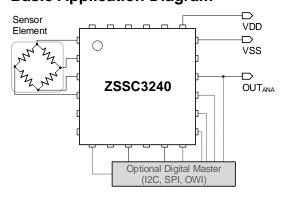
Sensor Signal Conditioner IC for Resistive Sensors

## **Description**

The ZSSC3240 is a sensor signal conditioning IC (SSC) for highly accurate amplification, digitization, and sensor-specific correction of resistive sensor signals. The ZSSC3240 is suitable for bridge and half-bridge sensors, as well as external voltage-source element and single-element sensors (e.g., Pt100 and external temperature sensor diodes) powered by an on-chip current source. Digital compensation of the sensor offset, sensitivity, temperature drift, and non-linearity is accomplished via a 26-bit math core running a correction algorithm with calibration coefficients stored in a non-volatile, reprogrammable memory. The programmable, integrated sensor front-end allows optimally applying various sensors for a broad range of applications.

The ZSSC3240 provides measurement value readouts and programming capabilities via an I2C, SPI, or one-wire interface (OWI). Three different operation modes allow optimal development of digital, digital-analog, and analog-output smart sensor modules including wake-up on request, continuous-on/fast-response, and automatic/cyclic sensor measurement operations. Absolute and ratiometric voltage, current-loop, or interrupt analog outputs are supported by the ZSSC3240. The analog output options and digital interface options (for calibration and/or a digital application interface) can be combined.

#### **Basic Application Diagram**



#### **Features**

- · Digital communication and calibration interfaces
  - 。 SPI up to 10MHz
  - <sub>o</sub> I2C (Standard, Fast, and High-Speed Mode)
  - one-wire-interface (OWI), up to 100kBit/s
- Accommodates nearly all resistive bridge sensor types (signal spans from 1mV/V up to 500mV/V)
- Supports different sensor element configurations:
  - 。 Resistive bridge or half-bridge
  - Resistive divider string
  - Voltage source
- · On-chip temperature sensor
- External temperature sensing supported, e.g. sensor-bridge as temperature detector, external diode, etc.
- Support for Pt100
- Programmable 16-bit digital-to-analog-converter and output:
  - 。 (0V to 1V) or (0V to 5V) absolute voltage output
  - 。 V<sub>DD</sub>-ratiometric voltage output
  - 。 4mA to 20mA current-loop output supported
  - 0V to 10V absolute-voltage output supported
- On-chip voltage regulators for sensor supply, and IC operation
- Support for extra regulation by external transistor, for example JFET
- Programmable 24-bit sensor-signal-conditioning math core
- Reprogrammable, nonvolatile memory (NVM)
- Programmable measurement scheduler for continuous sensing applications, with optimized balance of
  - 。 Energy consumption
  - Output update rate
  - Sensor-signal-conditioning accuracy
  - Self-diagnostic coverage and system safety
- · On-chip diagnostics:
  - Sensor connection
  - Broken-chip-check / chipping-check
  - Memory integrity

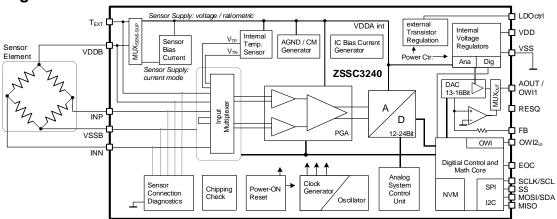
## **Physical Characteristics**

- Supply voltage, V<sub>DD</sub>: 2.7V to 5.5V; with external transistor, for example JFET: 5V to 48V
- Operating temperature: -40°C to 125°C
- Supported sensor elements:  $0.5k\Omega$  to  $60k\Omega$
- Available as die on wafers or 4 x 4 mm<sup>2</sup> 24-QFN with wettable flanks, allowing visual inspection of QFN reflow quality

### **Typical Applications**

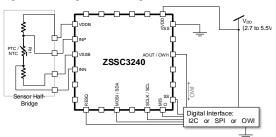
- Calibrated, continuously operating sensors with digital interface and/or analog output: (absolute or ratiometric) voltage or current loop output
- Enables smart, digital sensors for energy-efficient solutions
- · Pressure, flow, and level sensing
- Industrial applications; e.g. process/factory automation
- Consumer / white goods, e.g. HVAC, weight scales
- Medical applications, e.g. blood pressure, continuous smart health monitors

## **Block Diagram**

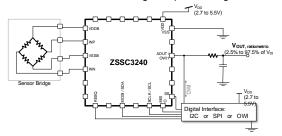


# **Typical Application Examples**

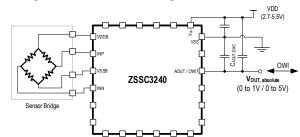
Digital Half-Bridge Sensor, e.g. PT100



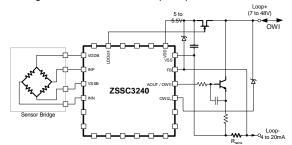
Sensor with Ratiometric Voltage Output and Digital Interface



Analog Sensor with Absolute Voltage Out



Analog Sensor with Current Loop Output, OWI, and External JFET



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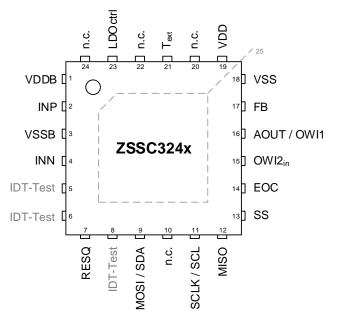
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# 1. Pin Assignments

The ZSSC324x is available as 8-inch wafers and in a 24-QFN package. Detailed information about die and wafers is available on request (see last page for contact information).



——— : QFN-bottom plate, Exposed PAD.

Figure 1. Pin Assignments for 4 × 4 mm<sup>2</sup> 24-QFN Package – Top View

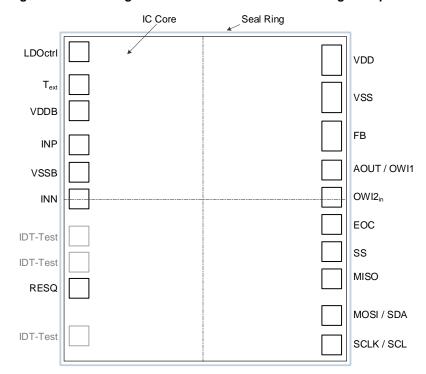


Figure 2. Pin (Pad) Assignments for Bare Die

# 2. Pin Descriptions

Table 1. Pin Descriptions

| Pin Number | Name               | Туре                                      | Description                                                                                                                                                                  |
|------------|--------------------|-------------------------------------------|------------------------------------------------------------------------------------------------------------------------------------------------------------------------------|
| 1          | VDDB               | Analog<br>Input/Output                    | Positive sensor (bridge) supply or sensor-signal input.                                                                                                                      |
| 2          | INP                | Analog Input                              | Positive sensor (bridge) signal.                                                                                                                                             |
| 3          | VSSB               | Analog Input                              | Sensor (bridge) ground or sensor-signal input.                                                                                                                               |
| 4          | INN                | Analog Input                              | Negative sensor (bridge) signal.                                                                                                                                             |
| 5          | IDT-test           | _                                         | Renesas-internal use only. Connect to VSS or no connection; leave pin floating.                                                                                              |
| 6          | IDT-test           | _                                         | Renesas-internal use only. Connect to VSS or no connection; leave pin floating.                                                                                              |
| 7          | RESQ               | Digital Input                             | Digital IC reset (low active); internal pull-up.                                                                                                                             |
| 8          | IDT-test           | _                                         | Renesas-internal use only. Connect to VSS or no connection; leave pin floating.                                                                                              |
| 9          | MOSI/SDA           | Digital<br>Input/Output                   | Digital data input for SPI or bidirectional data I/O for I2C. Pull-up to VDD.                                                                                                |
| 10         | n.c.               | -                                         | No connection. Leave pin floating.                                                                                                                                           |
| 11         | SCLK/SCL           | Digital Input                             | Clock input for SPI or I2C interface. Referenced to applied VDD level.                                                                                                       |
| 12         | MISO               | Digital Output                            | Data output from ZSSC3240 to master for SPI interface. Referenced to applied VDD level.                                                                                      |
| 13         | SS                 | Digital Input                             | Slave select (interface enable) for SPI. Referenced to applied VDD level.                                                                                                    |
| 14         | EOC                | Digital Output                            | End-of-conversion and output interrupt signal.                                                                                                                               |
| 15         | OWI2 <sub>in</sub> | Digital Input                             | Optional OWI interface input line for current-loop applications.                                                                                                             |
| 16         | AOUT/OWI1          | Analog Output;<br>Digital<br>Input/Output | Analog smart-sensor output signal and/or OWI-interface input/output line.  Short-circuit protection, capping the short-circuit current at 10-12mA.                           |
| 17         | FB                 | Analog Output                             | Current-loop application feedback output (level below VSS!). No connection if not used.                                                                                      |
| 18         | VSS                | Ground                                    | Power supply ground.                                                                                                                                                         |
| 19         | $V_{DD}$           | Supply                                    | Power supply.                                                                                                                                                                |
| 20         | n.c.               | _                                         | No connection. Leave pin floating.                                                                                                                                           |
| 21         | T <sub>EXT</sub>   | Analog Output                             | Current drive output for external temperature sensor and/or bridge in Current Mode. A $150\Omega$ serial resistor is built in the IC internally for pad-protection purposes. |
| 22         | n.c.               | _                                         | No connection. Leave pin floating.                                                                                                                                           |
| 23         | LDOctrl            | Analog Output                             | Control output (reference signal) for (optional) external regulator / supply control loop.                                                                                   |
| 24         | n.c.               | _                                         | No connection. Leave pin floating.                                                                                                                                           |
| 25         | Exposed PAD        |                                           | QFN-bottom plate, i.e. Die-bottom/substrate. Connect to VSS, PAD to be used for heat dissipation and additional EMC robustness.                                              |

# 3. Absolute Maximum Ratings

The absolute maximum ratings are stress ratings only. Stresses greater than those listed below can cause permanent damage to the device. Functional operation of the ZSSC3240 at absolute maximum ratings is not implied. Exposure to absolute maximum rating conditions might affect device reliability.

Table 2. Absolute Maximum Ratings

| Symbol        | Parameter                          | Conditions                         | Minimum | Maximum | Units |
|---------------|------------------------------------|------------------------------------|---------|---------|-------|
| TJ            | Junction temperature               |                                    |         | 135     | °C    |
| Ts            | Storage temperature                |                                    | -45     | 150     | °C    |
|               | ESD – Human Body Model             |                                    |         | 4000    | V     |
|               | ESD – Charged Device Model         |                                    |         | 750     | V     |
|               | Latch-up                           |                                    | -100    | +100    | mA    |
| $V_{DD\_max}$ | Maximum allowed for voltage supply | Referenced to VSS.                 | -0.3    | 6.5     | V     |
| $V_{IF\_max}$ | Voltage at digital interface pins  | I2C pins: SDA, SCL                 | -0.3    | 5.5     | V     |
| $V_{FB\_max}$ | Voltage at FB pin                  | 4mA to 20mA current loop interface | -2      | 2       | V     |

# 4. Recommended Operating Conditions

Table 3. Recommended Operating Conditions

| Symbol                    | Parameter                                                                                                     | Minimum | Typical | Maximum | Units   |
|---------------------------|---------------------------------------------------------------------------------------------------------------|---------|---------|---------|---------|
| $V_{DD}$                  | Power supply voltage                                                                                          |         | _       | 5.5     | V       |
| T <sub>A</sub>            | Ambient temperature (depending on the part code)                                                              | -40     | _       | 125     | °C      |
|                           | External (parasitic) capacitance between VDD and VSS, without external supply transistor regulation           | 0       | 10      | _       | nF      |
| $C_{VDD}$                 | External (parasitic) capacitance between VDD and VSS, with (optional) external supply transistor regulation   | 80      | 100     | 120     | nr<br>I |
| $C_{\text{VDDB,EMC}}$     | Recommended, external capacitance between VDDB and VSS for electro-magnetic immunity (EMI)                    | 0       | 6.8     | 8       | nF      |
| $C_{AOUT,EMC}$            | Recommended, external capacitance between AOUT versus VSS, and versus VDD for EMI [a]                         | 0       | 22      | 33      | nF      |
| I <sub>Sensor</sub>       | Load current through external sensor element [b]                                                              | 0.02    | 0.5     | 4       | mA      |
| $V_{DioDrop}$             | External temperature diode and RTD input range, drop over external element referenced to T <sub>EXT</sub> pin | -0.2    | -       | 1       | V       |
| $V_{Sens\_in}$            | Absolute sensor signal input level, INN, INP pins                                                             | 0.5     | _       | 1.2     | V       |
| VDDB <sub>ratio_min</sub> | Minimum level at VDDB [b]                                                                                     | 0.9     | _       | _       | V       |
| VSSB <sub>ratio_max</sub> | Maximum level at VSSB [b]                                                                                     | -       | _       | 0.7     | V       |
| I <sub>max_AOUT_V</sub>   | Maximum current load at AOUT pin for voltage outputs                                                          | -       | -       | 18      | mA      |
| $SR_{VDD\_POR}$           | Recommended V <sub>DD</sub> rise slew rate for power-on-reset (POR) <sup>[c]</sup>                            | 1.5     | _       | _       | V/ms    |

<sup>[</sup>a] For applications with OWI-interface or analog voltage-output.

# 5. Electrical Characteristics

All parameter values are valid only under specified operating conditions. All voltages are referenced to Vss.

Table 4. Electrical Characteristics

Note: See important notes at the end of this table.

| Symbol            | Parameter                                  | Conditions                                                                     | Minimum | Typical | Maximum   | Units |
|-------------------|--------------------------------------------|--------------------------------------------------------------------------------|---------|---------|-----------|-------|
|                   | IC Supply                                  |                                                                                |         |         |           |       |
| I <sub>IC</sub>   | Current consumption, active IC             | Excluding connected sensor elements (with LDOctrl enabled)                     | _       | 2.3     | 2.80      | mA    |
| I <sub>IDLE</sub> | Idle current consumption, IC in Idle State | Typical value at 30°C, maximum value at 85°C (125°C)  OWI and LDOctrl disabled | -       | 1.5     | 6<br>(22) | μА    |

<sup>[</sup>b] With ratiometric sensor supply configuration; e.g. a ratiometric bridge or bridge as temperature sensor with internal or external Rt.

<sup>[</sup>c] Per design, there is no (theoretical) minimum V<sub>DD</sub> slew rate to trigger a clean POR. Nevertheless, a reasonable slew rate is recommended.

| Symbol                         | Parameter                                                                                             | Conditions                                                                                                              | Minimum                  | Typical                  | Maximum                   | Units  |
|--------------------------------|-------------------------------------------------------------------------------------------------------|-------------------------------------------------------------------------------------------------------------------------|--------------------------|--------------------------|---------------------------|--------|
| I <sub>AVE</sub>               | Average current draw                                                                                  | Mean current consumption for one complete SSC measurement cycle per second at 16-bit digital-only output                | _                        | -                        | 3.5                       | μА     |
| $V_{DD,LDOctrl}$               | Target level regulation range to generate V <sub>DD</sub> after external transistor, for example JFET | Using LDOctrl and external transistor; programmable setup: VDD_ldoctrl_target (see section 6.7)                         | 4.6                      | 5.2                      | 5.5                       | V      |
|                                |                                                                                                       | Sensor Supply                                                                                                           |                          |                          |                           |        |
| I <sub>SUP</sub>               | Sensor bias                                                                                           | In the case of a Current Mode sensor                                                                                    | 5                        | 80                       | 500                       | μA     |
| Err <sub>TBIAS</sub>           | Relative sensor bias current error [a]                                                                | supply; setup in temp_source and sensor_sup (see section 6.2)                                                           | -3.5                     | -1                       | 1.5                       | %      |
| $V_{TBIAS}$                    | Drop over sensor bias current source                                                                  | referenced VDDA <sub>int</sub> from internal analog regulator                                                           | _                        | 200                      | 230                       | mV     |
| VDDB<br>(VDDA <sub>int</sub> ) | Internally regulated analog (bridge) sensor front-end supply                                          | In the case of a ratiometric sensor supply, setup in <i>temp_source</i> and <i>sensor_sup</i>                           | 1.68                     | 1.75                     | 1.80                      | V      |
| PSRR <sub>LOW</sub>            | Power supply rejection ratio <sup>[b]</sup> , only internal                                           | Attenuation of $V_{DD}$ fluctuations in the range of $f_{VDD} = 0$ Hz to 10MHz                                          | 45                       | 50                       | _                         | dB     |
| PSRR <sub>HIGH</sub>           | regulator                                                                                             | $f_{VDD} > 10MHz$                                                                                                       | 20                       | _                        | _                         | dB     |
|                                | T =                                                                                                   | Analog-to-Digital Converter (ADC, A2D                                                                                   |                          |                          | <u> </u>                  |        |
| rADC                           | Resolution                                                                                            |                                                                                                                         | 12                       | 16                       | 24                        | Bit    |
| $f_{S,raw}$                    | Single-conversion rate, conversions per second                                                        | Single external sensor A2D conversion (without auto-zero measurement AZ); resolution dependent                          | 0.21<br>(ADC:<br>24-bit) | 3.39<br>(ADC:<br>16-bit) | 13.00<br>(ADC:<br>12-bit) | kHz    |
| V <sub>ADCmid</sub><br>(AGND)  | Differential ADC input common mode [c]                                                                | With internal regulator supplying VDDB pin, typical: VDDB/2 = 875mV (equals PGA output common mode level)               | _                        | 0.5                      | _                         | VDDB   |
| ENOB [9]                       | Effective number of bits, $3\sigma_{\text{Noise}}$ based                                              | For gain < 78, shorted input, rADC = 24-bit, no oversampling                                                            | 15.8                     | 18.1                     | _                         | Bit    |
|                                |                                                                                                       | ital-to-Analog Converter (DAC) and Analog                                                                               |                          |                          | 1                         | 5      |
| r <sub>DAC</sub>               | Resolution                                                                                            | The a fire as 000% at a site at a track and 1 000% af                                                                   | 13                       | 14                       | 16                        | Bit    |
| t <sub>DACsettle</sub>         | Analog voltage output settling time                                                                   | Time from 30% steady state until 99% of<br>new DAC output (100% out) value is<br>reached; varies with level differences | 0                        | 65                       | 150                       | μs     |
|                                | Addresselle eutput                                                                                    | Absolute output, $Aout\_setup = 010_{BIN}$ (see section 6.5.3.1)                                                        | 0.025                    | _                        | 1                         | V      |
| $V_{DACout}$                   | Addressable output voltage at AOUT pin                                                                | Absolute output, $V_{DD} > 5.01V$ ,<br>$Aout\_setup = 011_{BIN}$                                                        | 0.025                    | _                        | 5                         | V      |
|                                |                                                                                                       | Ratiometric output, Aout_setup = 001 <sub>BIN</sub>                                                                     | 0.1                      | _                        | 100                       | %VDD   |
| BW <sub>DAC</sub>              | Output filter bandwidth                                                                               | Without external components                                                                                             | 12                       | 15                       | 20                        | kHz    |
| $SR_out$                       | Output slew rate                                                                                      | Resistive load > $2k\Omega$ ,<br>capacitive load < $20nF$ at Aout,<br>temperature = $25^{\circ}C$                       | 20                       | 100                      | -                         | mV/µs  |
| I <sub>OUTmax</sub>            | Maximum output current                                                                                | This current level must be overdriven from an OWI-Master, if concurrent DAC-output and OWI communication is configured. | 10                       | 12                       | 18                        | mA     |
| I <sub>DRIoop</sub>            | Current loop driving current                                                                          | Aout_setup = 000 <sub>BIN</sub> ; depends on connected bipolar transistor for current loop application                  | _                        | 100                      | 160                       | μΑ     |
|                                | To:                                                                                                   | Programmable-Gain Amplifier (PGA)                                                                                       |                          | 1                        | F 10                      | 1/2/   |
| G <sub>amp</sub>               | Gain                                                                                                  | 120 steps                                                                                                               | 1.32                     | _                        | 540                       | V/V    |
| G <sub>err</sub>               | Gain error Supported input common mode                                                                | Referenced to nominal gain, T = 25°C  VDDA <sub>int</sub> = 1.75V, valid for ratiometric and current mode sensor supply | -2.5<br>0.70             | 0.85                     | 2.5<br>1.00               | %<br>V |
|                                | 1                                                                                                     | Sensor Signal Conditioning Performan                                                                                    | ce                       | 1                        | 1                         | 1      |
|                                |                                                                                                       | Cyclic operation                                                                                                        | 0.07                     | 1.45                     | 2.91                      | kHz    |
| $f_{\sf SSCout}$               | Output (Update) rate [d]                                                                              | SSC-corrected (S, T) digital output rate, ADC:16-bit (see section 6.5.1)                                                | _                        | 1.20                     | -                         | kHz    |
|                                | (-)                                                                                                   | Complete SSC cycle ( <i>S</i> , <i>T</i> ) including analog output update; ADC: 14-bit; DAC: 14-bit                     | 1.35                     | 1.45                     | 1.60                      | kHz    |
|                                | •                                                                                                     |                                                                                                                         | •                        | •                        | •                         |        |

| Symbol                                                                        | Parameter                                                                     | Conditions                                                                                                          | Minimum | Typical | Maximum | Units    |
|-------------------------------------------------------------------------------|-------------------------------------------------------------------------------|---------------------------------------------------------------------------------------------------------------------|---------|---------|---------|----------|
| $Err_{A,IC}$                                                                  | error sensor (in temperature and measurand)                                   |                                                                                                                     | _       | -       | 0.01    | % FSO    |
| V <sub>ioffsc</sub> Correctable (in PGA), absolute, differential input offset |                                                                               | Programmable in 1mV steps; accuracy: ±5% referenced to nominal setup                                                | -15     | 0       | 15      | mV       |
| $\Delta_{ADC,c}$                                                              | Correctable (in ADC),<br>relative, differential input<br>offset               | Percentage of sensor signal offset versus maximum sensor signal                                                     | 0       | _       | 98      | %        |
|                                                                               |                                                                               | Input                                                                                                               |         |         |         |          |
| $V_{INP},V_{INN}$                                                             | Absolute sensor input                                                         | Voltages at INP and INN pin; resulting minimum/maximum differential voltages: -700mV < V <sub>INdiff</sub> < 700mV  | 0.5     | _       | 1.20    | V        |
| $V_{TEXT}$                                                                    | External temperature diode or RTD input range                                 | At T <sub>EXT</sub> pin                                                                                             | 0.5     | _       | 1.25    | V        |
| D                                                                             | External sensor (bridge)                                                      | VDDB = 1.75V                                                                                                        | 0.5     | _       | 60      | kΩ       |
| R <sub>SENSOR</sub>                                                           | resistance                                                                    | For 4mA to 20mA current loop output                                                                                 | 1.6     | _       | 60      | kΩ       |
| $ V_{\text{DIFFin}} $                                                         | Differential input signal range                                               | Referenced to sensor supply (VDDA <sub>int</sub> ); leading to full scale analog excitation                         | 2.6     | 50      | 700     | mV       |
|                                                                               |                                                                               | Diagnostics                                                                                                         |         |         |         |          |
| $R_{open}$                                                                    | Sensor connection loss; i.e., open threshold                                  | INP vs. INN                                                                                                         | 70      | _       | _       | kΩ       |
| $R_{short}$                                                                   | Sensor connection short threshold                                             | INP vs. INN; T <sub>EXT</sub> vs. VDDB                                                                              | _       | -       | 100     | Ω        |
| $V_{s,valid}$                                                                 | Valid sensor input signal                                                     | Beyond V <sub>s,valid</sub> , sensor connection checks (such as in-range, etc.) signalize Diagnostic <i>FAULT</i> s | 0.44    | _       | 1.31    | V        |
|                                                                               | •                                                                             | Power-Up                                                                                                            | •       | •       |         | •        |
| t <sub>STA1</sub>                                                             | Start-up Time                                                                 | V <sub>DD</sub> ramp up to interface communication                                                                  | _       | _       | 2       | ms       |
| t <sub>STA2</sub>                                                             | Otart up Time                                                                 | V <sub>DD</sub> ramp up to analog operation                                                                         | _       | _       | 2.5     | ms       |
| t <sub>WUP1</sub>                                                             | Wake-up Time                                                                  | Sleep to Active State interface communication                                                                       | _       | 2       | 10      | μs       |
| t <sub>WUP2</sub>                                                             |                                                                               | Sleep to Active State analog operation                                                                              | _       | _       | 2       | ms       |
|                                                                               | 1                                                                             | Oscillator                                                                                                          | T       | ı       | 1       | 1        |
| $f_{\text{CLK}}$                                                              | Internal oscillator frequency                                                 |                                                                                                                     | 5.9     | 6.0     | 6.1     | MHz      |
|                                                                               |                                                                               | Temperature Sensor(s)                                                                                               |         |         |         |          |
| $\mathbf{r}_{Temp}$                                                           | Internal temperature sensor resolution                                        | Setup: ADT <sub>Tsens,int</sub> = 13-bit                                                                            | 12      | 35      | _       | Counts/K |
| Rt, Rt'                                                                       | Internal low TC <sup>[f]</sup> top/bottom resistance for external temperature | Programmable with internal_rt and extra_rt; applied if temp_source ε {010; 110} (see section 6.2.4)                 | 1.34    | _       | 40      | kΩ       |
|                                                                               | T                                                                             | Interface and Memory                                                                                                | T       | T .     | I .     | 1        |
| f <sub>C,SPI</sub>                                                            | SPI clock frequency                                                           |                                                                                                                     | 0.05    | 1       | 12      | MHz      |
| f <sub>C,I2C</sub>                                                            | I2C clock frequency                                                           |                                                                                                                     | -       | _       | 3.4     | MHz      |
| CD <sub>owl</sub>                                                             | OWI data rate                                                                 |                                                                                                                     | 0.33    | -       | 10      | kBit/s   |
| t <sub>PROG</sub>                                                             | NVM program time                                                              | Programming time per 16-bit word                                                                                    | -       | 3       | 7       | ms       |
| n <sub>NVM</sub>                                                              | NVM endurance                                                                 | Number of reprogramming cycles                                                                                      | 1000    | 10000   | _       | Numeric  |
| t <sub>RET,NVM</sub>                                                          | Data retention                                                                |                                                                                                                     | 10      | _       | _       | Years    |

- [a] Referenced to nominal value. Relative errors are typically < 1% for sensor bias current setups > 20µA.
- [b] PSRR = 20·log<sub>10</sub>(V<sub>DD</sub>/V<sub>DDB</sub>): will be improved when applying external filter elements at V<sub>DD</sub> and/or also using an external JFET regulator.
- [c] This parameter must be taken into account if automatic common mode regulation in the PGA is switched off (pga\_en\_shift; see section 6.2.1) and a non-symmetric sensor supply and input to the PGA ADC path have been configured.
- [d] There are several setups and parameters that allow optimizing and maximizing the output update rate; e.g., ADC and DAC resolutions, configurations for the measurement sequence, usage of the internal or an external temperature sensor.
- [e]  $V_{\text{loffsc}}$  and  $\Delta_{\text{ADC,c}}$  can be arbitrarily set up and combined. They work independently on each other.
- [f] Typical residual temperature variation of voltage across Rt, Rt': 10ppm/K; maximum deviation: 150ppm/K at 40kΩ and >100°C, all other setups and conditions < 60ppm/K.
- [g] ENOB =  $log_2(2^{rADC} / 3\sigma_{Noise})$  with, for example rADC[Bit] = 24.

# 6. Device Description

The ZSSC3240 can be set up to for one of three main operating modes:

Sleep Mode

The Sleep Mode is recommended for smart sensors with purely digital output. The ZSSC3240 automatically enters the idle state after command execution for minimum current consumption, whereas the interface is still listening and accepts commands. After receiving a valid command, the ZSSC3240 wakes up, executes the command, provides the results at the digital interface, where the results must be read, and returns to idle state after the data fetch. The results are only available once; repeated data fetch is not supported. In Sleep Mode, sensor measurement results cannot be provided at the analog output of ZSSC3240.

**Command Mode** 

The Command Mode is most appropriate for evaluation, test, and calibration purposes. In this mode, all commands are available, both digital and analog outputs are supported and all functionality is available. Command Mode can be used for applications requiring re-occurring (or even continuous) digital interaction, potential analog output, and minimum latency. Applications in Command Mode are only active on command request.

**Cyclic Mode** 

In Cyclic Mode, autonomous, cyclically repeated sensor measurements are performed and related digital and/or analog output updates are provided. Cyclic Mode is recommended for analog output applications. The cyclic sequence for measurements, diagnostics, and hence the output update rate is configurable.

The ZSSC3240 always enters the programmed *default\_mode* after power-on (reset). One of the three operating modes can be set up as the default. After the ZSSC3240 is powered and has entered its default mode, changing to one of the other operating modes is possible via the mode change and start commands: *START\_CM*, *START\_SLEEP* (see section 6.6.1 for details).

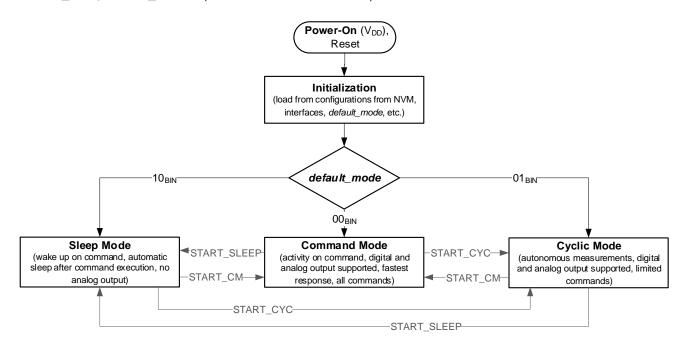


Figure 3. Main Operating Modes of the ZSSC3240

The ZSSC3240 supports three different types of digital interfaces: I2C, SPI, and OWI. All interface types allow application and control of each of the main operating modes.

Exception: The combination of Sleep Mode as the default mode (see the *default\_mode* bit in the *SSF1* register in Table 34) and the OWI interface is not supported. The OWI interface must be disabled (*owi\_off* = 1, bit[13] in the *SSF1* register) for correct Sleep Mode operation.

When using commands to change the operating mode, e.g. *START\_CM* or *START\_SLEEP*, validation of the new operating mode is recommended; e.g., by reading an NVM register or simply retrieving the status byte.

Note: The ZSSC3240 always requires two or more interface command interactions after an operating mode change prior to any additional changes in the mode.

#### 6.1 Signal Flow

See the figures on page 2 for the ZSSC3240 block diagram and circuit diagrams for different input sensors. The ZSSC3240 supports two sensor supplies: ratiometric voltage and current mode, i.e., sensor current bias. In the ratiometric sensor-supply configuration, VDDB and the power supply for analog circuitry are provided by an onchip voltage regulator, which is optimized for power supply disturbance rejection (PSRR). To improve noise suppression, the digital blocks are powered by a separate voltage regulator. A power supervision circuit monitors all supply voltages and generates appropriate reset signals for initializing the digital blocks.

The System Control Unit controls the analog circuitry to perform the measurement types: external sensor, external or internal temperature, and offset measurement. The multiplexer selects the signal input to the amplifier, which can be the external signals from the input pins INP, INN, T<sub>EXT</sub>, VDDB, and VSSB or the internal temperature reference sensor signals. A full measurement request will trigger an automatic sequence of all measurement types and all input signals. The basic sensor signal source configuration is set up in the *SSF1* register (see Table 34) in the on-chip memory.

The programmable gain amplifier (PGA) consists of two stages with programmable gain values. The ZSSC3240 employs a programmable analog-to-digital converter (ADC) optimized for conversion speed and noise suppression. The programmable resolution from 12 to 24 bits provides flexibility for adapting the conversion characteristics. To improve power supply noise suppression, the ADC uses the external sensor supply voltage, e.g., VDDB for the ratiometric supply of a connected full-bridge sensor element, as its reference voltage leading to a ratiometric measurement topology. The remaining IC-internal offset and the sensor element offset, i.e., the overall system offset for the amplifier and ADC, can be canceled via an offset and auto-zero measurement, respectively.

The math core accomplishes the auto-zero, span, and 1<sup>st</sup> and 2<sup>nd</sup> order temperature compensation of the measured external sensor signal. The correction coefficients are stored in the non-volatile memory.

The ZSSC3240 supports SPI, OWI, and I2C interface communication for controlling the ZSSC3240, configuration, and measurement result output. Analog output signals can be provided, which are proportional to the sensor signal that has been compensated for nonlinearity and temperature. The ZSSC3240 can also check and signalize numerous sensor and self-check diagnostic values.

# 6.2 Analog (Sensor) Front-End

The main blocks and functions of the analog sensor front-end of the ZSSC3240 are illustrated in Figure 4. As a typical first setup, the type and supply of the connected (external) sensor element should be determined and configured. The *sensor\_sup* and *temp\_source* bits in the *SSF1* register (03<sub>HEX</sub>; see Table 34) of the NVM must be set up according to the connected sensor configuration.

Important: If using the current mode sensor biasing via the "Sensor Bias Current" block, which is configured with the *Tbiasout* bit field (see section 6.2.4), ensure that the selection for bias current combined with the dimensioning for the connected external sensor is within the input common mode constraints, V<sub>CMin</sub> (typical 0.85V) as defined in Table 4.

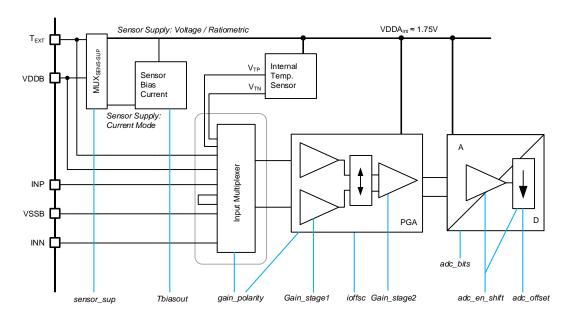


Figure 4. Analog Sensor Front-End Topology

#### 6.2.1. Programmable-Gain Amplifier (PGA)

The amplifier has a fully differential architecture and consists of two stages. The amplification of each stage and the external sensor gain polarity are programmable via settings in the measurement configuration register:

- For the main sensor element: SM\_config1 and SM\_config2 (NVM addresses 14HEX and 15HEX; see Table 34)
- For an optional external temperature sensor: extTemp\_config1 and extTemp\_config2 (NVM addresses 16HEX and 17HEX; see Table 34).

The first 7 bits of the \*\_config1 registers are the programmable gain settings Gain\_stage1 and Gain\_stage2. The options for the programmable gain settings are listed in Table 5 and Table 6. The resulting analog gain is the linear product of the stage 1 and stage 2 selection: Gain<sub>PGA</sub> = Gain<sub>1</sub> · Gain<sub>2</sub>. With the programmable Gain\_polarity bit in the \*\_config1 registers, the sign of the effective PGA gain can be swapped; e.g., to invert the sensor characteristic's slope and invert signal processing of the differential signal between INP and INN.

| Table 5. | PGA | Gain: | Stage ' | 1 |
|----------|-----|-------|---------|---|
|          |     |       |         |   |

|        | Gain_stage1[3:0] |        |        |              |  |
|--------|------------------|--------|--------|--------------|--|
| bit[3] | bit[2]           | bit[1] | bit[0] | Gain₁ [V/V]  |  |
| 0      | 0                | 0      | 0      | 1.2          |  |
| 0      | 0                | 0      | 1      | 2            |  |
| 0      | 0                | 1      | 0      | 4            |  |
| 0      | 0                | 1      | 1      | 6            |  |
| 0      | 1                | 0      | 0      | 12           |  |
| 0      | 1                | 0      | 1      | 20           |  |
| 0      | 1                | 1      | 0      | 30           |  |
| 0      | 1                | 1      | 1      | 40           |  |
| 1      | 0                | 0      | 0      | 60           |  |
| 1      | 0                | 0      | 1      | 80           |  |
| 1      | 0                | 1      | 0      | 120          |  |
| 1      | 0                | 1      | 1      | 150          |  |
| 1      | 1                | 0      | 0      | 200          |  |
| 1      | 1                | 0      | 1      | 240          |  |
| 1      | 1                | 1      | 0      | 300          |  |
| 1      | 1                | 1      | 1      | Not assigned |  |

Table 6. PGA Gain: Stage 2

|        | Gain_stage2[2:0]           bit[2]         bit[1]         bit[0] |   |     |  |  |
|--------|-----------------------------------------------------------------|---|-----|--|--|
| bit[2] |                                                                 |   |     |  |  |
| 0      | 0                                                               | 0 | 1.1 |  |  |
| 0      | 0                                                               | 1 | 1.2 |  |  |
| 0      | 1                                                               | 0 | 1.3 |  |  |
| 0      | 1                                                               | 1 | 1.4 |  |  |
| 1      | 0                                                               | 0 | 1.5 |  |  |
| 1      | 0                                                               | 1 | 1.6 |  |  |
| 1      | 1                                                               | 0 | 1.7 |  |  |
| 1      | 1                                                               | 1 | 1.8 |  |  |

In addition to the amplification of the sensor input signals, the PGA's first stage can perform an absolute offset shifting of the differential sensor signal. This shift operation can be programmed in 1mV steps with the configuration setup *ioffsc* bit field in the S*M\_config2* and *extTemp\_config2* registers. The effective voltage-shift depends on the selected Gain<sub>1</sub>, *Gain\_stage1*. The V<sub>IOFFSC</sub> values (in Table 8) correspond to the higher Gain<sub>1</sub> values, i.e. Gain<sub>1</sub> > 100. The PGA-operation including shift effect for a differential input signal, V<sub>DIFFin</sub> can be described as:

$$V_{ADC,IN} = Gain_2 \cdot Gain_1 \cdot (V_{DIFFin} + V_{IOFFSC}) - Gain_2 \cdot V_{IOFFSC}$$

**Equation 1** 

Table 7. Absolute Offset Shift - Properties

| Symbol                | Parameter                                                                                                                                                  | Minimum | Typical | Maximum | Units |
|-----------------------|------------------------------------------------------------------------------------------------------------------------------------------------------------|---------|---------|---------|-------|
| $\Delta_{IOFFSC}$     | Relative accuracy of the effectively applied Offset Shift referenced to the selected setup per <code>ioffsc[4:0]</code> , IC-to-IC variation               | 0.89    | 0.98    | 1.07    | -     |
| $TC_{neg,IOFFSC}$     | 1st order temperature coefficient for the change of the effective Offset Shift voltage for negative-voltage shift effects, i.e.<br>ioffsc[4]=0             | -0.25   | -0.21   | 0       | PPT/K |
| $TC_{pos,IOFFSC}$     | 1 <sup>st</sup> order temperature coefficient for the change of the effective Offset Shift voltage for positive-voltage shift effects, i.e.<br>ioffsc[4]=1 | 0       | 0.21    | 0.25    | PPT/K |
| SNR <sub>IOFFSC</sub> | Fluctuation of output offset signal (V <sub>IOFFSC</sub> ) versus nominal value at 25°C; 20-log10(V <sub>IOFFSC</sub> /ΔV <sub>IOFFSC</sub> )              | -       | 74      | _       | dB    |

The shifting can be configured independently for the main sensor and the optional, external temperature sensor. If the absolute offset shifting is enabled, then the ZSSC3240 current consumption increases by 100µA. The advantage of absolute offset shifting is an increase of analog dynamic range in the ZSSC3240's sensor frontend, which results in higher measurement result quality (less noise/fluctuations).

Table 8. Absolute Offset Shift – Differential Sensor Signal's Offset Compensation

|        |        | ioffsc[4:0] |        |        | Olive Ewart M                     |
|--------|--------|-------------|--------|--------|-----------------------------------|
| bit[4] | bit[3] | bit[2]      | bit[1] | bit[0] | Shift Effect, V <sub>IOFFSC</sub> |
| 0      | 0      | 0           | 0      | 0      | 0mV, no shift                     |
| 0      | 0      | 0           | 0      | 1      | -1mV                              |
| 0      | 0      | 0           | 1      | 0      | -2mV                              |
| 0      | 0      | 0           | 1      | 1      | -3mV                              |
| 0      | 0      | 1           | 0      | 0      | -4mV                              |
| 0      | 0      | 1           | 0      | 1      | -5mV                              |
| 0      | 0      | 1           | 1      | 0      | -6mV                              |
| 0      | 0      | 1           | 1      | 1      | -7mV                              |
| 0      | 1      | 0           | 0      | 0      | -8mV                              |
| 0      | 1      | 0           | 0      | 1      | -9mV                              |
| 0      | 1      | 0           | 1      | 0      | -10mV                             |
| 0      | 1      | 0           | 1      | 1      | -11mV                             |
| 0      | 1      | 1           | 0      | 0      | -12mV                             |
| 0      | 1      | 1           | 0      | 1      | -13mV                             |
| 0      | 1      | 1           | 1      | 0      | -14mV                             |
| 0      | 1      | 1           | 1      | 1      | -15mV                             |

|        |        | ioffsc[4:0] |        |        | Chitt Etta et V                   |
|--------|--------|-------------|--------|--------|-----------------------------------|
| bit[4] | bit[3] | bit[2]      | bit[1] | bit[0] | Shift Effect, V <sub>IOFFSC</sub> |
| 1      | 0      | 0           | 0      | 0      | 0mV, no shift                     |
| 1      | 0      | 0           | 0      | 1      | 1mV                               |
| 1      | 0      | 0           | 1      | 0      | 2mV                               |
| 1      | 0      | 0           | 1      | 1      | 3mV                               |
| 1      | 0      | 1           | 0      | 0      | 4mV                               |
| 1      | 0      | 1           | 0 1    |        | 5mV                               |
| 1      | 0      | 1           | 1      | 0      | 6mV                               |
| 1      | 0      | 1           | 1      | 1      | 7mV                               |
| 1      | 1      | 0           | 0      | 0      | 8mV                               |
| 1      | 1      | 0           | 0      | 1      | 9mV                               |
| 1      | 1      | 0           | 1      | 0      | 10mV                              |
| 1      | 1      | 0           | 1      | 1      | 11mV                              |
| 1      | 1      | 1           | 0      | 0      | 12mV                              |
| 1      | 1      | 1           | 0      | 1      | 13mV                              |
| 1      | 1      | 1           | 1      | 0      | 14mV                              |
| 1      | 1      | 1           | 1      | 1      | 15mV                              |

The PGA can perform an automatic adjustment for the PGA input to ADC input common mode. This can be enabled via the *pga\_en\_shift* bit in the \*\_config2 registers. The supportable input common mode range at the PGA, i.e. at the sensor front-end input, is constant per IC because it is derived from the internally regulated voltage VDDA<sub>int</sub>.

Table 9. PGA Input Span Ranges

| Total Gain, G <sub>AMP</sub> Examples | Gain₁ | Gain <sub>2</sub> | Max. Input Span, Differential Signal Range [mV] |
|---------------------------------------|-------|-------------------|-------------------------------------------------|
| 540                                   | 300   | 1.8               | 5.0                                             |
| 420                                   | 300   | 1.4               | 6.4                                             |
| 330                                   | 300   | 1.1               | 8.1                                             |
| 280                                   | 200   | 1.4               | 9.6                                             |
| 220                                   | 200   | 1.1               | 12.2                                            |
| 144                                   | 120   | 1.2               | 18.5                                            |
| 103                                   | 80    | 1.3               | 25.9                                            |
| 88                                    | 80    | 1.1               | 30.5                                            |
| 72                                    | 60    | 1.2               | 37.5                                            |
| 60                                    | 40    | 1.5               | 45                                              |
| 48                                    | 40    | 1.2               | 56                                              |
| 39                                    | 30    | 1.3               | 69                                              |
| 30                                    | 20    | 1.5               | 90                                              |
| 19.2                                  | 12    | 1.6               | 140                                             |
| 13.2                                  | 12    | 1.1               | 204                                             |
| 10.2                                  | 6     | 1.7               | 264                                             |
| 5.2                                   | 4     | 1.3               | 519                                             |
| 3.0                                   | 2     | 1.5               | 900                                             |
| 1.32 <sup>[a]</sup>                   | 1.2   | 1.1               | 1400                                            |

<sup>[</sup>a] There is a general PGA-input range constraint to support  $V_{\text{INdiff}}$  of  $\pm 700 \text{mV}$  at maximum, which is especially dominating for  $G_{\text{AMP}} < 2$ .

### 6.2.2. Analog-to-Digital Converter (ADC)

An analog-to-digital converter (ADC) is used to digitize the amplifier signal. To allow optimizing the trade-off between conversion time and resolution, the resolution can be programmed from 12-bit to 24-bit (adc\_bits bit fields in the SM\_config1, and extTemp\_config1 registers; see section 6.6.2.1). The ADC processes differential input signals around its input common mode level: VADCmid. Table 10 lists the ADC resolution, signal ranges, conversion times for a single Analog-to-Digital conversion.

| Table 10. | Single  | Analog-to  | -Digital         | Conversion  |
|-----------|---------|------------|------------------|-------------|
| Table IV. | Siliule | Alialog-it | <i>-</i> Digital | COLIVERSION |

|        | adc_b  | its[3:0] |        | ADC                  | Ratiometric ADC                                         | Absolute ADC                                            | Conversion            | Conversion             |
|--------|--------|----------|--------|----------------------|---------------------------------------------------------|---------------------------------------------------------|-----------------------|------------------------|
| Bit[3] | Bit[2] | Bit[1]   | Bit[0] | Resolution<br>[Bits] | Input Range <sup>[a]</sup> ,<br>V <sub>ADC,IN</sub> [V] | Input Range <sup>[b]</sup> ,<br>V <sub>ADC,IN</sub> [V] | Time, Typical<br>[µs] | Rate, Typical<br>[kHz] |
| 0      | 0      | 0        | 0      | 12                   | ±1.42                                                   | ±1.07                                                   | 162                   | 6.1                    |
| 0      | 0      | 0        | 1      | 13                   | ±1.43                                                   | ±1.08                                                   | 192                   | 5.2                    |
| 0      | 0      | 1        | 0      | 14                   | ±1.41                                                   | ±1.06                                                   | 235                   | 4.2                    |
| 0      | 0      | 1        | 1      | 15                   | ±1.42                                                   | ±1.07                                                   | 294                   | 3.4                    |
| 0      | 1      | 0        | 0      | 16                   | ±1.41                                                   | ±1.06                                                   | 380                   | 2.6                    |
| 0      | 1      | 0        | 1      | 17                   | ±1.42                                                   | ±1.07                                                   | 497                   | 2.0                    |
| 0      | 1      | 1        | 0      | 18                   | ±1.41                                                   | ±1.06                                                   | 670                   | 1.4                    |
| 0      | 1      | 1        | 1      | 19                   | ±1.42                                                   | ±1.07                                                   | 903                   | 1.1                    |
| 1      | 0      | 0        | 0      | 20                   | ±1.41                                                   | ±1.06                                                   | 1245                  | 0.8                    |
| 1      | 0      | 0        | 1      | 21                   | ±1.42                                                   | ±1.07                                                   | 1715                  | 0.5                    |
| 1      | 0      | 1        | 0      | 22                   | ±1.41                                                   | ±1.06                                                   | 2400                  | 0.4                    |
| 1      | 0      | 1        | 1      | 23                   | ±1.42                                                   | ±1.07                                                   | 3335                  | 0.3                    |
| 1      | 1      | 0        | 0      | 24                   | ±1.40                                                   | ±1.06                                                   | 4705                  | 0.2                    |
| 1      | 1      | 0        | 1      | Not assigned         | _                                                       | _                                                       | _                     | _                      |
| 1      | 1      | 1        | 0      | Not assigned         | _                                                       | -                                                       | _                     | _                      |
| 1      | 1      | 1        | 1      | Not assigned         | _                                                       | -                                                       | _                     | _                      |

<sup>[</sup>a] With the following settings: ratiometric reference, sel\_ref\* = 1, and no ADC-shift (adc\_en\_shift = 0) nor extra ADC-gain, i.e. Gain\_ADC=1

The ADC can perform an additional offset shift (independent of the PGA shifting with *ioffsc*) in order to adapt input signals with offsets to the ADC input range. The shift feature is enabled by setting  $adc\_en\_shift = 1$  (bit[8] in the  $SM\_config2$  or  $extTemp\_config2$  registers). As defined in Table 11, the respective analog offset shift can be selected with bits [14:12],  $adc\_offset$  in  $SM\_config1$  or  $extTemp\_config1$ .

Note: Enabling the offset shift causes the ADC to perform an additional amplification of the ADC's input signal by factor 2. This must be considered for a correct analog sensor setup by means of the PGA's gain, the absolute offset shift in the PGA, the ADC offset shift, and the potential ADC gain.

The overall analog amplification  $Gain_{TOTAL} = Gain_{PGA} \cdot Gain_{ADC}$  can be determined for the following potential use cases using Equation 2 or Equation 3 depending on the ADC offset setting:

If no ADC offset shift is selected, i.e.,  $adc\_en\_shift = 0$  and  $adc\_offset = 000$ , then

Gaintotal = Gainpga · 1 Equation 2

If ADC offset shift is selected, i.e.,  $adc_en_shift = 1$  ( $adc_offset$  is configurable), then

Gaintotal = Gainpga · 2 Equation 3

Table 11. ADC Offset Shift

|                          | adc_offset[2:0]      | Compensation of Percentage | ADC Input Signal               |                              |
|--------------------------|----------------------|----------------------------|--------------------------------|------------------------------|
| bit[2]                   | bit[1]               | bit[0]                     | Offset in Input Signal         | Range [V <sub>ADC,IN</sub> ] |
| 0                        | 0                    | 0                          | 0%                             | -0.5 to 0.5                  |
| 0                        | 0                    | 1                          | 6.25%                          | -0.44 to 0.56                |
| 0                        | 1                    | 0                          | -0.38 to 0.62                  |                              |
| 0                        | 1                    | 1                          | 18.75%                         | -0.31 to 0.69                |
| 1                        | 0                    | 0                          | 25.00%                         | -0.25 to 0.75                |
| 1                        | 0                    | 1                          | 31.25%                         | -0.19 to 0.81                |
| 1                        | 1 1 0                |                            | 37.50%                         | -0.13 to 0.87                |
| 1                        | 1                    | 1                          | 44.00%                         | -0.06 to 0.94                |
| ADC-offset shift disable | ed, adc_en_shift = 0 |                            | 0% (compensation, ×2-gain off) | -1 to +1                     |

<sup>[</sup>b] With the following settings: absolute reference, sel\_ref\* = 0, and no ADC-shift (adc\_en\_shift = 0) nor extra ADC-gain, i.e. Gain\_ADC=1

#### 6.2.3. Internal Temperature Sensor

The ZSSC3240 provides an internal temperature sensor measurement to allow compensation for temperature effects. The temperature output signal is a differential voltage that is adapted by the amplifier (PGA) for the ADC input, comparable to the external sensor's signal. For ZSSC3240-internal temperature measurements, the respective settings are defined and programmed in the NVM by Renesas.

#### 6.2.4. Supported Supplies for Sensor Elements and Additional, External Temperature Sensing

There are two options to supply and bias the external sensor element, which can be selected by the *sensor\_sup* bit field in the *SSF1* register (03<sub>HEX</sub>) in the NVM (see Table 34). The differential sensor signal (e.g., from a sensor bridge) is fed into the ZSSC3240 at the INP pin for the positive and the INN pin for the negative signal level.

Table 12. Sensor Supply Options

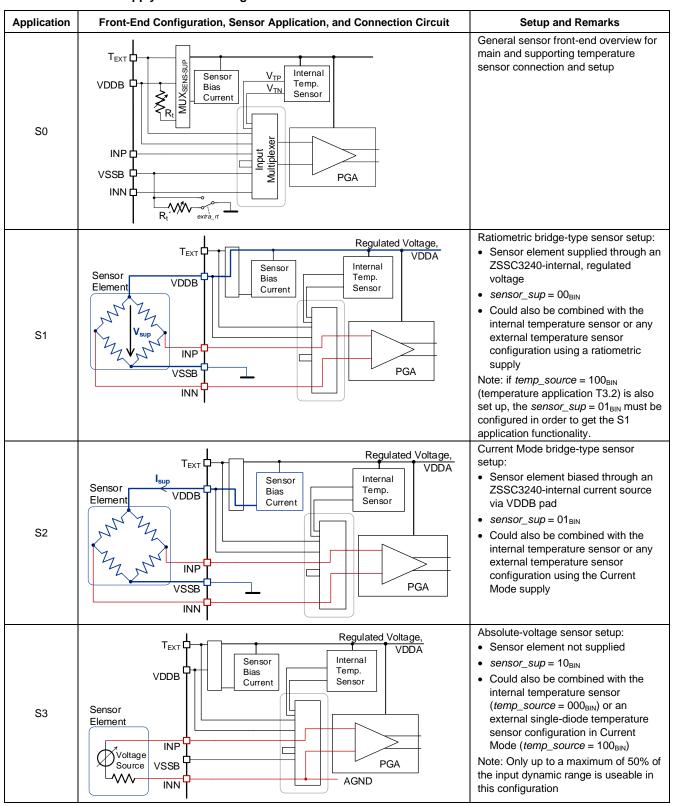
| sensor_sup[1:0] |        | External Sancar Symply                                                                                                   |
|-----------------|--------|--------------------------------------------------------------------------------------------------------------------------|
| bit[1]          | bit[0] | External Sensor Supply                                                                                                   |
| 0               | 0      | Ratiometric voltage: VDDB to VSSB.[a]                                                                                    |
| 0               | 1      | Bias current out of VDDB. [a]                                                                                            |
| 1               | 0      | No supply, INN internally connected to AGND, absolute voltage-source measurement (e.g., thermopile between INP and INN). |
| 1               | 1      | Not assigned.                                                                                                            |

<sup>[</sup>a] The combination of settings temp\_source = 100 and sensor\_sup=01 returns the sensor to be supplied by a ratiometric voltage.

There are multiple possible combinations of an external main sensing supply and the SSC-input signal generation with different sensing elements and approaches for generating a temperature signal for temperature-dependency compensation. Table 13 illustrates the possible sensor connections, application circuits, and ZSSC3240 configurations.

Note: The applications circuits S1 to S3 and T1 to T5 highlight the supply paths in blue and the input signal paths in red for the main sensing element connection and supply in Table 13 and for the supporting, external temperature sensing in Table 15.

Table 13. Sensor Supply - Main Sensing



For a ratiometric sensor supply, the VDDA<sub>int</sub> voltage from the ZSSC3240-internal regulator is used. As defined in Table 14, the alternative sensor bias current source generates a bias current that is programmable with the *Tbiasout* in bit field in the \*\_config2 registers (see Table 34).

|        | Tbiasout |        | Nominal Sensor    |
|--------|----------|--------|-------------------|
| bit[2] | bit[1]   | bit[0] | Bias Current [µA] |
| 0      | 0        | 0      | 5                 |
| 0      | 0        | 1      | 10                |
| 0      | 1        | 0      | 20                |
| 0      | 1        | 1      | 39                |
| 1      | 0        | 0      | 79                |
| 1      | 0        | 1      | 157               |
| 1      | 1        | 0      | 196               |

494

Table 14. Sensor Bias Currents - Sensor Sourcing in Current Mode

The ZSSC3240 supports internal and external temperature sensing for sensor-signal conditioning (SSC) purposes; i.e. an extra, separate temperature measurement in order to compensate temperature effects in the measurand signal from the main sensing element; e.g., a pressure sensor. The respective setup must be configured via the *temp\_source* bit field in the *SSF1* register.

If the main sensing element itself with its inherent temperature sensitivity is used to generate the temperature information for SSC correction, then the *internal\_rt* and *extra\_rt* bit fields in the *SFF1* register must be programmed. Table 15 provides an overview for the some of the supported temperature measurement options. The internal resistors *Rt* and *Rt'* have been designed for flat, almost zero-sensitivity to temperature, such that the resulting temperature sensor measurements' characteristic is mainly dominated only by the (typically spurious) temperature characteristic of the main sensor element itself. The use of the bottom resistance *Rt'*, selectable by *extra\_rt*, is recommended for most related applications in order to have a bridge-resistance-related, symmetric temperature excitation, and not to introduce further differential signal offset when using the bridge-sensor element as the temperature sensor.

In any configuration, the constraints for the minimum/maximum absolute and differential input signal dynamics must be considered.

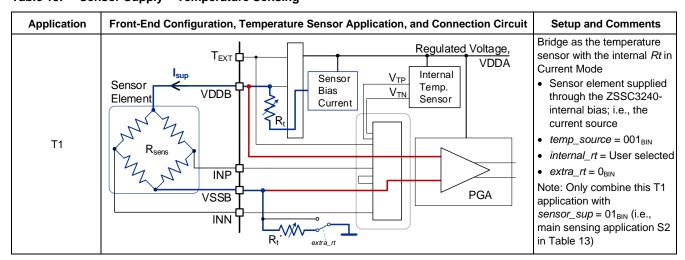
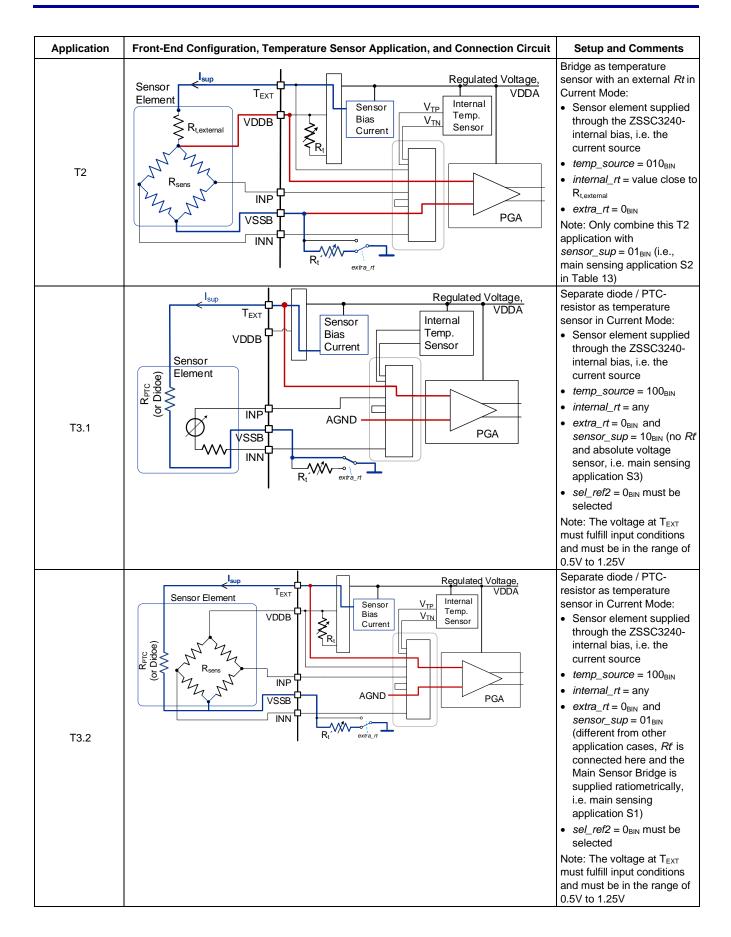
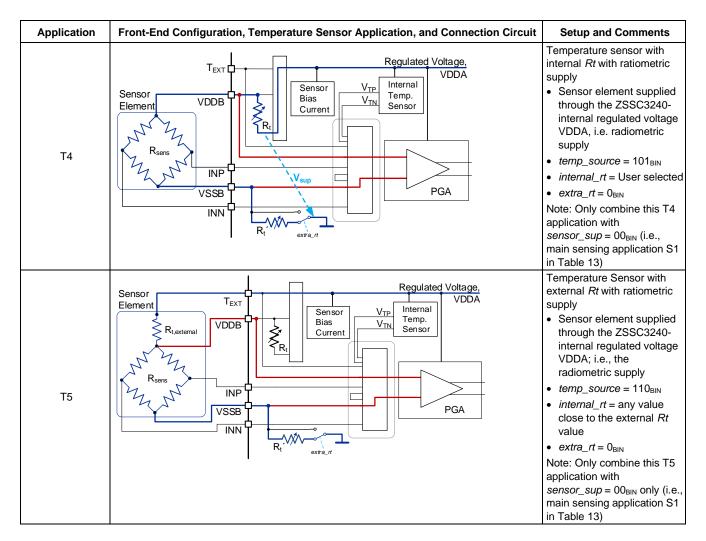


Table 15. Sensor Supply - Temperature Sensing





When using scenario T1, "Bridge as the temperature sensor with the internal Rt in Current Mode" in Table 15, the setup for bias current ( $I_{sup}$ ) and internal Rt must fulfill the requirements given in Equation 4 and Equation 5:

$$(0.5 \cdot R_{sens} + Rt) \cdot I_{sup} = 0.85V \pm 125mV$$

**Equation 4** 

Where R<sub>sens</sub> is the nominal resistance of the sensor element; i.e. the typical, effective resistance generating the differential sensor signal as input to the INP and INN pads.

Important: Take into consideration the maximum specifications for the PGA common mode input level, V<sub>Cmin</sub> (see Table 4).

$$(MAX[R_{sens}] - MIN[R_{sens}]) \cdot I_{sup} < 700 \text{mV}$$

**Equation 5** 

Important: Take into consideration the maximum specifications for the input signal,  $MAX[V_{DIFFin}]$  (see Table 4).

The best method for deriving the respective values for Rt and  $I_{sup}$  is to choose an Rt value close to but greater than  $R_{sens}$  and to calculate  $I_{sup}$  accordingly.

When using scenario T4, "*Temperature sensor with internal Rt with ratiometric supply*," in Table 15 the setup for bias current (I<sub>sup</sub>) and internal *Rt* must fulfill Equation 6:

Important: Take into consideration the maximum specifications for the PGA common mode input level,  $V_{Cmin}$ , which is automatically ensured if Rt and the extra Rt' are selected.

 $(MAX[R_{sens}] - MIN[R_{sens}]) / (R_{sens} + 2 \cdot Rt) \cdot VDDB_{typ} < 700 \text{mV}$ 

**Equation 6** 

Important: Take into consideration the maximum specifications for the input signal, MAX[ $V_{DIFFin}$ ] with  $VDDB_{typ} = 1.85$ V.

In most cases, a low *Rt* value will suffice for ratiometrically supplied configurations. The lower the applied *Rt* value, the less the noise-level effect onto the temperature measurement signal.

Sensor-bridge elements, which already contain a top resistor for temperature sensing purposes, can use the internal extra Rt.

## 6.3 On-Chip Diagnostics

The ZSSC3240 offers analog and digital self-test and sensor-diagnostic features to ensure robust system operation. If the part is programmed and operated with analog output ( $cont\_ANAoutn = 0_{BIN}$  in the SSF2 register; see Table 34), then diagnostic states are indicated by upper and lower levels at the AOUT pin; see Table 16. With the SPI, I2C, and OWI digital interfaces, the default status byte contains fault-diagnostics information. If further detailed diagnostic information is required, the  $CHECK\_DIAG$  command  $BO_{HEX}$  must be issued to retrieve the detailed diagnostics' results in the *diagnosticreg* output register. The content of *diagnosticreg* (see Table 17) is updated each time new respective diagnostic information becomes available. This is also the case with the default ZSSC3240 initialization after power-on-reset (POR) or if specific commands are triggered in order to perform diagnostic checks or influence *diagnosticreg*:

RESET DIAG, B1<sub>HEX</sub> Resets the contents of *diagnosticreg*.

UPDATE\_DIAG, B2<sub>HEX</sub> Performs all enabled diagnostic checks (selected via the select\_checks bit field

[9:0] in register 21<sub>HEX</sub> in NVM; see Table 34) and default diagnostic checks including checksum validation of the NVM; results in complete update of

diagnosticreg.

Connection Checks These are scheduled connection checks in the Cyclic Mode setup. All enabled

checks (as selected with select\_checks) are performed, and diagnosticreg is

updated accordingly.

The analog signalization of diagnostic states at the AOUT pin for the different analog output options can be enabled/disabled via the *diagouten* bit in the *SSF2* register 04<sub>HEX</sub> in the NVM (see Table 34). In Cyclic Mode, the analog signalization of a diagnostic state is present with the *SSC Calculation and Output Update* phase of the same measurement slot; see section 6.5.2. In Command Mode (with enabled analog output at AOUT pin), the diagnostic state at AOUT will be present with completion of the next SSC-conversion command, i.e. AA<sub>HEX</sub> or AC<sub>HEX</sub> to AF<sub>HEX</sub>; see Table 33).

Table 16. Diagnostic Signalization Options with ZSSC3240

| Detected Fault      | Analog Ratiometric Diagnostic Level, AOUT [a] | Analog Absolute Diagnostic OWI, SPI, I2C Statu<br>Level, AOUT [a] Byte [7:0] |                                  | Comments                             |
|---------------------|-----------------------------------------------|------------------------------------------------------------------------------|----------------------------------|--------------------------------------|
| No Error / Fault    | 2.5% to 97.5%                                 | 0.125 to 4.875 V <sup>[b]</sup>                                              | 01XX X000 <sub>BIN</sub>         | Status after "reset."                |
|                     | 2.0 /0 10 01.10 /0                            | 0.025 to 0.975 V <sup>[c]</sup>                                              | O 17 O C TO CO BIN               |                                      |
| Memory Error        | Lower                                         | 0 to 0.125 V <sup>[b]</sup>                                                  | 0XXXX1XX <sub>BIN</sub>          | Checksum failure of                  |
| Welliory Ellor      | Lower                                         | 0 to 0.025 V <sup>[c]</sup>                                                  | OXXXX <u>I</u> XXBIN             | NVM.                                 |
| Loss of INP         |                                               | 4.875 V to VDD [b]                                                           |                                  |                                      |
| Connection, INP     | Upper                                         | 0.975 to 1.0 V <sup>[c]</sup>                                                |                                  |                                      |
| Open <sup>[d]</sup> |                                               |                                                                              |                                  | A detailed, digital                  |
| Loss of INN         |                                               | 4.875 V to VDD [b]                                                           |                                  | decoding of the                      |
| Connection, INN     | Upper                                         | 0.975 to 1.0 V <sup>[c]</sup>                                                |                                  | respective connection                |
| Open <sup>[d]</sup> |                                               |                                                                              | 0100000414                       | check fault can be                   |
| INN or INP Signals  | Upper                                         | 4.875 V to VDD [b]                                                           | 0XXXXX <u>1</u> X <sub>BIN</sub> | fetched using the BO <sub>HEX</sub>  |
| Out of Range        | Оррсі                                         | 0.975 to 1.0 V <sup>[c]</sup>                                                |                                  | CHECK_DIAG<br>command, which returns |
| Bridge/Sensor       | Linnar                                        | 4.875 V to VDD [b]                                                           |                                  | the <i>diagnosticreg</i> register    |
| Short (INN=INP) [d] | Upper                                         | 0.975 to 1.0 V <sup>[c]</sup>                                                |                                  | content.                             |
| T ext Pin Open      | Lower                                         | 0 to 0.125 V <sup>[b]</sup>                                                  |                                  |                                      |
| 1_ext 1 iii Open    | Lowel                                         | 0 to 0.025 V <sup>[c]</sup>                                                  |                                  |                                      |

| Detected Fault     | Analog Ratiometric Diagnostic Level, AOUT [a] | Analog Absolute Diagnostic<br>Level, AOUT [a] | OWI, SPI, I2C Status<br>Byte [7:0] | Comments |
|--------------------|-----------------------------------------------|-----------------------------------------------|------------------------------------|----------|
| T_ext Pin Out of   | Lower                                         | 0 to 0.125 V <sup>[b]</sup>                   |                                    |          |
| Range              | Lowei                                         | 0 to 0.025 V <sup>[c]</sup>                   |                                    |          |
| T_ext Pin Short to | Lower                                         | 0 to 0.125 V <sup>[b]</sup>                   |                                    |          |
| INP                | Lower                                         | 0 to 0.025 V <sup>[c]</sup>                   |                                    |          |
| T_ext Pin Short to | Lauran                                        | 0 to 0.125 V <sup>[b]</sup>                   |                                    |          |
| INN                | Lower                                         | 0 to 0.025 V <sup>[c]</sup>                   |                                    |          |
| Die Crack /        | Lower                                         | 0 to 0.125 V <sup>[b]</sup>                   |                                    |          |
| Chipping Check     | Lower                                         | 0 to 0.025 V <sup>[c]</sup>                   |                                    |          |
| SSC Calculation    | Linner (evers)                                | 4.875 V to VDD [b]                            | 0000                               |          |
| Unit Saturation    | Upper (extra)                                 | 0.975 to 1.0 V <sup>[c]</sup>                 | 0XXX XXX <u>1</u> <sub>BIN</sub>   |          |

- [a] Only signalized if  $diagouten = 1_{BIN}$ .
- [b] With VDD =  $5V \pm 10\%$ , for 0 to 5V absolute analog out.
- [c] With any VDD, for 0 to 1V absolute analog out.
- [d] Do not enable if the IC is connected to an absolute voltage source sensor, for example, Thermopile ( $sensor\_sup = 10_{BIN}$ ) with typical internal resistances >60k $\Omega$ .

If multiple failures are detected leading to analog outputs that would be contradictory to each other, the high signal is always provided. The effective absolute, analog diagnostic-output level is constant for lower and upper diagnostic signal output. This absolute level may vary from IC to IC slightly. Hence, the effective lower and upper level for the absolute AOUT signal in the event of a valid diagnostic and failure event, respectively, are not influenced by any diagnostic-related setup in NVM nor by calibration coefficients, etc., per the *Aout\_setup* bit field in register 04<sub>HEX</sub> in NVM (see Table 34). However, the threshold (i.e., the sensor-signal-valid maximum for the upper and minimum for the lower diagnostic band) can be programmed and adjusted via proper calibration and the *diagouten* bit in register 04<sub>HEX</sub>.

Table 17. Information Assignment for CHECK\_DIAG Command: Output Register diagnosticreg [15:0]

|                                                                  | Connection Check | DAC                   | Bit-Number |    |    |    |    |    |   |   |   |   |   |   |   |   |   |   |
|------------------------------------------------------------------|------------------|-----------------------|------------|----|----|----|----|----|---|---|---|---|---|---|---|---|---|---|
| Meaning                                                          | Content          | Output <sup>[a]</sup> | 15         | 14 | 13 | 12 | 11 | 10 | 9 | 8 | 7 | 6 | 5 | 4 | 3 | 2 | 1 | 0 |
| No Error / Fault                                                 | Yes              | From SSC              | 0          | 0  | 0  | 0  | 0  | 0  | 0 | 0 | 0 | 0 | 0 | 0 | 0 | 0 | 0 | 0 |
| Fault information improved since last status information         | Yes              | _                     | 0          | 0  | 0  | 0  | 0  | 0  | 0 | 0 | 0 | 0 | 0 | 0 | 0 | 0 | 0 | 1 |
| Loss of sensor positive connection, INP                          | Yes              | 2dacres – 7           | 0          | 0  | 0  | 0  | 0  | 0  | 0 | 0 | 0 | 0 | 0 | 0 | 0 | 0 | 1 | 0 |
| Loss of sensor negative connection, INN                          | Yes              | 2dacres – 7           | 0          | 0  | 0  | 0  | 0  | 0  | 0 | 0 | 0 | 0 | 0 | 0 | 0 | 1 | 0 | 0 |
| Signal at INP pin out of range (leaking / short to VSS or VDDB)  | Yes              | 2dacres – 7           | 0          | 0  | 0  | 0  | 0  | 0  | 0 | 0 | 0 | 0 | 0 | 0 | 1 | 0 | 0 | 0 |
| Signal at INN pin out of range (leaking / short to VSS or VDDB)  | Yes              | 2dacres – 7           | 0          | 0  | 0  | 0  | 0  | 0  | 0 | 0 | 0 | 0 | 0 | 1 | 0 | 0 | 0 | 0 |
| Sensor short (INN = INP)                                         | Yes              | 2dacres - 7           | 0          | 0  | 0  | 0  | 0  | 0  | 0 | 0 | 0 | 0 | 1 | 0 | 0 | 0 | 0 | 0 |
| TEXT pin open                                                    | Yes              | 0007 <sub>HEX</sub>   | 0          | 0  | 0  | 0  | 0  | 0  | 0 | 0 | 0 | 1 | 0 | 0 | 0 | 0 | 0 | 0 |
| Signal at TEXT pin out of range (leaking / short to VSS or VDDB) | Yes              | 0007 <sub>HEX</sub>   | 0          | 0  | 0  | 0  | 0  | 0  | 0 | 0 | 1 | 0 | 0 | 0 | 0 | 0 | 0 | 0 |
| TEXT pin short to INN                                            | Yes              | 0007 <sub>HEX</sub>   | 0          | 0  | 0  | 0  | 0  | 0  | 0 | 1 | 0 | 0 | 0 | 0 | 0 | 0 | 0 | 0 |
| SSC Calculation Unit saturation                                  | No               | 2dacres - 7           | 0          | 0  | 0  | 0  | 0  | 0  | 1 | 0 | 0 | 0 | 0 | 0 | 0 | 0 | 0 | 0 |
| Memory error, checksum-check failure                             | No               | 0007 <sub>HEX</sub>   | 0          | 0  | 0  | 0  | 0  | 1  | 0 | 0 | 0 | 0 | 0 | 0 | 0 | 0 | 0 | 0 |
| TEXT pin short to INP                                            | Yes              | 0007 <sub>HEX</sub>   | 0          | 0  | 0  | 0  | 1  | 0  | 0 | 0 | 0 | 0 | 0 | 0 | 0 | 0 | 0 | 0 |
| Die crack / chipping check failure                               | No               | 0007 <sub>HEX</sub>   | 0          | 0  | 1  | 0  | 0  | 0  | 0 | 0 | 0 | 0 | 0 | 0 | 0 | 0 | 0 | 0 |

<sup>[</sup>a] The effective low limit for the DAC and resulting AOUT output signaling scales with the set up DAC resolution and is 16-bit =  $0007_{\text{HEX}}$ , 15-bit =  $000E_{\text{HEX}}$ , 14-bit =  $0015_{\text{HEX}}$ , or 13-bit =  $001C_{\text{HEX}}$ .

If a bit reset, i.e. a change from  $1_{\text{BIN}}$  (FAULT) back to  $0_{\text{BIN}}$  (NO-FAULT), for any bit occurs, *diagnosticreg*[0] is set in order to signal an improvement of fault states during the ZSSC3240 operation. This is especially relevant for Cyclic Mode and Continuous Analog-Output Mode operation.

The select\_checks bit field in NVM register 21<sub>HEX</sub> <sup>1</sup> can be programed to select which (analog) checks are executed and/or signalized when the *UPDATE\_DIAG* command is triggered or when a connection check is performed during Cyclic Mode operation. Checks that are not selected do not result in *diagnosticreg* register updates and are not signalized at the DAC and AOUT output.

# 6.4 Digital Interfaces

The ZSSC3240 supports three different digital interface protocols: SPI, I2C, and OWI. The implementation of the interfaces is such that the available commands (section 6.6.1) and request codes for the ZSSC3240 are the same regardless on the interface type used.

The selection of whether the ZSSC3240 operates with SPI, I2C, or OWI interface is determined in the start-up phase after power-on. Initially all interface relevant parameters are loaded from address 02<sub>HEX</sub> in the NVM (slave address, SPI configuration). If the first command after power-on is a valid and properly formatted I2C request including the correct slave address, the interface is fixed as an I2C slave. If, instead, there is an active signal at the SS pin as the first valid activity, then the IC is fixed as an SPI slave. Alternatively, a valid OWI start (within the start-up window) will fix the interface as OWI. Once, the interface is established and fixed, a change of the interface can only be done by means of a power-on-reset. The status byte defined in Table 18 is common for all supported interface types, and it is part of the ZSSC3240's digital response to read requests.

Table 18. General Status Byte

| Bit-Number | 7 | 6        | 5     | 4  | 3   | 2                | 1                             | 0                  |
|------------|---|----------|-------|----|-----|------------------|-------------------------------|--------------------|
| Meaning    | 0 | Powered? | Busy? | Мс | ode | Memory<br>Error? | Connection<br>Check<br>Fault? | Math<br>Saturation |

Table 19. Mode Status

| Status[4:3] | Mode             |
|-------------|------------------|
| 00          | Command Mode     |
| 01          | Cyclic Mode      |
| 10          | Sleep Mode       |
| 11          | Renesas reserved |

#### 6.4.1. SPI

The SPI interface mode is available if the first interface activity after ZSSC3240 power-up is an active signal at the SS pin. The polarity and phase of the SPI clock are programmable via the *CKP\_CKE* setting in bits [11:10] in address 02<sub>HEX</sub> as described in Table 34. *CKP\_CKE* is two bits: *CPHA* (bit 10), which selects which edge of SCLK latches data, and *CPOL* (bit 11), which indicates whether SCLK is high or low when it is idle. The polarity of the SS signal and pin are programmable via the *SS\_polarity* setting (bit 9).

The different combinations of polarity and phase are illustrated in Figure 5 and Figure 6. See Table 20 for the timing parameters.

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Recommendation for current loop applications: To minimize the effect of varying current draw in current loop applications, do not perform short-connection checks (sens\_short\_check, text\_inn\_short\_check, text\_inp\_short\_check).

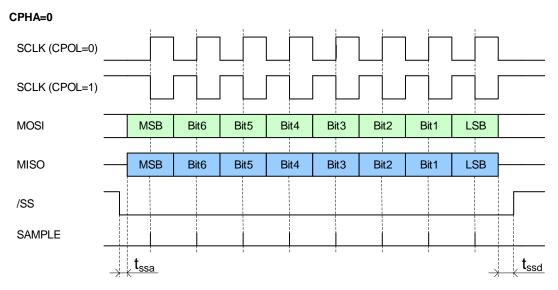


Figure 5. SPI Configuration CPHA=0

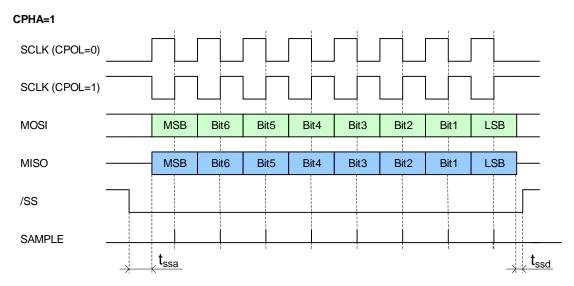


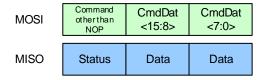
Figure 6. SPI Configuration CPHA=1

In SPI Mode, each command except NOP is started as shown in Figure 7. After the execution of a command (busy = 0), the expected data can be read as illustrated in Figure 8 or if no data are returned by the command, the next command can be sent. The status can be read at any time with the *NOP* command (see Figure 9).

Note: If SS and SCLK do not end after one complete read-response cycle, but continue for any reason, the ZSSC3240 will start repeating; e.g. the measurement result data would repeat in the following sequence (comparable to the OWI response shown in Figure 17):

 $Status \rightarrow SensorData~[23:16] \rightarrow SensorData~[15:8] \rightarrow SensorData~[7:0] \rightarrow TempData[23:16] \rightarrow TempData[15:8] \rightarrow TempData[7:0] \rightarrow SensorData~[23:16] \rightarrow SensorData~[15:8] \rightarrow ...$ 

#### **Command Request**

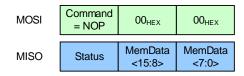


Note: A command request always consists of 3 bytes. If the command is shorter, then it must be completed with 0's. The data on MISO depend on the preceding command.

Figure 7. SPI Command Request

#### **Read Data**

(a) Example: after the completion of a Memory Read command



(b) Example: after the completion of a Measure command (AA<sub>HEX</sub>)

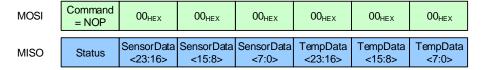


Figure 8. SPI Read Data

#### **Read Status**



Figure 9. SPI Read Status

Table 20. SPI Interface Parameter

Note: See important table notes at the end of the table.

| Symbol                      | Parameter                                                                                     | Conditions                                    | Minimum | Typical               | Maximum | Units |
|-----------------------------|-----------------------------------------------------------------------------------------------|-----------------------------------------------|---------|-----------------------|---------|-------|
| f <sub>SCLK</sub>           | Interface clock                                                                               |                                               | 0.05    | 1                     | 12      | MHz   |
| D <sub>SPI</sub>            | Duty cycle                                                                                    |                                               | 40      | 50                    | 60      | %     |
| $V_{high,SPI}$              | Input high level voltage                                                                      | Referenced to external                        | -       | V <sub>DD</sub> - 0.7 | =       | V     |
| $V_{\text{low},\text{SPI}}$ | Input low level voltage                                                                       | supply voltage V <sub>DD</sub> (maximum 5.5V) | -       | 0.7                   | -       | V     |
| SR <sub>SPI</sub>           | Input rising and falling edge slew rate                                                       |                                               | 0.26    | _                     | 1       | V/ns  |
| t <sub>ssa</sub>            | Delay time [a] between SS-activation edge and first edge of SLCK, MOSI or MISO                | "Typical" is for f <sub>SCLK</sub> ≤ 3MHz     | 1       | 50                    | _       | ns    |
| t <sub>ssd</sub>            | Delay time [a] between SS-deactivation edge and last edge of SLCK, MOSI or MISO               | operation                                     | 1       | 50                    | _       | ns    |
| t <sub>ss</sub>             | Delay between SS-deactivation edge of last command and of SS-activation edge for next command |                                               | 10      | -                     | _       | μs    |
| I <sub>MISO</sub>           | Driving current of SPI output (peak)                                                          |                                               | _       | 40                    | 180     | mA    |

<sup>[</sup>a] Typical: For conditions with no clocks prior and after the command and data bytes, the maximum values for  $t_{ssa}$  and  $t_{ssd}$  are not relevant; under conditions with clocks prior to and after command and data, there is a maximum for  $t_{ssa}$  and  $t_{ssd} = 0.3/f_{SCLK}$ .

#### 6.4.2. I2C

I2C Mode is selected if the first interface activity after the ZSSC3240 power-up is an I2C command with valid slave address. In I2C Mode, each command is started as shown in Figure 10. Only the number of bytes that are needed for the command must be sent. An exception is the I2C High Speed Mode where 3 bytes must always be sent as in SPI Mode. After the execution of a command (busy = 0), the expected data can be read as illustrated in Figure 11 or if no data are returned by the command, the next command can be sent. The status can be read at any time as described in Figure 12.

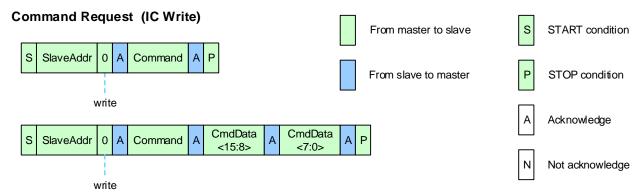
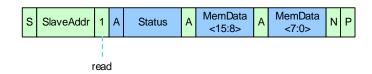


Figure 10. I2C Command Request

#### Read Data (I2C Read)

(a) Example: after the completion of a Memory Read command



(b) Example: after the completion of a *Measure* command (AA<sub>HEX</sub>)

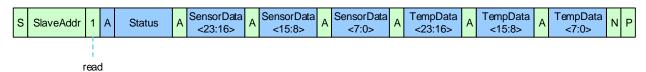


Figure 11. I2C Read Data

#### Read Status (I2C Read)

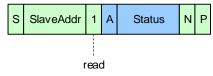


Figure 12. I2C Read Status

Table 21. I2C Interface Parameter

| Symbol               | Parameter                | Conditions                                             | Minimum | Typical               | Maximum | Units |
|----------------------|--------------------------|--------------------------------------------------------|---------|-----------------------|---------|-------|
| f <sub>SCL</sub>     | Interface clock          |                                                        | 0.1     | _                     | 3.4     | MHz   |
| D <sub>SPI</sub>     | Duty cycle               |                                                        | 33      | _                     | 50      | %     |
| $V_{high,I2C}$       | Input high level voltage | Referenced to external supply voltage V <sub>DD.</sub> | -       | V <sub>DD</sub> - 0.7 | -       | V     |
| $V_{\text{low,I2C}}$ | Input low level voltage  |                                                        | -       | 0.7                   | -       | V     |

| Symbol           | Parameter                         | Conditions                                                                                                                    | Minimum | Typical | Maximum | Units |
|------------------|-----------------------------------|-------------------------------------------------------------------------------------------------------------------------------|---------|---------|---------|-------|
| C <sub>SDA</sub> | Capacitive load at input pin, SDA | 100pF: maximum for Standard and Fast Mode; in HS Mode $f_{SCL,max} = 3.4 MHz$ 400pF: only in HS Mode; $f_{SCL,max} = 1.7 MHz$ | I       | 100     | 400     | pF    |
| I <sub>OL</sub>  | Low level output current          | V <sub>SDA</sub> =0.4V; Standard and Fast<br>Mode with 400kHz; 400pF load                                                     | 3       | 6       | 40      | mA    |

Details for timing and protocol of the ZSSC3240-supported I2C communication in Standard Mode, Fast Mode, and High-Speed Mode are given in *I2C-Bus Specification*, *Rev.6*, *UM10204*.

#### 6.4.3. One-Wire-Interface, OWI

The ZSSC3240 employs a one-wire digital interface concept (OWI). It combines a simple and easy protocol adaptation with a cost-saving pin sharing. The communication principle of the OWI interface is derived from the I2C protocol.

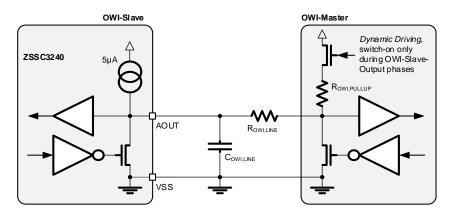


Figure 13. General Block Schematic of the OWI Interface

Both the analog output signal and the digital OWI interface use the same pin, AOUT. An advantage of the OWI is that it enables "end of line" calibration – no additional pins are required to digitally calibrate a finished assembly. Although the OWI is integrated mainly for calibration, it can also be used to read out the calibrated sensor signal continuously or retrieve diagnostic detail information.

The OWI protocol is defined as follows:

- Idle State: During inactivity of the bus, the OWI line is pulled up to the supply voltage V<sub>DD</sub> by an external resistor.
- Start Condition: When the OWI line is in idle mode, a low pulse with a minimum width of towi,START ≥ 10µs and then a return to high indicates a start condition. Every request must be initiated by a start condition sent by a master. A master can generate a start condition only when the OWI line is in idle mode.
- Valid Data: Data is transmitted in bytes (8 bits) starting with the most significant bit (MSB). Transmitted bits are recognized after a start condition at every transition from low to high at the OWI line. The value of the transmitted bit depends on the duty ratio between the high phase and high/low period (bit period, town,BIT in Figure 14). A duty ratio greater than 1/8 and less than 3/8 is detected as 0; a duty ratio greater than 5/8 and less than 7/8 is detected as 1. The bit period of consecutive bits must not increase to more than 1.5 times the previous bit period or decrease to less than half of the previous bit period because a stop condition is detected in this case.

The length of the OWI-line and the size of Rowi, Pull (if it is statically connected to AOUT), and consequently the resistive and capacitive load influence the maximum possible interface speed and minimum Bit period, respectively. Further, it can be beneficial for harsh EMC conditions to intentionally add capacitance to the OWI1 (AOUT) line in order to improve RF disturbance robustness. Table 22 shows some practical OWI-interface dimensioning examples and the resulting maximum signal frequencies (minimum possible Bit periods). The complete ZSSC3240's OWI interface properties and timing capabilities are given in Table 23.

| Table 22. OWI Dimensioning Examples | Table 22. | OWI D | imensioning | Examples |
|-------------------------------------|-----------|-------|-------------|----------|
|-------------------------------------|-----------|-------|-------------|----------|

| Rowi,Pull (+ Rowi,Load) Cowi,Load [a] | 1.8 kΩ | 2.5 kΩ | 3.3 kΩ | 5.5 kΩ | 10.0 kΩ |
|---------------------------------------|--------|--------|--------|--------|---------|
| 1nF                                   | 20µs   | 20µs   | 21µs   | 35µs   | 63µs    |
| 10nF                                  | 113µs  | 157µs  | 207µs  | 345µs  | 628µs   |
| 22nF                                  | 249µs  | 345µs  | 456µs  | 760µs  | 1381µs  |
| 33nF                                  | 373µs  | 518µs  | 684µs  | 1140µs | 2070µs  |
| 44nF                                  | 497µs  | 691µs  | 912µs  | 1520µs | 2762µs  |
| 51nF                                  | 576µs  | 801µs  | 1057µs | 1760µs | 3205µs  |

 $<sup>[</sup>a] \quad \text{Examples are shown with statically connected $R_{\text{OWI},PULL}$, and with minimum bit period: $t_{\text{OWI},BIT}$.}$ 

OWI protocol timing and parameters are specified in Figure 14, Figure 15, and Table 23.

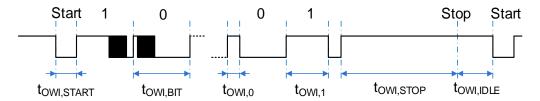


Figure 14. OWI Timing Diagram

Note: Configuration for SSF1 register 03<sub>HEX</sub> in NVM (see Table 34) to allow continuous OWI and concurrent analog output: owi\_off = 0, cont\_ANAoutn = 0, owi\_su\_case = 1.

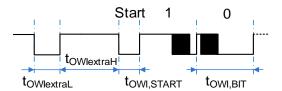


Figure 15. OWI Extra (Activation) Pulse for Concurrent OWI and Analog Output Configuration

Table 23. OWI Interface Parameters

| Symbol                                         | Parameter                                         | Conditions                                                                                                            | Minimum | Typical                              | Maximum | Units                  |
|------------------------------------------------|---------------------------------------------------|-----------------------------------------------------------------------------------------------------------------------|---------|--------------------------------------|---------|------------------------|
| t <sub>SUlength</sub>                          | OWI start-up "listening" window                   | Programmable window length , see<br>owi_su_length, bit[2] in SSF1<br>register                                         | _       | -                                    | 50      | ms                     |
|                                                | Bus free time between operation                   |                                                                                                                       | 1       | 20                                   |         |                        |
| t <sub>OWI,IDLE</sub> START and STOP condition |                                                   | Minimum in ZSSC3240 Sleep Mode operation                                                                              | 20 30   |                                      | _       | μs                     |
| t <sub>OWI,START</sub>                         | Hold time for START condition                     |                                                                                                                       | 20µs    | 0.5 <b>×</b><br>t <sub>OWI_BIT</sub> | _       | μs                     |
| t <sub>OWI,BIT</sub>                           | Bit period, bit time                              | Robust operation with: $t_{\text{OWI,BIT}} \geq 10 \cdot R_{\text{OWI,PULL}} \cdot C_{\text{OWI,LOAD}}$               | 20      | 40                                   | 3000    | μs                     |
| t <sub>OWI,0</sub>                             | Duty ratio bit '0'                                |                                                                                                                       | 0.125   | 0.25                                 | 0.375   | t <sub>OWI_BIT</sub>   |
| t <sub>OWI,1</sub>                             | Duty ratio bit '1'                                |                                                                                                                       | 0.625   | 0.75                                 | 0.875   | t <sub>OWI_BIT</sub>   |
| t <sub>OWI,STOP</sub>                          | Hold time STOP condition                          | t <sub>OWI_BIT_L</sub> is the bit period of the last valid bit                                                        | 1.5     | 3                                    |         | t <sub>OWI_BIT_L</sub> |
| t <sub>OWI_BIT_DEV</sub>                       | Bit time deviation                                | Duration of most recent bit versus previous bit duration                                                              | 0.55    | 1.0                                  | 1.45    | t <sub>OWI_BIT</sub>   |
| t <sub>OWlextraL</sub>                         | Length of extra pulse [a]                         | OWI configuration to allow                                                                                            | 43.5    | _                                    | 49.5    | μs                     |
| t <sub>OWlextraH</sub>                         | Duration of HIGH after<br>Aout-to-OWI extra pulse | continuous OWI and concurrent analog output; see Figure 15.                                                           | 43.5    | _                                    | _       | μs                     |
| C <sub>OWI,LOAD</sub>                          | Capacitive load at OWI line                       | Minimize C <sub>OWI,LOAD</sub> if ratiometric DAC-output, Aout_setup = 001 <sub>BIN</sub> is configured for AOUT/OWI1 | 0.05    | 2.2                                  | 66      | nF                     |

| Symbol                 | Parameter                       | Conditions                                                                                                                                   | Minimum | Typical                         | Maximum | Units |
|------------------------|---------------------------------|----------------------------------------------------------------------------------------------------------------------------------------------|---------|---------------------------------|---------|-------|
| R <sub>OWI,PULL</sub>  | Pull-up resistance – master [b] | If $R_{\text{OWI,PULL}}$ values greater than 3.3k $\Omega$ were applied, the shortest $t_{\text{OWI,BIT}}$ times cannot be achieved anymore. | 1.8     | 2.5                             | 3.3     | kΩ    |
| Rowi,LOAD              | Resistive OWI line load         | If R <sub>OWI,LOAD</sub> >35Ω, OWI-timing parameter (t <sub>OWI</sub> ,·) low-limits, i.e. highest speeds are not guaranteed.                | 0       | 0.01 x<br>R <sub>OWI,PULL</sub> | -       | Ω     |
| $V_{OWI,inL}$          | Voltage level LOW               |                                                                                                                                              | -       | 0.1                             | 0.25    | VDD   |
| $V_{OWI,inH}$          | Voltage level HIGH              |                                                                                                                                              | 0.80    | 0.9                             | -       | VDD   |
| V <sub>OWI-S,LOW</sub> | Slave output level LOW          | Open drain output at AOUT pin,<br>max. allowed current draw 5mA,<br>otherwise: V <sub>OW-S,LOW</sub> >0.1*VDD                                | _       | _                               | 0.1     | VDD   |

<sup>[</sup>a] To switch from analog output to "OWI listen" at AOUT pin.

The effective OWI properties depend on the load conditions at the OWI1 pin. Additional to Table 22, some further applicable configurations are as follows:

- For maximum operation speed (50kHz) of OWI1, the capacitive load, C<sub>OWI,LOAD</sub> can be up to 1nF and the maximum R<sub>OWI,PULL</sub> is 2.5kΩ.
- For high operation speed (10kHz) of OWI1, the capacitive load, C<sub>OWI,LOAD</sub> can be up to 4.7nF and R<sub>OWI,PULL</sub> must be ≤ 3.3kΩ.
- For an equivalent frequency of 1kHz of OWI1, it should be ensured that  $C_{OWI,LOAD} \le 22nF$  and  $R_{OWI,PULL} \le 7k\Omega$ , or for example that  $C_{OWI,LOAD} \le 66nF$  combined with  $R_{OWI,PULL} \le 4.5k\Omega$ .

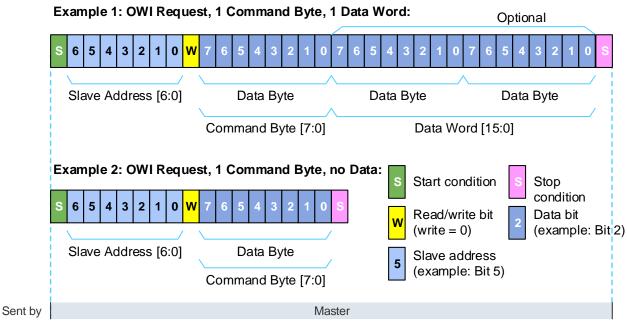


Figure 16. OWI Command Request

<sup>[</sup>b] For the selection of R<sub>OWI,PULL</sub>, the minimum current limit of the AOUT buffer and maximal VDD supply must take into account if OWI and analog output voltage mode are set up to work concurrently; that is *owi\_off* = 0, *cont\_ANAoutn* = 0, and *owi\_su\_case* = 1. If the current limitation condition (I<sub>OUTmax</sub>, see Table 4) is exceeded, it is recommended to use the Dynamic Driving Approach for R<sub>OWI,PULL</sub> at the OWI-master, and only switch the R<sub>OWI,PULL</sub> to AOUT when the OWI-master starts communication. This setting is specifically recommended for the phases when the OWI-master listens to the AOUT-line, and the OWI-slave (the ZSSC3240) has to respond, respectively.

#### Example: OWI Read Operation, Status Byte (+n) Data Bytes\*:

Response data is sent in a loop, i.e. repeated until master generates stop condition Optional 5 3 2 0 ...n<sup>th</sup> Data Byte Slave Address [6:0] Status Byte [7:0] Data Byte [7:0] \* n data bytes could be: NVM read: 2 bytes, Measure: 6 bytes, Get Raw: 3 bytes Master Slave Master Sent by Read/write bit Slave address Data bit Start condition Stop condition 5 (read = 1)(example: Bit 5) (example: Bit 2)

Figure 17. OWI Response by ZSSC3240

The ZSSC3240 allows utilization of the OWI interface in different application configurations:

- **OWI Disable:** The OWI interface can be deactivated by *owi\_off* = 1 (bit[13] in *SSF1* register 03<sub>HEX</sub>). For example, this could be applied in cases when an analog-output smart sensor is configured and calibrated using the OWI interface and the OWI will not be available after calibration and final setup/programming.
- OWI Only (no analog output): With the NVM configuration owi\_off = 0 and cont\_ANAoutn = 1, the AOUT will not provide any analog outputs and is only used as the OWI pin. There is no startup window limitation (owi\_su\_length is ignored by the ZSSC3240). If the first (valid) digital interface activity is the Startup OWI (D2<sub>HEX</sub>) command, the ZSSC3240's interface type will be fixed as OWI communication (SPI and I2C will be disabled/ignored).
- **OWI with Startup Window and Analog Output:** The OWI startup window followed by subsequent activation of the analog output is possible with *owi\_off* = 0, *cont\_ANAoutn* = 0, and *owi\_su\_case* = 0. AOUT works as a (listening) OWI signal pin after power-up until the selected startup window (*owi\_su\_length*) has elapsed. If the *Startup OWI* (D2<sub>HEX</sub>) command is received within the startup window, AOUT persists as the OWI communication pin until a power-on reset occurs. If the ZSSC3240 does not receive the *Startup OWI* command (D2<sub>HEX</sub>) during the startup window, the OWI interface will be disabled and AOUT starts functioning as an analog output.
- Continuous OWI and Analog Output: The configuration  $owi\_off = 0$ ,  $cont\_ANAoutn = 0$ , and  $owi\_su\_case = 1$  results in AOUT providing analog output levels as soon as they are available after power-up (in Cyclic Mode). Concurrently, the OWI listens to the AOUT <sup>1</sup> pin in order to check for valid OWI commands. The OWI still needs to be enabled by means of the *Startup OWI* command. The physical protocol in this configuration requires an extra pulse (see Figure 15) prior the *Startup OWI* command. After the release of the extra OWI initialization pulse, the analog output is switched off <sup>2</sup> and AOUT becomes the OWI I/O pin until the OWI startup window (according to *owi su length*) has elapsed.

The OWI-master implements *Dynamic Driving* to avoid dynamic currents (due to DAC-output level changes) causing unwanted pull-up signal generation (via  $R_{OWI,PULL}$ ). When *Dynamic Driving Approach* is not applied in this configuration, set the constantly connected OWI-master pull-up resistances ( $R_{OWI,PULL}$ ) to  $\geq 5.5 k\Omega$  to prevent erroneous OWI-start detections that can be triggered by changing DAC-output levels. Limit the interface speed to slower values with the proper setting, such as longer bit period.

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Dependent on Aout\_setup, OWI2 is the alternative input pin, e.g., in the case of the current loop setup, i.e. the Aout\_setup bit field = 000 in register 04<sub>HEX</sub>.

<sup>&</sup>lt;sup>2</sup> The DAC switch-off time point is variable and depends on the activity status in the measurement cycle, measurement execution, etc. It can be anytime between the extra-pulse and a received, completed *Startup OWI* command.

## 6.5 Measurement and Output Options

Sensor or diagnostic measurement results of the ZSSC3240 can be provided in both domains, digital and analog. Any of the supported digital interfaces and output options can be used as the only active interaction path, or it can be combined with any of the analog output configurations. For digital communication, only one interface type can be active and supported (see section 6.4).

Digital communication via SPI and I2C are fully independent of the configuration and application of the ZSSC3240's analog outputs. For digital OWI communication combined with analog output, special application circuits and constraints might have to be considered, as the OWI interface and the analog outputs use the same pin, AOUT.

#### 6.5.1. Single Measurements, Digital Raw Results, and SSC Results

The IC generates digital raw values, which are processed by the ZSSC3240-internal math core generating the SSC-corrected (linearized, temperature-compensated) output signal. See section 6.6.3 for details about the SSC math, etc. In addition to the SSC-corrected digital measurement results, the ZSSC3240 can provide raw values without SSC correction for evaluation and/or calibration purposes. The respective results are provided at the digital interface as a 24-bit wide data word. Raw values and SSC results are MSB-aligned. Raw values are formatted as two's-complement, whereas SSC results are formatted as unsigned absolute value.

Table 24. Data Format of Raw ADC Readings

| Bit-Number            | 23  | 22  | 21  | 20  | ••• | 2                | 1                | 0                |
|-----------------------|-----|-----|-----|-----|-----|------------------|------------------|------------------|
| Meaning,<br>Weighting | -20 | 2-1 | 2-2 | 2-3 | ••• | 2 <sup>-21</sup> | 2 <sup>-22</sup> | 2 <sup>-23</sup> |

Table 25. Data Format of Corrected, SSC Results (S and T)

| Bit-Number            | 23             | 22              | 21              | 20              | ••• | 2                | 1                | 0                |
|-----------------------|----------------|-----------------|-----------------|-----------------|-----|------------------|------------------|------------------|
| Meaning,<br>Weighting | 2 <sup>0</sup> | 2 <sup>-1</sup> | 2 <sup>-2</sup> | 2 <sup>-3</sup> |     | 2 <sup>-21</sup> | 2 <sup>-22</sup> | 2 <sup>-23</sup> |

The ZSSC3240 can process and digitize the following signals:

- SM: Direct sensor signal inputs; i.e., perform sensor measurements
- AZS: Auto-zero signals for the sensor channel
- TM: Direct temperature signal inputs, i.e. perform temperature measurements
- AZT: Auto-zero signals for the temperature channel

The internal sequence (in time) of A2D-conversions with both auto-zero measurements enabled is: first is AZS, second is SM, third is AZT, and forth is TM. The utilization of auto-zero measurements allows further optimization and reduction of the noise level for the sensor signal in combination with the inherent compensation of the residual offsets of the analog sensor front-end. If an auto-zero measurement is enabled, then the sensor signal remains the input for the auto-zero measurement with the gain and ADC set up as for the original signal measurement, but with swapped inputs and offset configurations of the PGA and ADC such that the following holds for the resulting raw value:

- Sensor raw value with auto-zero: S\_raw = 0.5 · (SM AZS)
- Temperature raw value with auto-zero:  $T_raw = 0.5 \cdot (TM AZT)$

The application benefits with enabled auto-zero measurements are

- ZSSC3240 front-end offset cancellation residual signal degradation<sup>1</sup> or drift for the application is eliminated
- · Improvement of the signal-to-noise ratio for the raw or SSC-corrected output signal

<sup>&</sup>lt;sup>1</sup> Worst-case IC-offset drift is < 2ppm/day at 125°C.

On the other hand, the default application benefit without auto-zero measurements is an approximately 50% faster output update rate compared to an equivalent configuration with enabled auto-zero measurements.

Recommendations: For applications where a faster update rate is the priority, disable and not apply the auto-zero measurements. For applications where a better signal-to-noise level and maximum signal quality are the priority, enable and apply the auto-zero measurements.

The NVM configuration and measurement-request commands can be used to select which measurements are performed, processed, and provided at the digital interface. See Table 33 for command details.

Examples of options for a single measurement request and output:

- SSC-corrected sensor readings (requested by the Measure command AAHEX) generating an output of SSC-corrected, 24-bit sensor data followed by SSC-corrected, 24-bit temperature data.
- Raw sensor measurement with or without auto-zero correction (requested by the *Raw Sensor Measure* command A2<sub>HEX</sub>) generating an output of raw 24-bit sensor data.
- Raw temperature measurement with or without auto-zero correction (requested by the Raw Temperature Measure command, A4HEX) generating an output of raw 24-bit temperature data.

The auto-zero measurements can be disabled/enabled via the *AZMs\_on* and *AZMt\_on* bits in NVM registers 04<sub>HEX</sub> (see Table 34).

Table 26 and Table 27 provide some exemplary, typical conversion times and noise performance values for the ZSSC3240's Front-End (PGA and ADC) in order provide some guidance for understanding effects and signal-quality-related consequences while defining an application setup.

| Table 20. Typical Conversion Times for Comblete 33C Sensor Measurements, 3M, 1 | Table 26. | Typical Conversion Times for Complete SSC Sensor Measurements: SN | I. TM |
|--------------------------------------------------------------------------------|-----------|-------------------------------------------------------------------|-------|
|--------------------------------------------------------------------------------|-----------|-------------------------------------------------------------------|-------|

| ADC Resolution (Main) Sensor | ADC Resolution Temperature Sensor | Typical Measurement Duration [ms] [a] |
|------------------------------|-----------------------------------|---------------------------------------|
| 12                           | 12 (external temperature sensor)  | 0.38                                  |
| 14                           | 13 (internal temperature sensor)  | 0.47                                  |
| 14                           | 14 (external temperature sensor)  | 0.53                                  |
| 16                           | 14 (external temperature sensor)  | 0.67                                  |
| 16                           | 16 (external temperature sensor)  | 0.82                                  |
| 18                           | 18 (external temperature sensor)  | 1.40                                  |
| 24                           | 24 (external temperature sensor)  | 9.47                                  |

<sup>[</sup>a] The time from the end of the SSC-measurement command request AA<sub>HEX</sub> to signalization for the end-of-conversion at the EOC pin with the ZSSC3240 in Command Mode; *INT\_setup* bit field = 00<sub>BIN</sub> in register 02<sub>HEX</sub> (see Table 34); 25°C; V<sub>DD</sub>=5V; *AZMs\_on* = 0<sub>BIN</sub>; and *AZMt\_on* = 0<sub>BIN</sub>.

The data is shown with ZSSC3240 default NVM configuration.

Table 27. Typical Conversion Times and Noise Performance for Complete SSC Measurements

| ADC Resolution:<br>External Sensor [Bits] | Reference Source for External Sensor (sel_ref1) | Typical 3-sigma Noise for SSC-Corrected (Digital) Output <sup>[b],</sup> S, T | Typical Measurement <sup>[a]</sup><br>Duration <sup>[c]</sup> [ms] |  |
|-------------------------------------------|-------------------------------------------------|-------------------------------------------------------------------------------|--------------------------------------------------------------------|--|
| 12                                        | Absolute, sel_ref1=0                            | bsolute, sel_ref1=0 5 LSB <sub>12Bit</sub>                                    |                                                                    |  |
| 12                                        | Ratiometric, sel_ref1=1                         | 7 LSB <sub>12Bit</sub>                                                        | 0.8                                                                |  |
| 16                                        | 16 Absolute, <i>sel_ref1</i> =0 26 LSE          |                                                                               | 4.2                                                                |  |
| 16                                        | Ratiometric, sel_ref1=1                         | 51 LSB <sub>16Bit</sub>                                                       | 1.2                                                                |  |
| 20                                        | Absolute, sel_ref1=0                            | 182 LSB <sub>20Bit</sub>                                                      | 2.9                                                                |  |
| 20 Ratiometric, sel_ref1=1                |                                                 | 270 LSB <sub>20Bit</sub>                                                      | 2.9                                                                |  |
| 24 Absolute, sel_ref1=0                   |                                                 | 1122 LSB <sub>24Bit</sub>                                                     | 9.8                                                                |  |
| 24 Ratiometric, sel_ref1=1                |                                                 | 1354 LSB <sub>24Bit</sub>                                                     | 9.0                                                                |  |

<sup>[</sup>a] Measurements including AZS, SM, AZT, TM with internal temperature measurement.

<sup>[</sup>b] Reference noise values normalized to the respective external sensor's ADC resolution, obtained with the following setup: 10kΩ sensor bridge, 25°C, Gain=28, VDD=3.3V, ioffsc=00000 for sel\_ref1=1, ioffsc=01111 for sel\_ref1=0, adc\_en\_shift=0, pga\_en\_shift=0, sensor\_sup=00, cp\_off=0.

<sup>[</sup>c] The time from the end of the SSC-measurement command request AA<sub>HEX</sub> to signalization for the end-of-conversion at the EOC pin with the ZSSC3240 in Command Mode; *INT\_setup* bit field = 00<sub>BIN</sub> in register 02<sub>HEX</sub> (see Table 34).

#### 6.5.2. Cyclic, Continuous, Repeated Measurements - Measurement Scheduler

In addition to single measurement requests, such as AA<sub>HEX</sub>, or the *Oversample-x Measure* requests (AC<sub>HEX</sub> to AF<sub>HEX</sub>; see Table 33), the ZSSC3240 can be configured for cyclic measurement sequences. The continuously running measurement sequence consists of individual measurement slots in which all or a selectable subset of measurements and checks can be scheduled and allocated including sensor measurement (S), auto-zero measurement for the sensor (AZS), temperature measurement (T), auto-zero measurement for temperature (AZT), and diagnostic checks (see section 6.3). If AZS is enabled ( $AZMs\_on = 1_{BIN}$  in register  $04_{HEX}$ ; see Table 34 for details for registers), the sensor measurement (S) and auto-zero measurement for the sensor (AZS) must be scheduled to always occur together for correct signal processing; i.e., these settings are required:  $slots\_S = slots\_AZS$  in register  $1F_{HEX}$  and  $startS\_wfirstn = startAZS\_wfirstn$  in register  $1E_{HEX}$ . If AZT is enabled ( $AZMt\_on = 1_{BIN}$  in register  $04_{HEX}$ ), the temperature measurement (T) and auto-zero measurement for temperature (AZT) must be scheduled to always occur together for correct signal processing; i.e., these settings are required:  $slots\_T = slots\_AZT$  and  $startT\_wfirstn = startAZT\_wfirstn$  (see registers  $1E_{HEX}$  and  $1F_{HEX}$ ). For applications where obtaining the fastest possible update rate is the highest priority, disabling the auto-zero measurements is recommended, i.e.,  $AZM^*\_on = 0_{BIN}$ , for which slot scheduling is user programmable without constraints.

The automatically, continuously running measurement sequence is executed in Cyclic Mode, which is either entered as the default main operating mode after power-on or entered by means of the START\_CYC command, AB<sub>HEX</sub>.

Figure 18 shows an example of the measurement sequence configurability. During the pauses in the sequence, the ZSSC3240 signals that it is not busy (i.e., the Busy? bit =  $0_{BIN}$  in the general status byte; see Table 18). The available measurement results are updated at the end of each SSC calculation and output operation and are kept valid at the digital interface or DAC output until the next SSC calculation and output operation.

The configuration of the measurement scheduler is done in the NVM registers 1E<sub>HEX</sub> to 20<sub>HEX</sub>.

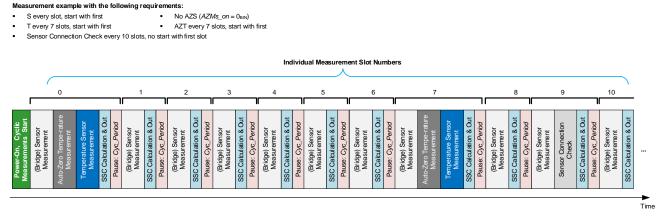


Figure 18. Example Configuration for the Measurement Scheduling and Cyclic Mode Operation

A slot denotes all measurements that are conducted and updated before the next SSC calculation. There can be pauses from one slot to the start of the next slot. The first slot has the slot number 0.

If the digital interface clock speed is too slow or contains long no-read pauses related to the SSC output update rate in Cyclic Mode, intermediate results can be lost, and the respective read result can be outdated compared to the related, read-concurrent, physical situation at the sensor (especially for very long pauses between two interface read operations). This digital interface behavior is valid for all options: SPI, I2C, OWI. In Cyclic Mode, the present data word (measurement result) at the interface output always follows the last data (result) that was read at the interface. See Figure 19 for relatively slow interface polling compared to the internal measurement data update rate in Cyclic Mode.

Figure 19. Measurement Result Output Update in Cyclic Operation (with "Slow" Interface Polling)

### 6.5.3. Analog Outputs: Digital-to-Analog Converter (DAC)

The integrated, programmable digital-to-analog converter (DAC) generates an IC-internal analog signal that can be output at AOUT as an absolute voltage, V<sub>DD</sub>-ratiometric voltage, or control signal for an externally connected current loop circuit. The analog output must be configured by *Aout\_setup* in the *SSF2* register, 04<sub>HEX</sub>.

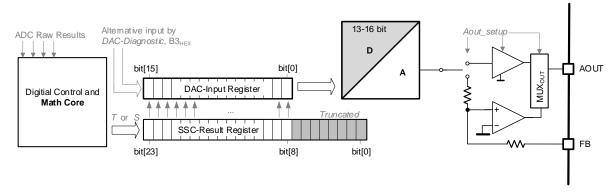


Figure 20. DAC and Analog Output Topology

The ZSSC3240 provides only analog outputs for signals that have been processed by the SSC calculation unit (see section 6.6.3), or that are directly transferred (via the digital command, *DAC-Diagnostic*, B3<sub>HEX</sub>; see Table 33) as input to the DAC; e.g., for test or calibration purposes.

Note: OWI does not support the DAC-Diagnostic feature, it is only applicable with the interfaces I2C and SPI.

The setup parameter *dacouttype*, bit[3] of the *SSF*2 register, 04<sub>HEX</sub> defines if either the SSC-corrected sensor value, *S*, or the SSC-corrected temperature value, *T*, is provided at AOUT; see Figure 20.

| value, S, o | or the SSC-corrected temperature value, <i>T</i> , is provided at AOUT; see Figure 20. |
|-------------|----------------------------------------------------------------------------------------|
| Table 28.   | DAC Configurations                                                                     |

| dacres |        | Applied DAC Becalities | Marrian um DAC Outrout Voltage t                                    |  |
|--------|--------|------------------------|---------------------------------------------------------------------|--|
| bit[1] | bit[0] | Applied DAC Resolution | Maximum DAC Output Voltage t <sub>DACsettle</sub> Settling Time [a] |  |
| 0      | 0      | 13-Bit                 | 150µs                                                               |  |
| 0      | 1      | 14-Bit                 | 160µs                                                               |  |
| 1      | 0      | 15-Bit                 | 180µs                                                               |  |
| 1      | 1      | 16-Bit                 | 200μs                                                               |  |

<sup>[</sup>a] t<sub>DACsettle</sub> is the step-response time for the DAC and analog output stage (only); i.e., the time to reach 99% of the new analog output level after a DAC input change. For analog-output smart-sensor step-response time, the time for generating a new SSC-result as input to the DAC must also be considered.

For the suppression of spuriously emitted tones in the analog output signal, dithering within the DAC operation can be enabled/disabled via the *dither\_off* bit in the *SSF2* register. If spurious tone emission is irrelevant in the application, dithering can be switched off in order to improve the analog output signal's noise level.

For analog diagnostic level signalization, enabled by the *diagouten* bit =  $1_{BIN}$  in the *SSF2* register (see Table 16), the ZSSC3240 directly ties the analog output signal to 0% or 100% with the selected output stage, supported by

digital pre-scaling to reserve approximately 1.5%-wide signal bands for diagnostic outputs. Strong recommendation: If the ZSSC3240 provides diagnostic levels, activate analog signalization of diagnostic levels before sensor calibration.

#### 6.5.3.1. Voltage Outputs

The ZSSC3240 can provide one of three direct voltage outputs at the AOUT pin. The *Aout\_setup* bit field in the *SSF*2 register (bits [7:5]; see Table 34) is used to configure the ZSSC3240 and select the analog voltage output stage as defined in Table 29. It is also possible to set up the analog voltage output for 0V to 10V systems using additional external components.

Table 29. Direct Voltage Outputs

| Aout_setup |        | Voltage Output (Dange Tune) [8] | 0                                  |                                                                                                              |  |
|------------|--------|---------------------------------|------------------------------------|--------------------------------------------------------------------------------------------------------------|--|
| bit[2]     | bit[1] | bit[0]                          | Voltage Output (Range/Type) [a]    | Comments                                                                                                     |  |
| 0          | 0      | 0                               | -                                  | Current loop; see section 6.5.3.3                                                                            |  |
| 0          | 0      | 1                               | 0 to V <sub>DD</sub> , ratiometric | Typical 0 to 5V; with V <sub>DD</sub> > 5V, rail-to-rail output                                              |  |
| 0          | 1      | 0                               | 0 to 1V, absolute                  | Any (valid) V <sub>DD</sub>                                                                                  |  |
| 0          | 1      | 1                               | 0 to 5V, absolute                  | Requires V <sub>DD</sub> > 5.01V                                                                             |  |
| 1          | 0      | 0                               | -                                  | Not assigned                                                                                                 |  |
| 1          | 0      | 1                               | 0 to V <sub>DD</sub> , ratiometric | Typical 0 to 5V; with V <sub>DD</sub> > 5V, rail-to-rail output, OWI2 <sub>in</sub> enabled as OWI input pin |  |
| 1          | 1      | 0                               | 0 to 1V, absolute                  | Any (valid) V <sub>DD,</sub> OWI2 <sub>in</sub> enabled as OWI input                                         |  |
| 1          | 1      | 1                               | 0 to 5V, absolute                  | Requires V <sub>DD</sub> > 5.01V, OWI2 <sub>in</sub> enabled as OWI input                                    |  |

<sup>[</sup>a] The voltage outputs listed are directly supported, requiring minimal (for ratiometric output) or no (for absolute voltage output) additional external devices.

Table 30. Recommended Operating Conditions for Voltage Output

| Symbol                | Parameter                                | Typical Value | Unit | Comments                                                                         |
|-----------------------|------------------------------------------|---------------|------|----------------------------------------------------------------------------------|
| R <sub>low-pass</sub> | External, filter resistor at AOUT        | 1             | kΩ   | For 1kHz to 5kHz output bandwidth, as RC low-                                    |
| C <sub>low-pas</sub>  | External, filter capacity at AOUT        | 10            | nF   | pass filter configuration.                                                       |
| R <sub>Load</sub>     | External, resistive load at AOUT vs. VSS | 5 (min)       | kΩ   | Alternatively, to a low-pass filter, a single load resistor can be used instead. |

#### 6.5.3.2. Accuracy and Calibration of the DAC-Output

The 16-bit-DAC of ZSSC3240 is optimized from design prospective for high stability. Low drift over operational conditions can be achieved with minimal additional effort during the calibration phase, by compensating absolute errors/mismatches with mathematical adaptation of sensor calibration coefficients.

The functional, analog main-components of the ZSSC3240's DAC come with some residual level of IC-to-IC variation for DAC-characteristic's offset and gain. It is recommended to calibrate the DAC-characteristic and consider the linearity IC-to-IC-variation of the DAC at the IC's calibration, especially for applications with high requirements for absolute accuracy of the output voltage. For analog output configurations, the SSC coefficients can be derived such that the digital SSC-results and hence the DAC's digital input (S or T) is pre-shaped in order to compensate the residual DAC's (non-)linearity variation.

To avoid taking analog measurement values during the smart sensors' calibration procedure, the ZSSC3240 provides two high-precision DAC-calibration point measurement results in the NVM, DAC10RM5V and DAC90RM5V in the NVM registers  $22_{HEX}$  and  $23_{HEX}$ , see Table 34. Using these two high-precision DAC calibration points for the determination of the SSC-coefficients, the ZSSC3240 achieves a low residual, absolute DAC-output error of less than  $\pm 0.15\%$  over the device specified temperature range, and over the DAC output swinging from 1% to 100% of the specified range . This approach can be also interpreted as mapping of the digital SSC-outputs (S or T) to an IC-to-IC-varying best fit straight line characteristic of the DAC. The residual DAC-error is typically higher in the signal range 0% to 1%, as the ZSSC3240's does not provide exactly 0V for zero-value digital DAC-inputs, S or T.

If more than two DAC-calibration points is considered, absolute accuracies below ±0.15% become possible, down to the analog output (AOUT) line's noise-and-distortion level.

#### 6.5.3.3. Current Loop Output

The analog current loop is a typical output signal configuration, especially for industrial sensors. Using only two wires, the sensor is supplied with power and transmits its output signal to the processing unit. With  $Aout\_setup = 000_{BIN}$  (bits [7:5] in the SSF2 register; see Table 34), the ZSSC3240 will generate a SSC-corrected sensor-signal-proportional control signal at AOUT that allows generating a related loop current according the application in Figure 21.

Table 31. ZSSC3240 Current-Loop-Specific Properties

| Symbol                  | Parameter                                                           | Typical Value | Unit    | Comments                                                                                                                                                                                                                                                                              |
|-------------------------|---------------------------------------------------------------------|---------------|---------|---------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------|
| R <sub>1</sub>          | Control feedback resistor, internal                                 | 120           | kΩ      | Combined with external R <sub>SENS</sub> , defines the current-loop gain: R <sub>1</sub> /R <sub>SENS</sub> R <sub>1</sub> -process-variation in the range of ±20%                                                                                                                    |
| R <sub>SENS</sub>       | External loop-sensing resistor                                      | 50            | Ω       | Using a low-TC resistor is recommended to minimize spurious temperature influence                                                                                                                                                                                                     |
| β <sub>TLOOP</sub>      | Current gain of external-loop bipolar transistor, T <sub>LOOP</sub> | 100           | Numeric |                                                                                                                                                                                                                                                                                       |
| BW <sub>L</sub>         | Transfer bandwidth of internal current loop op amp.                 | 20            | kHz     |                                                                                                                                                                                                                                                                                       |
| R <sub>SENSOR,MIN</sub> | External sensor element's minimum resistance                        | 1.6           | kΩ      | With a ratiometric supply and resistances that are too low, the overall current consumption ( $I_{Sensor} + I_{IC}$ ) at $V_{DD}$ could exceed the 4mA low-limit for typical current loops (see Table 3 for $I_{Sensor}$ specifications, and see Table 4 for $I_{IC}$ specifications) |
| I <sub>Loop,high</sub>  | Loop-response current for logical-1; OWI over current-loop          | 1418          | mA      | Effective current modulation when ZSSC3240 is OWI slave modulating the slave-to-master                                                                                                                                                                                                |
| I <sub>Loop,low</sub>   | Loop-response current for logical-0; OWI over current-loop          | 46            | mA      | response via the loop current (controlled by AOUT/OWI1)                                                                                                                                                                                                                               |

Strong recommendation: Use the Zener diode between FB and VDD to protect the  $V_{DD}$  line from positive overvoltage conditions and protect the FB input from negative over-voltages. The 100nF capacitor performs a low-pass-filter function for short/fast changes in the total current consumption for the sensor element plus the ZSSC3240 ( $I_{SENS} + I_{IC}$ ), such that current consumption changes do not lead to short-term fluctuations of AOUT and the loop current.

An equivalent effect of slight loop current fluctuations might be observable if a sensor-connection check is sometimes executed between the normal sensor measurements. Here, the connected sensor element, e.g., a resistive bridge, will be unsupplied briefly in order to determine the electrical connection properties; whereas an overall load change (sensor measurements  $\rightarrow$  sensor-connection check  $\rightarrow$  sensor-measurement) at  $V_{DD}$  and hence in the current loop will be present. Therefore, diagnostic features should be carefully enabled and selected for current loop applications that have strong requirements for output signal quality under any circumstances.

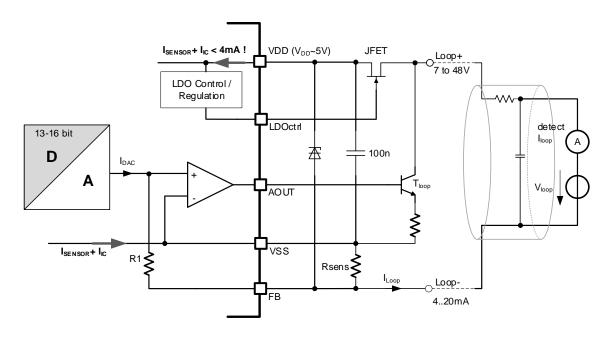


Figure 21. Current Loop Configuration

#### 6.5.4. Output Interrupt Signaling

The EOC pin can be programmed to operate either as a simple "measurement busy" and end-of-conversion transducer or as a configurable interrupt transducer, which is configured using the  $INT\_setup[1:0]$  bits in NVM register  $02_{HEX}$ , bits[8:7]. Further, one or two 24-bit quantized thresholds can be programmed via TRSH1 and TRSH2 (Interrupt Level Setup registers  $18_{HEX}$ ,  $19_{HEX}$  and  $14_{HEX}$  in NVM; see Table 34). Depending on the  $INT\_setup$  selection, the EOC pin provides a logic 1 or logic 0 (also dependent on the respective interface setup; e.g., SPI with either logic  $0 = V_{DD}$  or logic  $0 = V_{SS}$ , etc.) according to the SSC-corrected measurement result. The respective thresholds must be programmed left-aligned in the memory with the threshold's MSB in the memory register's MSB, etc. The LSBs of the 24-bit threshold in memory are ignored depending on the number of bits of the ADC resolution as selected with  $adc\_bits$  (see Table 10).

With  $INT\_setup = 00_{BIN}$ , only the effective end-of-conversion is signalized. The EOC signal is a pulse of approximately  $5\mu s$  (see Figure 22). The next command will be executed only after this EOC signaling period.

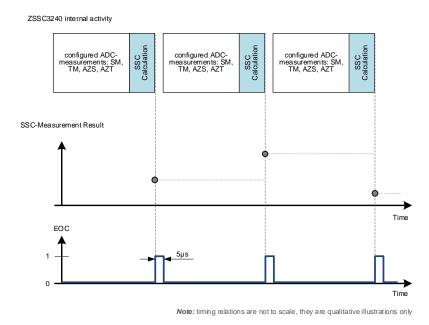


Figure 22. EOC-Behavior: Signalization of End-of-Conversion ( $INT\_setup = 00_{BIN}$ )

The interrupt functionality is only available for digital values from the SSC-calculation unit. The interrupt feature cannot monitor raw values. The encoding and data format of the interrupt thresholds is the same as for SSC-corrected measurement results (see Table 32).

Table 32. Data Format of Interrupt Thresholds (TRSH1 and TRSH2)

| Bit-Number            | 23                    | 22  | 21  | 20              | <br>2                | 1                | 0    |
|-----------------------|-----------------------|-----|-----|-----------------|----------------------|------------------|------|
| Meaning,<br>Weighting | <b>2</b> <sup>0</sup> | 2-1 | 2-2 | 2 <sup>-3</sup> | <br>2 <sup>-21</sup> | 2 <sup>-22</sup> | 2-23 |

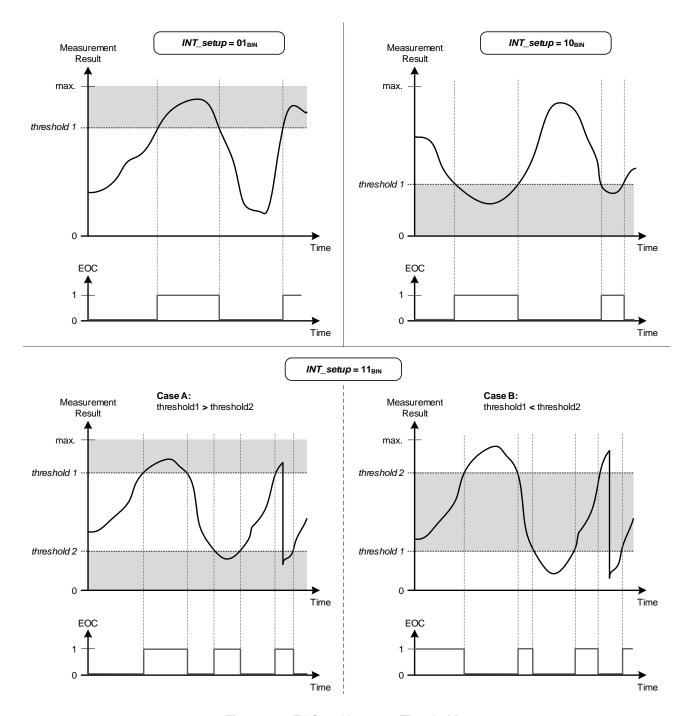


Figure 23. EOC and Interrupt Thresholds

# 6.6 System Setup and Control

The digital blocks of the ZSSC3240 are organized functionally as shown in Figure 24. In addition to the central blocks, which are the "Interfaces," "Digital Main Core," and "Memory (NVM)" blocks, there is also the Shadow Registers block, which in most cases, is a direct copy of the NVM registers. The shadow registers are loaded from NVM during the power-up sequence and allow acceleration of command processing and NVM-independent configuration adaptability; e.g., during adaptive sensor setup, evaluation, or smart sensor test. For the main function of the ZSSC3240 to conduct a sensor measurement and ADC-conversion, the setups (for main Sensor or Temperature) are loaded or activated from the corresponding Shadow Registers in order to set all IC-internal configuration switches for sensor supply, PGA gain, offset compensation, reference voltage sources, etc. After a settling time for the analog signals and levels, the A2D conversion takes place. This course of activities is (re-)done for each individual measurement, i.e. once for SM, AZS, TM, AZT, with setups for SM and AZS according the Shadow Registers for SM\_config1 and SM\_config2, and for TM, AZT from registers extTemp\_config1 and extTemp\_config2. If the internal temperature sensor was selected as signal source for TM, AZT, the setups are loaded from a Renesas-preprogrammed register different to extTemp\_config1 and extTemp\_config2.

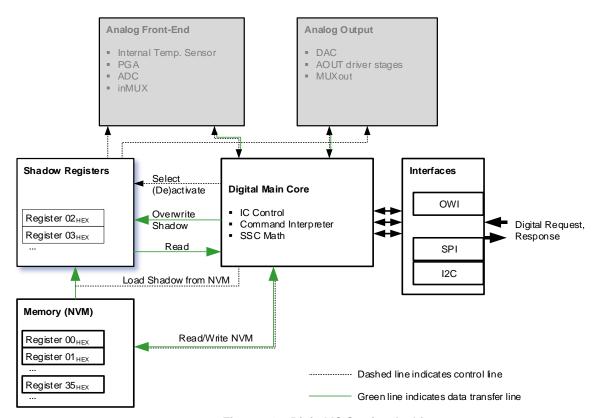


Figure 24. Digital IC Section Architecture

# 6.6.1. Digital Commands

The availability of commands depends on the active main operating mode: Command, Sleep, or Cyclic Mode.

#### Table 33. Command List

Note: See important table notes as the end of this table.

| Command Code<br>(Byte)                                                                                         | Return      | Description                                                                                                                                                                          | Available in<br>Sleep Mode | Available in<br>Command Mode | Available in<br>Cyclic Mode |
|----------------------------------------------------------------------------------------------------------------|-------------|--------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------|----------------------------|------------------------------|-----------------------------|
| 00 <sub>HEX</sub> to 3F <sub>HEX</sub>                                                                         | 16-bit data | Memory Read address 00 <sub>HEX</sub> to 3F <sub>HEX</sub>                                                                                                                           | Yes                        | Yes                          | No                          |
| 40 <sub>HEX</sub> to 75 <sub>HEX</sub><br>followed by data<br>(0000 <sub>HEX</sub> to<br>FFFF <sub>HEX</sub> ) | -           | <b>Memory Write</b> addresses $00_{HEX}$ to $35_{HEX}$ (NVM register address is command minus $40_{HEX}$ ); if the NVM is locked, write requests are not acknowledged or are ignored | Yes                        | Yes                          | No                          |

| Command Code<br>(Byte) | Return                                                                                         | Description                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                    | Available in<br>Sleep Mode | Available in Command Mode | Available in Cyclic Mode |
|------------------------|------------------------------------------------------------------------------------------------|--------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------|----------------------------|---------------------------|--------------------------|
| 90 <sub>HEX</sub>      | -                                                                                              | Calculate NVM Checksum and write it to the memory                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                              | Yes                        | Yes                       | No                       |
| A2 <sub>HEX</sub>      | 24-bit raw data                                                                                | Raw Sensor Measurement [a] – Configuration is loaded in the controlling shadow registers from the <i>SM_config1</i> and <i>SM_config2</i> registers in NVM Note: auto-zero sensor measurement is performed if set up in the AZMs_on bit in the SSF2 register                                                                                                                                                                                                                                                                                                                                                                                                                   | Yes                        | Yes                       | No                       |
| A4 <sub>HEX</sub>      | 24-bit raw data                                                                                | Raw Temperature Measurement [a] — Configuration is loaded in the controlling shadow registers from the extTemp_Config1/2 or T_config1/2 registers in NVM as well as the SSF1/2 registers  Note: Auto-zero correction will be performed if set up via the AZMt_on bit in the SSF2 register  Note: If a raw data measurement with an external setup (different from the NVM content) will be performed, then pre-load the measurement configuration via the Overwrite SSF1/2 Register and Overwrite T_config1/2 Shadow Register commands.  Note: The internal or external temperature measurement will be performed if set up via the temp_source bit field in the SSF1 register | Yes                        | Yes                       | No                       |
| A8 <sub>HEX</sub>      | -                                                                                              | START_SLEEP – Exit Command Mode or Cyclic Mode and transition to Sleep Mode Note: The response to <i>Start_Sleep</i> is only the status byte                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                   | No                         | Yes                       | Yes                      |
| A9 <sub>HEX</sub>      | -                                                                                              | START_CM – Exit Sleep Mode or Cyclic Mode and transition to Command Mode                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                       | Yes                        | No                        | Yes                      |
| AA <sub>HEX</sub>      | 24-bit SSC-<br>corrected<br>sensor data and<br>24-bit SSC-<br>corrected<br>temperature<br>data | <b>Measure</b> – Trigger a full measurement (autozero-sensor, sensor, auto-zero-temperature, temperature) and perform SSC correction Note: Auto-zero correction is performed with this command if set up in the <i>AZMs_on</i> and <i>AZMt_on</i> bits in the <i>SSF2</i> register                                                                                                                                                                                                                                                                                                                                                                                             | Yes                        | Yes                       | No                       |
| AB <sub>HEX</sub>      | -                                                                                              | START_CYC – Enter the Cyclic Mode:<br>continuous measurement cycles, SSC<br>corrections, and automatic, continuous digital<br>and/or analog output updates                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                     | Yes                        | Yes                       | No                       |
| АСнех                  |                                                                                                | Oversample-2 Measure <sup>[b]</sup> – Mean value generation; 2 full measurements (triggered similar to AA <sub>HEX</sub> , not cyclic) are performed and the resulting mean value is provided as output Note: Auto-zero correction is performed with this command if set up in the AZMs_on and AZMt_on bits in the SSF2 register                                                                                                                                                                                                                                                                                                                                               | Yes                        | Yes                       | No                       |
| AD <sub>HEX</sub>      | 24-bit SSC-<br>corrected<br>sensor data and<br>24-bit SSC-<br>corrected<br>temperature<br>data | Oversample-4 Measure [b] – Mean value generation; 4 full measurements (triggered similar to AA <sub>HEX</sub> , not cyclic) are performed and the resulting mean value is provided as output Note: Auto-zero correction is performed with this command if set up in the AZMs_on and AZMt_on bits in the SSF2 register                                                                                                                                                                                                                                                                                                                                                          | Yes                        | Yes                       | No                       |
| AE <sub>HEX</sub>      |                                                                                                | Oversample-8 Measure [b] – Mean value generation; 8 full measurements (triggered similar to AA <sub>HEX</sub> , not cyclic) are performed and the resulting mean value is provided as output Note: Auto-zero correction is performed with this command if set up in the AZMs_on and AZMt_on bits in the SSF2 register                                                                                                                                                                                                                                                                                                                                                          | Yes                        | Yes                       | No                       |

| Command Code<br>(Byte)                                                           | Return                              | Description                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                               | Available in<br>Sleep Mode | Available in Command Mode | Available in Cyclic Mode |
|----------------------------------------------------------------------------------|-------------------------------------|-----------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------|----------------------------|---------------------------|--------------------------|
| AF <sub>HEX</sub>                                                                |                                     | Oversample-16 Measure [b] – Mean value generation; 16 full measurements (triggered similar to AA <sub>HEX</sub> , not cyclic) are performed and the resulting mean value is provided as output Note: Auto-zero correction is performed with this command if set up in the AZMs_on and AZMt_on bits in the SSF2 register                                                                                                                                                                                                                                                                                                                                                                                                                                   | Yes                        | Yes                       | No                       |
| B0 <sub>HEX</sub>                                                                | 16-bit<br>diagnostic<br>result data | CHECK_DIAG – The ZSSC3240 responds with<br>the detailed fault-result status in the<br>diagnosticreg register                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                              | Yes                        | Yes                       | No                       |
| B1 <sub>HEX</sub>                                                                | _                                   | RESET_DIAG – Resets the contents of diagnosticreg to 00 <sub>HEX</sub>                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                    | Yes                        | Yes                       | No                       |
| B2 <sub>HEX</sub>                                                                | -                                   | Update_DIAG — Causes a complete diagnostics check cycle including memory CRC calculation, etc., and results in a reset and update of diagnosticreg  Note: If a measurement cycle is running concurrently, the diagnostic update happens after completion of the measurement cycle and SSC calculations (and might delay the next cyclic measurement cycle)                                                                                                                                                                                                                                                                                                                                                                                                | Yes                        | Yes                       | No                       |
| B3 <sub>HEX</sub> followed by data (0000 <sub>HEX</sub> to FFFF <sub>HEX</sub> ) | -                                   | DAC Diagnostic – Set the DAC output register with the data in the command and enable/output the respective analog signal through AOUT (according to the AOUT_setup)  Note: The DAC output can be switched off by the RESQ pin, POR, or a change in the main operating mode  Note: DAC Diagnostic feature is only applicable with the interfaces I2C and SPI.                                                                                                                                                                                                                                                                                                                                                                                              | No                         | Yes                       | No                       |
| B4 <sub>HEX</sub> followed by 00XX <sub>HEX</sub>                                | 24-bit raw data                     | Self-Diagnostic Measure – The ADC performs a raw measurement with the setup from the $SM\_config$ registers, and the PGA input is disconnected from the external sensor and internally shorted (INN = INP = AGND). The ZSSC3240-internal setup, which is configured according to the <i>ioffsc</i> bit field in the $SM\_config2$ register, is changed to $XX_{HEX}$ (transmitted with the command). The respective pseudo-offset signal becomes the input test signal to the PGA-ADC-path.  The original $ioffsc$ and $SM\_config2$ contents are restored after the self-diagnostic measurement completion.  Note: alternatively, also a changed setup (PGA, ADC) could be used by applying Overwrite commands prior to the self-diagnostic measurement. | No                         | Yes                       | No                       |
| D1 <sub>HEX</sub> followed by XXXX <sub>HEX</sub>                                | _                                   | Set Post-Calibration Offset – Set recent SSC-<br>output to expected value XXXX <sub>HEX</sub> in command<br>by means of offset adjustment with coefficient<br>SENS_shift                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                  | Yes                        | Yes                       | No                       |
| D2 <sub>HEX</sub>                                                                | -                                   | Startup OWI – Initialization command to enter<br>OWI interface operation; only valid for OWI (see<br>section 6.4.3)                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                       | Yes                        | Yes                       | Yes                      |
| D6 <sub>HEX</sub> followed by data (0000 <sub>HEX</sub> to FFFF <sub>HEX</sub> ) | -                                   | Overwrite SM_config1 shadow register – Content (originally from NVM register 14 <sub>HEX</sub> ) in the digital shadow register for SM_config1 is directly overwritten with the command data [c]                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                          | No                         | Yes                       | No                       |
| D7 <sub>HEX</sub> followed by data (0000 <sub>HEX</sub> to FFFF <sub>HEX</sub> ) | -                                   | Overwrite SM_config2 shadow register — Content (originally from NVM register 15 <sub>HEX</sub> ) in the digital shadow register for SM_config2 is directly overwritten with the command data <sup>[c]</sup>                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                               | No                         | Yes                       | No                       |

| Command Code<br>(Byte)                                                                 | Return                                    | Description                                                                                                                                                                                                                                                                                              | Available in<br>Sleep Mode | 711 411411010 111 | Available in Cyclic Mode |
|----------------------------------------------------------------------------------------|-------------------------------------------|----------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------|----------------------------|-------------------|--------------------------|
| D8 <sub>HEX</sub> followed by data (0000 <sub>HEX</sub> to FFFF <sub>HEX</sub> )       | -                                         | Overwrite <i>T_config</i> 1 shadow register – Content (originally from NVM register 16 <sub>HEX</sub> or 3C <sub>HEX</sub> ) in the digital shadow register for the temperature measurement is directly overwritten with the command data <sup>[c]</sup>                                                 | No                         | Yes               | No                       |
| D9 <sub>HEX</sub> followed by data (0000 <sub>HEX</sub> to FFFF <sub>HEX</sub> )       | -                                         | Overwrite <i>T_config2</i> shadow register – Content (originally from NVM register 17 <sub>HEX</sub> or 3D <sub>HEX</sub> ) in the digital shadow register for the temperature measurement is directly overwritten with the command data <sup>[c]</sup>                                                  | No                         | Yes               | No                       |
| DA <sub>HEX</sub> followed<br>by data (0000 <sub>HEX</sub><br>to FFFF <sub>HEX</sub> ) | -                                         | Overwrite SSF1 shadow register – Content (originally from NVM register 03 <sub>HEX</sub> ) n the digital shadow register for SSF1 is directly overwritten with the command data <sup>[c]</sup> Note: transferred bits[1:0] and bits[15:13] are ignored; i.e., are not overwritten in the shadow register | No                         | Yes               | No                       |
| DB <sub>HEX</sub> followed<br>by data (0000 <sub>HEX</sub><br>to FFFF <sub>HEX</sub> ) | -                                         | Overwrite SSF2 shadow register – Content (originally from NVM register 04 <sub>HEX</sub> ) the digital shadow register for SSF2 is directly overwritten with the command data <sup>[c]</sup>                                                                                                             | No                         | Yes               | No                       |
| FX <sub>HEX</sub>                                                                      | Status followed<br>by last 24-bit<br>data | NOP – Output of read results; only valid for SPI (see section 6.4.1)                                                                                                                                                                                                                                     | Yes                        | Yes               | Yes                      |

<sup>[</sup>a] These commands can be used to conduct a measurement without an SSC correction; e.g., during the smart sensor calibration procedure. No digital correction is performed on the measurement result. The setup and configuration for the raw measurement is the content in the shadow registers that can be pre-loaded (automatically loaded during power-on) from the NVM or by means of the *Overwrite* commands, D6<sub>HEX</sub> to DB<sub>HEX</sub>.

- [b] Use Oversample measurements to obtain noise-minimized measurement results in Sleep or Command Mode. With higher oversampling factors, the command execution time increases proportionally.
- [c] Overwrite commands can be used to optimize evaluation and test routine execution time for analog front-end setup or to configure self-diagnostic measurement setups without needing to change the ZSSC3240's NVM content. The content and effects from Overwrite commands are cleared and reset with the ZSSC3240 reset via the RESQ pin or POR.

#### 6.6.2. Nonvolatile Memory (NVM)

In the ZSSC3240, the memory is organized in 16-bit wide registers and can be programmed multiple times (approximately 10000). There are  $54 \times 16$ -bit registers available for customer use. Each register can be reprogrammed.

Basically, there are two NVM content sectors:

- Customer Use: Accessible via regular write operations: 40<sub>HEX</sub> to 75<sub>HEX</sub>. This sector contains the customer ID, interface setup data, measurement setup information, calibration coefficients, analog output configuration, etc.
- Renesas Use: Only accessible for write operations by Renesas. This sector (36<sub>HEX</sub> to 3F<sub>HEX</sub>) contains specific trim information and is programmed during manufacturing test by Renesas, e.g. setups for the internal temperature sensor are stored there.

The whole NVM can be locked by programming  $lock = 1_{BIN}$  in the SSF1 register, NVM address  $03_{HEX}$ , bit[14]. No change of the NVM content is possible once the NVM lock has been activated.

Recommendations when using the NVM lock:

- · Write all required setups, configurations, and SSC coefficients to the NVM first.
- Then write the SSF1 register content with the lock bit set.
- Then trigger the generation and writing of the CRC via the Calculate NVM Checksum command, 90<sub>HEX</sub>.

The NVM lock will be effective after a ZSSC3240 reset with POR or RESQ.

# 6.6.2.1. Memory Contents

Table 34. Memory (NVM) Content Assignments

| NVM Address       | Word/Bit Range | Default Setting         | Description       | Notes/Explanations                                                                                                                            |
|-------------------|----------------|-------------------------|-------------------|-----------------------------------------------------------------------------------------------------------------------------------------------|
| 00 <sub>HEX</sub> | 15:0           | 0000 <sub>HEX</sub>     | Cust_ID0          | Customer ID byte 0 (combines with memory word 01 <sub>HEX</sub> to                                                                            |
| 01 <sub>HEX</sub> | 15:0           | 0000 <sub>HEX</sub>     | Cust_ID1          | form customer ID) <sup>[a]</sup> Customer ID byte 1 (combines with memory word 00 <sub>HEX</sub> to                                           |
| O'HEX             | 10.0           |                         |                   | form customer ID).                                                                                                                            |
|                   |                |                         | Interface Configu | I2C and OWI slave address; valid range: 00 <sub>HEX</sub> to 7F <sub>HEX</sub>                                                                |
|                   | 6:0            | 000 0000 <sub>BIN</sub> | Slave_Addr        | (default: $00_{\text{HEX}}$ ).  Note: address codes $04_{\text{HEX}}$ to $07_{\text{HEX}}$ are reserved for entering the I2C High Speed Mode. |
|                   |                |                         |                   | Interrupt configuration, EOC pin functionality:                                                                                               |
|                   |                |                         |                   | 00 = End-of-conversion signal                                                                                                                 |
|                   |                |                         |                   | 01 = 0 to 1 transition if threshold1 ( <i>TRSH1</i> ) is exceeded and 1 to 0 transition if threshold1 is underrun again                       |
|                   |                |                         |                   | 10 = 0 to 1 transition if threshold1 is underrun and 1 to 0 transition if threshold1 is exceeded again                                        |
|                   | 8:7            | 00 <sub>BIN</sub>       | INT_setup         | <ul> <li>11 = EOC is determined by threshold settings (see section 6.5.4):</li> <li>If (TRSH1 &gt; TRSH2) then EOC/INT (interrupt</li> </ul>  |
|                   |                |                         |                   | level) = 0 if $(TRSH1 > MEAS \ge TRSH2)$ where MEAS is the conditioned measurement result. Otherwise EOC/INT = 1.                             |
|                   |                |                         |                   | • If (TRSH1 ≤ TRSH2) then EOC = 1 if (TRSH1 ≤ MEAS < TRSH2). Otherwise EOC = 0.                                                               |
|                   |                |                         |                   | Determines the polarity of the Slave Select pin (SS) for SPI operation:                                                                       |
|                   | 9              | O <sub>BIN</sub>        | SS_polarity       | 0 = Slave Select is active low (SPI and ZSSC3240 are active if SS==0)                                                                         |
| 02 <sub>HEX</sub> |                |                         |                   | 1 = Slave Select is active high (SPI and ZSSC3240 are active if SS==1)                                                                        |
|                   |                |                         | CKP_CKE           | Clock polarity and clock-edge select. <i>CKP_CKE</i> determines polarity and phase of SPI interface clock with the following modes:           |
|                   |                |                         |                   | 00 = SCLK is low in idle state; data latch with rising edge and data output with falling edge                                                 |
|                   | 11:10          | 00 <sub>BIN</sub>       |                   | 01 = SCLK is low in idle state; data latch with falling edge and data output with rising edge                                                 |
|                   |                |                         |                   | 10 = SCLK is high in idle state; data latch with falling edge and data output with rising edge                                                |
|                   |                |                         |                   | 11 = SCLK is high in idle state; data latch with rising edge and data output with falling edge                                                |
|                   |                |                         |                   | Update period in cyclic operation:                                                                                                            |
|                   |                |                         |                   | 000 = 0.0ms 100 = 5.0ms<br>001 = 0.1ms 101 = 10ms                                                                                             |
|                   |                |                         |                   | 001 = 0.1ms                                                                                                                                   |
|                   | 14:12          | 000 <sub>BIN</sub>      | CYC_period        | 011 = 2.5ms                                                                                                                                   |
|                   |                |                         |                   | Note: A slower measurement rate, i.e., a higher CYC_period,                                                                                   |
|                   |                |                         |                   | can improve the analog output signal quality due to lower                                                                                     |
|                   |                |                         |                   | system bandwidth.  Type/shape of second-order curve correction for the sensor                                                                 |
|                   |                |                         |                   | signal:                                                                                                                                       |
|                   | 15             | O <sub>BIN</sub>        | SOT_curve         | 0 = Parabolic curve                                                                                                                           |
|                   |                |                         |                   | 1 = S-shaped curve                                                                                                                            |
|                   |                | Smart Sensor F          | eature Configurat | tion Register 1 (SSF1)                                                                                                                        |
| 03 <sub>HEX</sub> | 1:0            | 00 <sub>віN</sub>       | default_mode      | Defines the default operating mode that is automatically entered after power-on:                                                              |
| O THEA            |                | ODIIN                   | doladit_illodo    | 00 = Command Mode 10 = Sleep Mode<br>01 = Cyclic Mode 11 = Not assigned                                                                       |

| NVM Address | Word/Bit Range | Default Setting    | Description   | Notes/Explanations                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                      |
|-------------|----------------|--------------------|---------------|-----------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------|
|             | 2              | O <sub>BIN</sub>   | owi_su_length | Defines the length of the OWI startup window, during which the OWI interface can be activated if analog output through the AOUT pin is also set up via $cont\_ANAoutn = 0_{BIN}$ (see register $04_{HEX}$ ).  OWI_ListenTime: $0 = 50 ms$ $1 = 3 ms$                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                    |
|             | 3              | O <sub>BIN</sub>   | owi_su_case   | Defines the activation level for the analog output at AOUT with or without concurrent OWI1 I/O behavior (see section 6.4.3 for OWI application cases):  0 = Regular, separate Startup Window for OWI first, then switch over to AOUT behavior  1 = Direct start with output of analog signal at AOUT                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                    |
|             | 6:4            | 000вім             | temp_source   | Selection of utilized temperature sensor source:  000 = Integrated PTAT temperature sensor (no extra setup required)  001 = Bridge as temperature sensor with internal Rt in Current Mode <sup>[b]</sup> 010 = Current Mode through T <sub>EXT</sub> <sup>[b]</sup> for one of the following:  • Bridge as the temperature sensor with external Rt at T <sub>EXT</sub> • Single diode/resistor at T <sub>EXT</sub> 011 = Not assigned  100 = Current Mode operation for diode or PTC between T <sub>EXT</sub> and VSSB <sup>[b]</sup> 101 = Ratiometric supply for the sensor (bridge) as the temperature sensor with the internal Rt <sup>[b]</sup> 110 = Ratiometric supply for sensor (bridge) as the temperature sensor with the external Rt between sensor (bridge) top and T <sub>EXT</sub> pin <sup>[b]</sup> 111 = Not assigned |
|             | 8:7            | 00 <sub>BIN</sub>  | sensor_sup    | Front-end operation and supply setup for main measurand sensor measurements:  00 = Ratiometric supply at VDDB  01 = Current Mode out of VDDB from Tbias (see section 6.2)  10 = Absolute voltage (Thermopile)  11 = Not assigned  Note: if temp_source = 100 (temperature application T3.2) is also set up, sensor_sup = 01 must be configured in order to get ratiometric main sensor supply at VDDB.  Top resistance set up for "Bridge as temperature sensor"                                                                                                                                                                                                                                                                                                                                                                        |
|             | 11:9           | 000 <sub>вім</sub> | internal_rt   | configuration (see Table 15). Selection of resistance value (internal $Rt$ ) for re-using the sensor (bridge) as the temperature sensor with internal $Rt$ ( $temp\_source = 001$ or $101$ ). Selected $Rt$ value is as follows: $000 = 1.34k\Omega \qquad 100 = 15k\Omega \\ 001 = 4k\Omega \qquad 101 = 20k\Omega \\ 010 = 8k\Omega \qquad 110 = 30k\Omega \\ 011 = 10k\Omega \qquad 111 = 40k\Omega$ Note: the same value is selected for the bottom $Rt$ , if $extra\_rt = 1_{BIN}$ is selected                                                                                                                                                                                                                                                                                                                                     |

| NVM Address       | Word/Bit Range | Default Setting   | Description        | Notes/Explanations                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                      |
|-------------------|----------------|-------------------|--------------------|---------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------|
|                   | 12             | O <sub>BIN</sub>  | extra_rt           | Bottom resistance set up for the "Bridge as temperature sensor" configuration.  If temp_source = 110 or 010 (or 100 combined with sensor_sup = 01), then extra_rt defines whether an internal bottom resistor Rt equivalent to the internal_rt selection is placed between VSSB and PGA negative input:  0 = Use internal Rt (no extra external Rt)  1 = Extra external Rt (do not apply internal Rt)  Note: with temp_source = 100 AND sensor_sup = 10, the meaning of extra_rt bit is swapped (that is extra_rt = 0 means internal Rt is not enabled) |
|                   | 13             | O <sub>BIN</sub>  | owi_off            | Setup bit to disable OWI interface: 0 = OWI is enabled and usable 1 = OWI is disabled and cannot be used Note: This setting has no effect on SPI or I2C operation                                                                                                                                                                                                                                                                                                                                                                                       |
|                   | 14             | O <sub>BIN</sub>  | lock               | Lock bit: no further NVM writing is possible if this bit is set.  0 = NVM write allowed  1 = NVM locked  Note: Once this bit is set to 1, the lock becomes effective after the next IC reset.                                                                                                                                                                                                                                                                                                                                                           |
|                   | 15             | O <sub>BIN</sub>  | cp_off             | Switch off the charge pump for the internal regulators:  0 = Charge pump on (recommended setting for better PSRR, or when external VDD<4.3V)  1 = Charge pump off (less current consumption and lower distortion risks, e.g. coupling to VSS); this might be needed to ensure the 4mA low-limit in current loop applications (default setting for preconfigured Current-Loop application products, for example, ZSSC3240CL1B and ZSSC3240CL3R)  Note: Switch off the charge pump only if VDD > 4.3V is ensured                                          |
|                   | ·              | Smart Sensor Fo   | eature Configurati | ion Register 2 (SSF2):                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                  |
|                   | 1:0            | 00 <sub>BIN</sub> | dacres             | Setup of DAC output resolution:<br>00 = 13-bit                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                          |
|                   | 2              | 1 <sub>BIN</sub>  | dither_off         | Switch on/off the dithering function for the DAC:  0 = Dither is applied for DAC outputs  1 = Dither is switched off                                                                                                                                                                                                                                                                                                                                                                                                                                    |
| 04 <sub>HEX</sub> | 3              | O <sub>BIN</sub>  | dacouttype         | Defines if the SSC-corrected sensor(bridge) signal S or the temperature signal T is the output at the DAC:  0 = Sensor signal S is output at the DAC  1 = Temperature signal T is output at DAC                                                                                                                                                                                                                                                                                                                                                         |
|                   | 4              | O <sub>BIN</sub>  | cont_ANAoutn       | Selects whether the ZSSC3240 provides analog output in general:  0 = Analog (DAC) output is enabled  1 = No analog output (cyclic operation with digital outputs is still possible)  Note: If cont_ANAoutn is set to 1, then Aout_setup is ignored; there is no analog output in Sleep Mode in general                                                                                                                                                                                                                                                  |

| NVM Address | Word/Bit Range | Default Setting    | Description            | Notes/Explanations                                                                                                                                                                                                                                                                                                                          |
|-------------|----------------|--------------------|------------------------|---------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------|
|             |                |                    |                        | Definition of the basic AOUT pin behavior:                                                                                                                                                                                                                                                                                                  |
|             |                |                    |                        | 000 = Current loop enabled, output through error amplifier for current loop <sup>[c]</sup> , OWI listens to both the OWI2 <sub>in</sub> and OWI1 pins concurrently (default setting for pre-configured Current-Loop application products, for example, ZSSC3240CL1B and ZSSC3240CL3R)                                                       |
|             |                |                    |                        | 001 = External V <sub>DD</sub> -ratiometric, rail-to-rail out                                                                                                                                                                                                                                                                               |
|             | 7:5            | 001 <sub>BIN</sub> | Aout_setup             | 010 = 0V to 1.0V absolute output                                                                                                                                                                                                                                                                                                            |
|             |                |                    |                        | 011 = 0V to 5V absolute output                                                                                                                                                                                                                                                                                                              |
|             |                |                    |                        | 100 = not assigned                                                                                                                                                                                                                                                                                                                          |
|             |                |                    |                        | 101 = External V <sub>DD</sub> -ratiometric, rail-to-rail out (OWI2 <sub>in</sub> enabled)                                                                                                                                                                                                                                                  |
|             |                |                    |                        | 110 = 0V to 1.0V absolute output (OWI2 <sub>in</sub> enabled)                                                                                                                                                                                                                                                                               |
|             |                |                    |                        | 111 = 0V to 5V absolute output (OWI2 <sub>in</sub> enabled)                                                                                                                                                                                                                                                                                 |
|             | 8              | O <sub>BIN</sub>   | diagouten              | Enable diagnostic level output mode: The lower and upper analog output range levels are reserved for diagnostic signaling according to Table 16. The ZSSC3240 performs an automatic DAC-output scaling (if already digitally calibrated) to reserve the lower and upper 1.56% band or absolute voltage levels:  0 = No analog signalization |
|             |                |                    |                        | 1 = Analog diagnostic signaling is enabled  Switch off the internal output regulator circuit running the                                                                                                                                                                                                                                    |
|             | 9              | O <sub>BIN</sub>   | disable_ldoctrl        | LDOctrl pin if no external supply transistor (such as JFET) is used; this reduces current consumption, etc.  0 = LDOctrl output is switched/kept on  1 = LDOctrl output switched off  Note: If enabled (= 0), then the charge-pump can be off (the cp_off bit = 1 in register 03 <sub>HEX</sub> )                                           |
|             |                |                    |                        | Set point for regulated V <sub>DD</sub> using external supply transistor                                                                                                                                                                                                                                                                    |
|             | 11:10          | 10 <sub>BIN</sub>  | VDD_ldoctrl<br>_target | JFET or depletion MOSFET:<br>$00 = V_{DD} = 4.8V$<br>$01 = V_{DD} = 5.0V$<br>$10 = V_{DD} = 5.2V$                                                                                                                                                                                                                                           |
|             |                |                    |                        | $11 = V_{DD} = 5.4V$                                                                                                                                                                                                                                                                                                                        |
|             |                |                    |                        | Enable/disable for auto-zero measurement for (bridge) sensor measurement:  0 = No auto-zero measurements for sensor signal                                                                                                                                                                                                                  |
|             | 12             | O <sub>BIN</sub>   | AZMs_on                | Auto-zero measurement of sensor bridge is performed and processed                                                                                                                                                                                                                                                                           |
|             |                |                    |                        | Note: This setup is ignored for raw data measurements with setup via the interface, i.e. command A2 <sub>HEX</sub>                                                                                                                                                                                                                          |
|             |                |                    |                        | Enable/disable for auto-zero measurement for temperature measurement:                                                                                                                                                                                                                                                                       |
|             | 13             | O <sub>BIN</sub>   | AZMt_on                | 0 = No auto-zero measurements for temperature signal                                                                                                                                                                                                                                                                                        |
|             |                |                    |                        | 1 = Auto-zero measurement for temperature signal performed and processed                                                                                                                                                                                                                                                                    |
|             | 15:14          | ОО <sub>ВІN</sub>  | oversamp_cyc           | Selection for applied digital oversampling in Cyclic Mode operation:  00 = No oversampling  01 = Oversample-4: Results of 4 SSC cycles per last meas_scheduler sequence  10 = Oversample-8: Results of 8 SSC cycles per last meas_scheduler sequence  11 = Oversample-16: Results of 16 SSC cycles per last meas_scheduler sequence         |
|             |                |                    |                        | Note: This setup is ignored for any measurement in Command and Sleep Mode                                                                                                                                                                                                                                                                   |

| NVM Address       | Word/Bit Range | Default Setting     | Description        | Notes/Explanations                                                                                                                                                                                                             |
|-------------------|----------------|---------------------|--------------------|--------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------|
|                   |                | Sign                | al Conditioning Pa | arameters                                                                                                                                                                                                                      |
| 05 <sub>HEX</sub> | 15:0           | 0000 <sub>HEX</sub> | Offset_S[15:0]     | Bits [15:0] of the 24-bit-wide sensor offset correction coefficient Offset_S. The MSBs including sign are Offset_S[23:16], which is [15:8] in register 0F <sub>HEX</sub> .                                                     |
| 06 <sub>HEX</sub> | 15:0           | 0000 <sub>HEX</sub> | Gain_S[15:0]       | Bits [15:0] of the 24-bit-wide value of the sensor gain coefficient <i>Gain_S</i> . The MSBs including sign are <i>Gain_S</i> [23:16], which is [7:0] in register 0F <sub>HEX</sub> .                                          |
| 07 <sub>HEX</sub> | 15:0           | 0000 <sub>HEX</sub> | Tcg[15:0]          | Bits [15:0] of the 24-bit-wide coefficient <i>Tcg</i> for the temperature correction of the sensor gain. The MSBs including sign are <i>Tcg</i> [23:16], which is bits [15:8] in register 10 <sub>HEX</sub> .                  |
| 08 <sub>HEX</sub> | 15:0           | 0000 <sub>HEX</sub> | Tco[15:0]          | Bits [15:0] of the 24-bit-wide coefficient <i>Tco</i> for temperature correction of the sensor offset. The MSBs with sign are <i>Tco</i> [23:16], which is bits [7:0] in register 10 <sub>HEX</sub> .                          |
| 09 <sub>HEX</sub> | 15:0           | 0000 <sub>HEX</sub> | SOT_tco[15:0]      | Bits [15:0] of the 24-bit-wide 2 <sup>nd</sup> order term <i>SOT_tco</i> applied to <i>Tco</i> . The MSBs of this term including sign are <i>SOT_tco</i> [23:16], which is bits [15:8] in register 11 <sub>HEX</sub> .         |
| 0A <sub>HEX</sub> | 15:0           | 0000 <sub>HEX</sub> | SOT_tcg[15:0]      | Bits [15:0] of the 24-bit-wide 2 <sup>nd</sup> order term <i>SOT_tcg</i> applied to <i>Tcg</i> . The MSBs of this term including sign are <i>SOT_tcg</i> [23:16], which is bits[7:0] in register 11 <sub>HEX</sub> .           |
| 0B <sub>HEX</sub> | 15:0           | 0000 <sub>HEX</sub> | SOT_sens[15:0]     | Bits [15:0] of the 24-bit-wide 2 <sup>nd</sup> order term <i>SOT_sens</i> applied to the sensor readout. The MSBs of this term including sign are <i>SOT_sens</i> [23:16], which is bits[15:8] in register 12 <sub>HEX</sub> . |
| 0C <sub>HEX</sub> | 15:0           | 0000 <sub>HEX</sub> | Offset_T[15:0]     | Bits [15:0] of the 24-bit-wide temperature offset correction coefficient <i>Offset_T</i> . The MSBs of this coefficient including sign are <i>Offset_T</i> [23:16], which is bits[7:0] in register 12 <sub>HEX</sub> .         |
| 0D <sub>HEX</sub> | 15:0           | 0000 <sub>HEX</sub> | Gain_T[15:0]       | Bits [15:0] of the 24-bit-wide absolute value of the temperature gain coefficient <i>Gain_T</i> . The MSBs including sign are <i>Gain_T</i> [23:16], which is bits[15:8] in register 13 <sub>HEX</sub> .                       |
| 0E <sub>HEX</sub> | 15:0           | 0000 <sub>HEX</sub> | SOT_T[15:0]        | Bits [15:0] of the 24-bit-wide 2 <sup>nd</sup> -order term <i>SOT_T</i> applied to the temperature reading. The MSBs including sign are <i>SOT_T</i> [23:16], which is bit[7:0] in register 13 <sub>HEX</sub> .                |
| ٥٢                | 7:0            | 20 <sub>HEX</sub>   | Gain_S[23:16]      | Bits [23:16] including sign for the 24-bit-wide sensor gain correction coefficient <i>Gain_S</i> . The LSBs of this coefficient are <i>Gain_S</i> [15:0] in register 06 <sub>HEX</sub> .                                       |
| 0F <sub>HEX</sub> | 15:8           | 00 <sub>HEX</sub>   | Offset_S[23:16]    | Bits [23:16] including sign for the 24-bit-wide sensor offset correction coefficient <i>Offset_S</i> . The LSBs are <i>Offset_S</i> [15:0] in register 05 <sub>HEX</sub> .                                                     |
| 40                | 7:0            | 00 <sub>HEX</sub>   | Tco[23:16]         | Bits [23:16] including sign for the 24-bit-wide coefficient $Tco$ for temperature correction for the sensor offset. The LSBs are $Tco$ [15:0] in register $08_{HEX}$ .                                                         |
| 10 <sub>HEX</sub> | 15:8           | 00 <sub>HEX</sub>   | Tcg[23:16]         | Bits [23:16] including sign for the 24-bit-wide coefficient <i>Tcg</i> for the temperature correction of the sensor gain. The LSBs are <i>Tcg</i> [15:0] in register 07 <sub>HEX</sub> .                                       |
| 11                | 7:0            | 00 <sub>HEX</sub>   | SOT_tcg[23:16]     | Bits [23:16] including sign for the 24-bit-wide 2 <sup>nd</sup> order term <i>SOT_tcg</i> applied to Tcg. The LSBs are <i>SOT_tcg</i> [15:0] in register 0A <sub>HEX</sub> .                                                   |
| 11 <sub>HEX</sub> | 15:8           | 00 <sub>HEX</sub>   | SOT_tco[23:16]     | Bits [23:16] including sign for the 24-bit-wide 2 <sup>nd</sup> order term <i>SOT_tco</i> applied to Tco. The LSBs are <i>SOT_tco</i> [15:0] in register 09 <sub>HEX</sub> .                                                   |
| 40                | 7:0            | 00 <sub>HEX</sub>   | Offset_T[23:16]    | Bits [23:16] including sign for the 24-bit-wide temperature offset correction coefficient <i>Offset_T</i> . The LSBs are <i>Offset_T</i> [15:0] in register OC <sub>HEX</sub> .                                                |
| 12 <sub>HEX</sub> | 15:8           | 00 <sub>HEX</sub>   | SOT_sens[23:16]    | Bits [23:16] including sign for the 24-bit-wide 2 <sup>nd</sup> order term                                                                                                                                                     |
| 12                | 7:0            | 00 <sub>HEX</sub>   | SOT_T[23:16]       | Bits [23:16] including sign for the 24-bit-wide 2 <sup>nd</sup> -order term $SOT_T$ applied to the temperature reading. The LSBs are $SOT_T$ [15:0] in register $OE_{HEX}$ .                                                   |
| 13 <sub>HEX</sub> | 15:8           | 20 <sub>HEX</sub>   | Gain_T[23:16]      | Bits [23:16] including sign for the 24-bit-wide absolute value of the temperature gain coefficient <i>Gain_T</i> . The LSBs are <i>Gain_T</i> [15:0] in register 0D <sub>HEX</sub> .                                           |

| NVM Address       | Word/Bit Range  | Default Setting       | Description       | Notes / Evalenations                                                                                                                                                                                                                                                                                                                                                                  |
|-------------------|-----------------|-----------------------|-------------------|---------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------|
| NVIVI Address     | word/ bit Range |                       |                   | Notes/Explanations                                                                                                                                                                                                                                                                                                                                                                    |
|                   |                 | weasurement (         | Configuration Reg | ister 1 (SM_config1)  Coin patting for the 1st DCA stage with Coin stage 1(2:0):                                                                                                                                                                                                                                                                                                      |
|                   | 3:0             | 0000 <sub>BIN</sub>   | Gain_stage1       | Gain setting for the 1 <sup>st</sup> PGA stage with $Gain\_stage1[3:0]$ :  Parameters are valid for $Gain_{PGA} \le 192$ : $0000 = 1.2$ $0010 = 2$ $0011 = 4$ $0011 = 6$ $0010 = 12$ $0100 = 12$ $0100 = 12$ $0100 = 12$ $0101 = 120$ Parameters are limited for $Gain_{PGA} > 192$ : $1011 = 150$ $1100 = 200$ $1101 = 240$ $1110 = 300$ $1111 = Not assigned$ $1111 = Not assigned$ |
|                   | 6:4             | 000 <sub>BIN</sub>    | Gain_stage2       | Gain setting for the 2 <sup>nd</sup> PGA stage with Gain_stage2[1:0]:  000 = 1.1                                                                                                                                                                                                                                                                                                      |
|                   | 7               | O <sub>BIN</sub>      | Gain_polarity     | Set up the polarity of the sensor bridge's gain (invert chopper 1):  0 = positive (no polarity change)  1 = negative (180° polarity change)                                                                                                                                                                                                                                           |
| 14 <sub>HEX</sub> | 11:8            | 0100 <sub>BIN</sub>   | adc_bits          | Resolution, i.e. absolute number of bits for the ADC with<br>adc_bits[3:0]:<br>0000 = 12                                                                                                                                                                                                                                                                                              |
|                   | 14:12           | 000 <sub>BIN</sub>    | adc_offset        | Differential signal's offset shift in the ADC including gain x2; compensation of x% signal offset:  000 = 0%, no offset compensation  100 = 25.00% offset  001 = 6.25% offset  101 = 31.25% offset  110 = 37.50% offset  011 = 18.75% offset  111 = 44.00% offset                                                                                                                     |
|                   | 15              | O <sub>BIN</sub>      | sel_ref1          | Reference source for main sensor measurement:  0 = Absolute (internal) bandgap is the reference  1 = Ratiometric reference; recommended for ratiometrically supplied sensors                                                                                                                                                                                                          |
|                   |                 | Measurement (         | Configuration Reg | jister 2 (SM_config2)                                                                                                                                                                                                                                                                                                                                                                 |
| 15 <sub>HEX</sub> | 4:0             | 0 0000 <sub>BIN</sub> | ioffsc            | Absolute voltage input shift for input signals to the PG, e.g. INP-INN  The input signal is shifted by the following voltages:  00000 = 0mV, no shift  00001 = -1mV  00010 = -2mV  00011 = -3mV   01110 = -14mV  01111 = -15mV  10000 = 0mV, no shift  10001 = +1mV  10010 = +2mV   11110 = +14mV  11111 = +15mV                                                                      |

| NVM Address       | Word/Bit Range | Default Setting        | Description   | Notes/Explanations                                                                                                                                                                                                                                    |
|-------------------|----------------|------------------------|---------------|-------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------|
|                   | 7:5            | 000 <sub>BIN</sub>     | Tbiasout      | Current Mode sensor bias selection; nominal sensor supply current $I_{sup}$ (if $sensor\_sup = 01$ ): $000 = 5\mu A$ $001 = 10\mu A$ $010 = 20\mu A$ $011 = 39\mu A$ $100 = 79\mu A$ $101 = 157\mu A$ $110 = 196\mu A$ $111 = 494\mu A$               |
|                   | 8              | O <sub>BIN</sub>       | adc_en_shift  | General disable/enable of the ADC feature to apply the extra gain x2 and signal offset compensation <i>adc_offset</i> in register 14 <sub>HEX</sub> :  0 = Gain: ×2 and signal offset compensation off 1 = Gain: ×2 and signal offset compensation on |
|                   | 9              | O <sub>BIN</sub>       | pga_en_shift  | Automatic common mode adjust feature, which allows automatically, optimally adapting the sensor-input common mode to AGND at the PGA output. <sup>[d]</sup> 0 = Automatic common mode adjustment off  1 = Automatic common mode adjustment on         |
|                   | 15:10          | 00 0000 <sub>BIN</sub> |               | Not assigned ation Register 1 (extTemp_config1)                                                                                                                                                                                                       |
|                   | 3:0            | 0000 <sub>BIN</sub>    | Gain_stage1   | Gain setting for the 1 <sup>st</sup> PGA stage with <i>Gain_stage1</i> [3:0] for external temperature measurements:  Parameters are valid for Gain <sub>PGA</sub> ≤ 192:  0000 = 1.2                                                                  |
| 16 <sub>HEX</sub> | 6:4            | 000 <sub>BIN</sub>     | Gain_stage2   | Gain setting for the 2 <sup>nd</sup> PGA stage with <i>Gain_stage2</i> [1:0] for external temperature measurements:  000 = 1.1                                                                                                                        |
|                   | 7              | O <sub>BIN</sub>       | Gain_polarity | Set up the polarity of the temperature sensor gain (invert input) with:  0 = Positive (no polarity change)  1 = Negative (180° polarity change)                                                                                                       |
|                   | 11:8           | 0100 <sub>BIN</sub>    | adc_bits      | Resolution, i.e. absolute number of bits for the ADC for external temperature measurements with adc_bits[3:0]: 0000 = 12                                                                                                                              |

| NVM Address       | Word/Bit Range | Default Setting        | Description         | Notes/Explanations                                                                                                                                                                                                                                                                                                                                  |
|-------------------|----------------|------------------------|---------------------|-----------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------|
|                   | 14:12          | 000 <sub>BIN</sub>     | adc_offset          | Differential signal's offset shift in ADC including gain x2 for external temperature measurements; compensation of x% signal offset:  000 = 0%, no offset compensation  001 = 6.25% offset  010 = 12.50% offset  011 = 18.75% offset  100 = 25.00% offset                                                                                           |
|                   |                |                        |                     | 101 = 31.25% offset<br>110 = 37.50% offset<br>111 = 44.00% offset<br>Reference source for external temperature sensing and                                                                                                                                                                                                                          |
|                   | 15             | O <sub>BIN</sub>       | sel_ref2            | conversion:  0 = Absolute (internal) bandgap is reference  1 = Ratiometric reference; recommended for ratiometrically supplied sensors                                                                                                                                                                                                              |
|                   | External Te    | mperature Measu        | rement Configura    | ation Register 2 (extTemp_config2)                                                                                                                                                                                                                                                                                                                  |
|                   | 4:0            | 0 0000вім              | ioffsc              | Absolute voltage input shift for input signals for external temperature measurements to the PG, e.g. INP-INN The input signal is shifted by the following voltages:  00000 = 0mV, no shift  00001 = -1mV  00010 = -2mV  00011 = -3mV  01110 = -14mV  01111 = -15mV  10000 = 0mV, no shift  10001 = +1mV  10010 = +2mV  11110 = +14mV  11111 = +15mV |
| 17 <sub>HEX</sub> | 7:5            | 000 <sub>BIN</sub>     | Tbiasout            | Current Mode sensor bias selection for external temperature measurements; nominal sensor supply current (if $temp\_source \in \{001_{BIN}, 010_{BIN}, 011_{BIN}, 100_{BIN}\}$ ): $000 = 5\mu A$ $001 = 10\mu A$ $010 = 20\mu A$ $011 = 39\mu A$ $100 = 79\mu A$ $101 = 157\mu A$ $110 = 196\mu A$ $111 = 494\mu A$                                  |
|                   | 8              | O <sub>BIN</sub>       | adc_en_shift        | General disenable/enable of the ADC feature for external temperature measurements to apply the extra gain x2 and signal offset compensation <i>adc_offset</i> in register 16 <sub>HEX</sub> :  0 = Gain: x2 and signal offset compensation off  1 = Gain: x2 and signal offset compensation on                                                      |
|                   | 9              | O <sub>BIN</sub>       | pga_en_shift        | Automatic common mode adjust feature, which allows automatically, optimally adapting the sensor-input common mode to AGND at the PGA output for external temperature measurements. <sup>[d]</sup> 0 = Automatic common mode adjustment off  1 = Automatic common mode adjustment on                                                                 |
|                   | 15:10          | 00 0000 <sub>BIN</sub> | _                   | Not assigned                                                                                                                                                                                                                                                                                                                                        |
|                   |                |                        | nd Post-Calibration | on (Digital) Offset Calibration                                                                                                                                                                                                                                                                                                                     |
| 18 <sub>HEX</sub> | 15:0           | 0000 <sub>HEX</sub>    | TRSH1[15:0]         | Bits [15:0] of the 24-bit-wide interrupt threshold1, <i>TRSH1</i> . (The MSBs for this threshold are TRSH1[23:16], which is bits [7:0] of register 1A <sub>HEX</sub> .)                                                                                                                                                                             |

| NVM Address                      | Word/Bit Range                     | Default Setting                              | Description                              | Notes/Explanations                                                                                                                                                                                                                                                                       |
|----------------------------------|------------------------------------|----------------------------------------------|------------------------------------------|------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------|
| 19 <sub>HEX</sub>                | 15:0                               | 0000 <sub>HEX</sub>                          | TRSH2[15:0]                              | Bits [15:0] of the 24-bit-wide interrupt threshold2, <i>TRSH2</i> . (The MSBs for this threshold are TRSH2[23:16], which is bits[15:8] of register 1A <sub>HEX</sub> .)                                                                                                                  |
| 10                               | 7:0                                | 00 <sub>HEX</sub>                            | TRSH1[23:16]                             | Bits [23:16] of the 24-bit-wide interrupt threshold1, <i>TRSH1</i> . (The LSBs for this threshold are TRSH1[15:0], which is bits[15:0] of register 18 <sub>HEX</sub> .)                                                                                                                  |
| 1A <sub>HEX</sub>                | 15:8 00 <sub>HEX</sub> TRSH2[23:16 |                                              | TRSH2[23:16]                             | Bits [23:16] of the 24-bit-wide interrupt threshold2, <i>TRSH2</i> . (The LSBs for this threshold are TRSH2[15:0], which is bits[15:0] of register 19 <sub>HEX</sub> .)                                                                                                                  |
| 1B <sub>HEX</sub>                | 15:0                               | 0000 <sub>HEX</sub>                          | SENS_Shift[15:0]                         | Bits [15:0] of the post-calibration sensor offset shift coefficient<br>SENS_Shift.<br>(The MSBs of SENS_Shift are bits [15:8] of register 1D <sub>HEX</sub> .)                                                                                                                           |
| 1C <sub>HEX</sub>                | 15:0                               | 0000 <sub>HEX</sub>                          | T_Shift[15:0]                            | Bits [15:0] of the post-calibration temperature offset shift coefficient <i>T_Shift</i> . (The MSBs of <i>T_Shift</i> are bits [7:0] of register 1D <sub>HEX</sub> .)                                                                                                                    |
|                                  | 7:0                                | 00 <sub>HEX</sub>                            | T_Shift[23:16]                           | Bits [23:16] of the post-calibration temperature offset shift coefficient <i>T_Shift</i> . (The LSBs of <i>T_Shift</i> are in register 1C <sub>HEX</sub> .)                                                                                                                              |
| 1D <sub>HEX</sub>                | 15:8                               | 00 <sub>HEX</sub>                            | SENS_Shift[23:16]                        | Bits [23:16] of the post-calibration sensor offset shift                                                                                                                                                                                                                                 |
|                                  |                                    | Measurement S                                | Scheduler (Cyclic C                      | Operation Sequence)                                                                                                                                                                                                                                                                      |
|                                  | 0                                  | $0_{BiN}$                                    | cycwsn                                   | Cyclic measurement operation is performed with/including the sensor measurement:  0 = Sensor measurement is performed  1 = Sensor measurement is not performed  Note: Whether AZS is to be performed in the cyclic measurement sequence is set up with AZMs_on (see register 04HEX)      |
| 1E <sub>HEX</sub>                | 1                                  | O <sub>BIN</sub>                             | cycwtn                                   | Cyclic measurement operation is performed with the temperature measurement:  0 = Temperature measurement is performed  1 = Temperature measurement is not performed  Note: whether AZT is to be performed in the cyclic measurement sequence is set up with AZMt_on (see register O4HEX) |
|                                  | 2                                  | O <sub>BIN</sub>                             | -                                        | Not assigned                                                                                                                                                                                                                                                                             |
|                                  | 3                                  | O <sub>BIN</sub>                             | cycwscn                                  | Cyclic measurement operation is performed with/including the sensor-connection check:  0 = Sensor connection check is performed  1 = Sensor connection check is not performed                                                                                                            |
|                                  | measurement type Note: The SSC and | in the first slot or o<br>analog output will | nly after respective only become valid a | e measurement sequence performs the respective slots_X have been completed for the first time.  after the sensor, temperature, and related auto-zero time. The first output signals maybe invalid until this condition                                                                   |
|                                  | 4                                  | O <sub>BIN</sub>                             | startS_wfirstn                           | 0 = Perform the sensor measurement in the first slot<br>1 = Do not perform the sensor measurement in the first slot                                                                                                                                                                      |
| 1E <sub>HEX</sub><br>(continued) | 5                                  | O <sub>BIN</sub>                             | startAZS_wfirstn                         | <ul> <li>0 = Perform the auto-zero sensor measurement in the first slot</li> <li>1 = Do not perform the auto-zero sensor measurement in the first slot</li> <li>Note: The startAZS_wfirstn bit is ignored for the cyclic operation if the AZMs_on = 0 = "off."</li> </ul>                |
|                                  | 6                                  | O <sub>BIN</sub>                             | startT_wfirstn                           | Perform the temperature measurement in the first slot      Do not perform the temperature measurement in the first slot                                                                                                                                                                  |

| NVM Address       | Word/Bit Range         | Default Setting             | Description       | Notes/Explanations                                                                                                           |
|-------------------|------------------------|-----------------------------|-------------------|------------------------------------------------------------------------------------------------------------------------------|
|                   |                        | _                           |                   | 0 = Perform the auto-zero temperature measurement in                                                                         |
|                   | 7                      | O <sub>BIN</sub>            | startAZT_wfirstn  | the first slot  1 = Do not perform the auto-zero temperature                                                                 |
|                   |                        |                             |                   | measurement in the first slot  Note: The startAZT_wfirstn bit is ignored for the cyclic                                      |
|                   |                        |                             |                   | operation if the <i>AZMt_on</i> = 0 = "off."                                                                                 |
|                   | 8                      | O <sub>BIN</sub>            | _                 | Not assigned                                                                                                                 |
|                   |                        |                             |                   | Diagnostics: sensor connection checks:  0 = Perform sensor connection checks in the first slot                               |
|                   | 9                      | O <sub>BIN</sub>            | startSC_wfirstn   | 1 = Do not perform sensor connection checks in the first                                                                     |
|                   |                        |                             |                   | slot                                                                                                                         |
|                   |                        |                             |                   | Defines the number of pause slots between two subsequent temperature measurements:                                           |
|                   | 4-10                   |                             |                   | 0 = No pause, measure temperature at each slot                                                                               |
|                   | 15:10                  | 00 0000 <sub>BIN</sub>      | slots_T           | 1 <sub>DEC</sub> to 63 <sub>DEC</sub> = Pause slots after the slot with the temperature measurement                          |
|                   |                        |                             |                   | Note: Set $slots_T = slots_AZT$ for correct Cyclic Operation.                                                                |
|                   |                        |                             |                   | Defines the number of pause slots between two subsequent auto-zero temperature (AZT) measurements:                           |
|                   |                        |                             | slots_AZT         | 0 = No pause, measure AZT at each slot                                                                                       |
|                   | 5:0                    | 00 0000 <sub>віN</sub>      |                   | 1 to 63 <sub>DEC</sub> = Number of pause slots after the slot with the AZT measurement                                       |
|                   |                        |                             |                   | Note: If AZMt_on = 0, no auto-zero temperature measurement will be performed.                                                |
|                   | 9:6                    | 0000 <sub>BIN</sub>         | slots_S           | Defines the number of pause slots between two subsequent                                                                     |
|                   |                        |                             |                   | sensor/bridge measurements:  0 = No pause, measure sensor at each slot                                                       |
|                   |                        |                             |                   | 0 = No pause, measure sensor at each slot  1 <sub>DEC</sub> to 15 <sub>DEC</sub> = Number of pause slots after the slot with |
| 1F <sub>HEX</sub> |                        |                             |                   | the sensor measurement                                                                                                       |
|                   |                        |                             |                   | Note: Set slots_S = slots_AZS for correct Cyclic Operation.                                                                  |
|                   |                        | 0000 <sub>BIN</sub>         | slots_AZS         | Defines the number of pause slots between two subsequent auto-zero-sensor (AZS) measurements:                                |
|                   |                        |                             |                   | 0 = No pause, measure AZS at each slot                                                                                       |
|                   | 13:10                  |                             |                   | 1 <sub>DEC</sub> to 15 <sub>DEC</sub> = Number of pause-slots after the slot with sensor measurement                         |
|                   |                        |                             |                   | Note: If <i>AZMs_on</i> = 0, no auto-zero-sensor measurement is performed.                                                   |
|                   | 15:14                  | 00 <sub>BIN</sub>           | _                 | These bits must be $00_{BIN}$ to ensure proper Cyclic Operation                                                              |
|                   | 5:0                    | 00 0000 <sub>BIN</sub>      | _                 | Not assigned.                                                                                                                |
|                   |                        |                             |                   | Defines the number of pause slots between two subsequent sensor connection check runs:                                       |
| 20 <sub>HEX</sub> | 15:6                   | 00 0000 0000 <sub>BIN</sub> | slots_SC          | 0 = No pause, always check sensor connection                                                                                 |
|                   |                        |                             |                   | 1 <sub>DEC</sub> to 1023 <sub>DEC</sub> = Number of pause-slots after slot with Sensor-Connection check                      |
|                   | !                      | Selection of (Sens          | sor) Connection C | hecks to be Conducted                                                                                                        |
|                   | The first 10 bits of r |                             |                   | 0] bit field:                                                                                                                |
|                   |                        | _                           |                   | Loss of sensor positive connection, INP [f]                                                                                  |
| 21                | 0                      | $O_{BIN}$                   | inp_check         | 0 = Check is not performed; result is not signalized                                                                         |
| 21 <sub>HEX</sub> |                        |                             |                   | 1 = Check is performed; result is signalized  Loss of bridge/sensor negative connection, INN [f]                             |
|                   | 1                      | $0_{BIN}$                   | inn_check         | 0 = Check is not performed; result is not signalized                                                                         |
|                   |                        | ARIN                        |                   | 1 = Check is performed; result is signalized                                                                                 |

| NVM Address       | Word/Bit Range | Default Setting        | Description                                                                                                                                                                                                                                                 | ription Notes/Explanations                                                                                                                                                                                                                                                 |  |
|-------------------|----------------|------------------------|-------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------|----------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------|--|
|                   | 2              | O <sub>BIN</sub>       | inp_range_check                                                                                                                                                                                                                                             | Signal at pin INP out of range (leaking/short to VSS or VDDB)  0 = Check is not performed; result is not signalized  1 = Check is performed; result is signalized                                                                                                          |  |
|                   | 3              | O <sub>BIN</sub>       | inn_range_check                                                                                                                                                                                                                                             | Signal at pin INN out of range (leaking/short to VSS or VDDB)  0 = Check is not performed; result is not signalized  1 = Check is performed; result is signalized                                                                                                          |  |
|                   | 4              | O <sub>BIN</sub>       | sens_short<br>_check                                                                                                                                                                                                                                        | Sensor short (INN = INP) <sup>[f]</sup> 0 = Check is not performed; result is not signalized 1 = Check is performed; result is signalized                                                                                                                                  |  |
|                   | 5              | O <sub>BIN</sub>       | text_open_check                                                                                                                                                                                                                                             | T <sub>EXT</sub> pin open 0 = Check is not performed; result is not signalized 1 = Check is performed; result is signalized                                                                                                                                                |  |
|                   | 6              | O <sub>BIN</sub>       | text_range_check                                                                                                                                                                                                                                            | Signal at pin T <sub>EXT</sub> out of range (leaking / short to VSS or VDDB)  0 = Check is not performed; result is not signalized  1 = Check is performed; result is signalized                                                                                           |  |
|                   | 7              | O <sub>BIN</sub>       | text_inn_short<br>_check                                                                                                                                                                                                                                    | T <sub>EXT</sub> pin short to INN 0 = Check is not performed; result is not signalized 1 = Check is performed; result is signalized                                                                                                                                        |  |
|                   | 8              | O <sub>BIN</sub>       | text_inp_short<br>_check                                                                                                                                                                                                                                    | T <sub>EXT</sub> pin short to INP 0 = Check is not performed; result is not signalized 1 = Check is performed; result is signalized                                                                                                                                        |  |
|                   | 9              | O <sub>BIN</sub>       | crack_check                                                                                                                                                                                                                                                 | Broken-chip check / chipping check  0 = Check is not performed; result is not signalized  1 = Check is performed; result is signalized                                                                                                                                     |  |
|                   | 15:10          | 00 0000 <sub>BIN</sub> | _                                                                                                                                                                                                                                                           | Not assigned                                                                                                                                                                                                                                                               |  |
|                   | •              |                        | C (Output Calibrati                                                                                                                                                                                                                                         |                                                                                                                                                                                                                                                                            |  |
| 22 <sub>HEX</sub> | 15:0           | XXXX <sub>HEX</sub>    | DAC10RM5V                                                                                                                                                                                                                                                   | Encoded, 16bit-quantized measurement value of DAC-output at $V_{DD}$ =5V with 10%-DAC-excitation, digital code (199 $A_{HEX}$ ). Programmed at Renesas' device test. The measured DAC-voltage [e] can be derived as: $V_{DAC10,AOUT}[V]$ := DAC10RM5V[dec] / 296000 + 0.39 |  |
| 23 <sub>HEX</sub> | 15:0           | XXXX <sub>HEX</sub>    | Encoded, 16bit-quantized measurement value of at V <sub>DD</sub> =5V with 90%-DAC-excitation, digital code programmed at Renesas' device test. The measurement voltage [e] can be derived as: V <sub>DAC90,AOUT</sub> [V] := DAC90RM5V[dec] / 284000 + 4.45 |                                                                                                                                                                                                                                                                            |  |
|                   |                | Free Mem               | ory (Available for                                                                                                                                                                                                                                          | Customer Use)                                                                                                                                                                                                                                                              |  |
| 24 <sub>HEX</sub> | 15:0           | 0000 <sub>HEX</sub>    | _                                                                                                                                                                                                                                                           | Not assigned (e.g., can be used for Cust_IDx customer identification number)                                                                                                                                                                                               |  |
|                   |                |                        | -                                                                                                                                                                                                                                                           | Not assigned (e.g., can be used for Cust_IDx customer identification number)                                                                                                                                                                                               |  |
| 34 <sub>HEX</sub> | 15:0           | 0000 <sub>HEX</sub>    | -                                                                                                                                                                                                                                                           | Not assigned (e.g., can be used for Cust_IDx customer identification number)                                                                                                                                                                                               |  |
| 35 <sub>HEX</sub> | 15:0           | -                      | Checksum                                                                                                                                                                                                                                                    | Generated (checksum) for the entire memory through a linear feedback shift register (LFSR); signature is checked on power-up to ensure memory content integrity                                                                                                            |  |

<sup>[</sup>a] For I3C operation, this should contain the Legacy Virtual Register (LVR) information:  $1X_{HEX}$  to Index 0. Fast-Mode is supported.

<sup>[</sup>b] Use the extTemp\_config1 and extTemp\_config2 registers for temperature sensor related front-end configuration.

<sup>[</sup>c] In Current Loop Operation Mode, it must be ensured that a sufficient external  $V_{DD}$ -level > 4.8V is present (e.g., with external supply transistor, such as JFET or depletion MOSFET, and extra LDO-control option).

<sup>[</sup>d] If pga\_en\_shift is enabled, the ZSSC3240 current consumption increases by approximately 100μA. Usage is recommended for optimizing the analog front-end setup.

<sup>[</sup>e] The IC provides the originally measured DAC-output voltage V<sub>DAC'0,AOUT</sub>[V] with V<sub>DD</sub>=5V, Aout\_setup=(001<sub>BIN</sub> or 101<sub>BIN</sub>) as reaction on B3<sub>HEX</sub> command, see Table 33.

<sup>[</sup>f] Do not enable (that is, set to  $0_{BIN}$ ) if the IC is connected to an absolute voltage source sensor, for example, Thermopile (sensor\_sup =  $10_{BIN}$ ).

The NVM-consistence checksum is calculated (internally by the ZSSC3240 for the whole NVM) using the polynomial:  $x^{16} + x^{15} + x^2 + 1$ . The checksum verification is only realized directly after V<sub>DD</sub> power-on. If the checksum is successfully verified, then the "Memory Error" status bit is set to 0<sub>BIN</sub>.

#### 6.6.3. Digital Sensor-Signal-Conditioning Mathematics

The saturation check (signalized by SSC Calculation Unit Saturation, see Table 16) in the ZSSC3240 detects saturation effects of the internal calculation steps, allowing the final correction output to be determined despite the saturation. It is possible to get potentially useful signal conditioning results that have had an intermediate saturation during the calculations. These cases are detectable; e.g., by observing the status bit[0] for each measurement result. Details about the saturation limits and the valid ranges for values are provided in the equations in the following sections.

The calibration math description assumes a calculation with integer numbers. The description is numerically correct concerning values, dynamic range, and resolution.

### 6.6.3.1. Sensor Signal Correction

The configuration parameter *SOT\_curve* in NVM register 02<sub>HEX</sub> selects whether second-order equations compensate for sensor nonlinearity with a parabolic or S-shaped curve. The parabolic compensation is recommended for most sensor types.

The following equations describe the available SSC capabilities. The equation terms are as follows:

- S Corrected sensor reading output via I2C, OWI, or SPI; range [0HEX to FFFFFHEX]
- S\_Raw Raw sensor reading from ADC (after AZ correction, if selected); range [-7FFFFhex to 7FFFFhex]

Gain\_S Sensor gain term; range [-7FFFFFHEX to 7FFFFFHEX]

Offset\_SSensor offset term; range [-7FFFFHEX to 7FFFFHEX]

Tcg Temperature coefficient gain term; range [-7FFFFHEX to 7FFFFHEX]

Tco Temperature coefficient offset term; range [-7FFFFFHEX to 7FFFFFHEX]

T\_Raw Raw temperature reading (after AZ correction); range [-7FFFFFHEX to 7FFFFFHEX]

SOT\_tcgSecond-order term for Tcg non-linearity; range [-7FFFFHEX to 7FFFFHEX]

SOT\_tcoSecond-order term for Tco non-linearity; range [-7FFFFHEX to 7FFFFHEX]

SOT\_sens Second-order term for sensor non-linearity; range [-7FFFFFHEX to 7FFFFHEX]

SENS\_shift Post-calibration, post-assembly offset shift; range [-7FFFFFHEX to 7FFFFHEX]

- ... Absolute value
- $[...]_{ll}^{ul}$  Bound/saturation number range from ll to ul, overflow/underflow is reported as saturation in the status byte

The correction formula for the differential signal reading is represented as a two-step process depending on the SOT\_curve setting.

Table 35. Data Format of 24-bit SSC Coefficients

| Bit-Number:        | 23                           | 22             | 21             | 20              |     | 2                | 1    | 0                |
|--------------------|------------------------------|----------------|----------------|-----------------|-----|------------------|------|------------------|
| Meaning, Weighting | 0 = positive<br>1 = negative | 2 <sup>1</sup> | 2 <sup>0</sup> | 2 <sup>-1</sup> | ••• | 2 <sup>-19</sup> | 2-20 | 2 <sup>-21</sup> |

Table 36. Data Format of Corrected, SSC Results (S and T)

| Bit-Number:        | 23                    | 22              | 21  | 20  | ••• | 2                | 1    | 0                |
|--------------------|-----------------------|-----------------|-----|-----|-----|------------------|------|------------------|
| Meaning, Weighting | <b>2</b> <sup>0</sup> | 2 <sup>-1</sup> | 2-2 | 2-3 |     | 2 <sup>-21</sup> | 2-22 | 2 <sup>-23</sup> |

# Equations for the parabolic SOT\_curve setting (SOT\_curve = 0):

Simplified:

$$K_1 = 2^{23} + \frac{T_Raw}{2^{23}} \cdot \left(\frac{4 \cdot SOT_tcg}{2^{23}} \cdot T_{Raw} + 4 \cdot Tcg\right)$$
 Equation 7

$$K_2 = 4 \cdot Offset_S + S_raw + \frac{T_Raw}{2^{23}} \cdot \left(\frac{4 \cdot SOT_tco}{2^{23}} \cdot T_{Raw} + 4 \cdot Tco\right)$$
 Equation 8

$$Z_{SP} = \frac{4 \cdot Gain\_S}{2^{23}} \cdot \frac{K_1}{2^{23}} \cdot K_2 + 2^{23}$$
 (delimited to positive number range)

$$S = \frac{Z_{SP}}{2^{23}} \cdot \left(\frac{4 \cdot SOT\_sens}{2^{23}} \cdot Z_{SP} + 2^{23}\right) + SENS\_shift \qquad \text{(delimited to positive number range)}$$

Complete:

$$K_{1} = \left[ 2^{23} + \left[ \frac{T_{Raw}}{2^{23}} \cdot \left[ \left[ \frac{SOT_{tcg}}{2^{21}} \cdot T_{Raw} \right]_{2^{25}}^{2^{25}-1} + 4 \cdot Tcg \right]_{2^{25}}^{2^{25}-1} \right]_{2^{25}}^{2^{25}-1} \right]_{2^{25}}^{2^{25}-1}$$
Equation 11

$$K_{2} = \left[ 4 \cdot \text{Offset\_S} + \left[ S_{\text{raw}} + \left[ \frac{T_{\text{Raw}}}{2^{23}} \cdot \left[ \left[ \frac{\text{SOT\_tco}}{2^{21}} \cdot T_{\text{Raw}} \right]_{-2^{25}}^{2^{25}-1} + 4 \cdot \text{Tco} \right]_{-2^{25}}^{2^{25}-1} \right]_{-2^{25}}^{2^{25}-1} \right]_{-2^{25}}^{2^{25}-1}$$
**Equation 12**

$$Z_{SP} = \left[ \left[ \frac{\text{Gain\_S}}{2^{21}} \cdot \left[ \frac{K_1}{2^{23}} \cdot K_2 \right]_{-2^{25}}^{2^{25}-1} \right]_{-2^{25}}^{2^{25}-1} + 2^{23} \right]_{0}^{2^{25}-1}$$
Equation 13

$$S = \left[ \frac{Z_{SP}}{2^{23}} \cdot \left[ \left[ \frac{SOT\_sens}{2^{21}} \cdot Z_{SP} \right]_{.2^{25}}^{2^{25}-1} + 2^{23} \right]_{.2^{25}}^{2^{25}-1} + SENS\_shift \right]_{0}^{2^{24}-1}$$
Equation 14

### Equations for the S-shaped SOT curve setting (SOT curve = 1):

Simplified:

$$Z_{SS} = \frac{4 \cdot Gain\_S}{2^{23}} \cdot \frac{K_1}{2^{23}} \cdot K_2$$
 (K<sub>1</sub> and K<sub>2</sub> according to Equation 7 and Equation 8)

$$S = \frac{Z_{SS}}{2^{23}} \cdot \left(\frac{4 \cdot SOT\_sens}{2^{23}} \cdot |Z_{SS}| + 2^{23}\right) + 2^{23} + SENS\_shift \qquad \text{(delimited to positive number range)}$$

Complete:

$$Z_{SS} = \left[ \left[ \frac{\text{Gain\_S}}{2^{21}} \cdot \left[ \frac{K_1}{2^{23}} \cdot K_2 \right]_{-2^{25}}^{2^{25}-1} \right]_{-2^{25}}^{2^{25}-1} \right]_{-2^{25}}^{2^{25}-1}$$
Equation 17

$$S = \left[ \frac{Z_{SP}}{2^{23}} \cdot \left[ \frac{SOT\_sens}{2^{21}} \cdot |Z_{SS}| \right]_{-2^{25}}^{2^{25}-1} + 2^{23} \right]_{-2^{25}}^{2^{25}-1} + 2^{23} + SENS\_shift$$
Equation 18

### 6.6.3.2. Temperature Signal Correction

Temperature is measured either internally by the ZSSC3240 or through an additional external element or by means of a combination of ZSSC3240-internal and external temperature sensing capabilities; see sections 6.2.3 and 6.2.4. Temperature correction contains both linear gain and offset terms as well as a second-order term to correct for any nonlinearities. For temperature, second-order compensation for nonlinearity is always parabolic.

The correction equation terms are as follows:

T Corrected temperature sensor reading output via digital interface; range [0HEX to FFFFFHEX]

Gain\_T Gain coefficient for temperature; range [-7FFFFFHEX to 7FFFFFHEX]

T\_Raw Raw temperature reading after AZ correction; range [-7FFFFFHEX to 7FFFFFHEX]

Offset\_TOffset coefficient for temperature; range [-7FFFFFHEX to 0x7FFFFFHEX]

SOT\_T Second-order term for temperature source nonlinearity; range [-7FFFFFHEX to 7FFFFFHEX]

T\_Shift Shift for post-calibration/post-assembly offset compensation [-7FFFFFHEX]

The correction formula is best represented as a two-step process as follows:

Simplified:

$$Z_T = \frac{4 \cdot Gain\_T}{2^{23}} \cdot (T\_Raw + 4 \cdot Offset\_T) + 2^{23}$$
 (delimited to positive number range)

$$T = \frac{Z_T}{2^{23}} \cdot \left(\frac{4 \times SOT_T}{2^{23}} \cdot Z_T + 2^{23}\right) + T_shift \text{ (delimited to positive number range)}$$

Complete:

$$Z_{T} = \left[ \left[ \frac{\text{Gain\_T}}{2^{21}} \cdot \left[ T_{\text{Raw}} + 4 \cdot \text{Offset\_T} \right]_{2^{25}}^{2^{25}-1} \right]_{2^{25}}^{2^{25}-1} + 2^{23} \right]_{2^{25}-1}^{2^{25}-1}$$
Equation 21

$$T = \left[ \frac{Z_T}{2^{23}} \cdot \left[ \left[ \frac{SOT_T}{2^{21}} \cdot Z_T \right]_{2^{25}}^{2^{25}-1} + 2^{23} \right]_{2^{25}}^{2^{25}-1} + T_shift \right]_0^{2^{24}-1}$$
**Equation 22**

# 6.7 External, Extra LDO (LDOctrl) for Applications for > 5.5V

The ZSSC3240 has integrated voltage regulators that generate separate analog and digital ZSSC3240-internal voltages for any valid external supply voltage,  $V_{DD}$  (2.7V to 5.5V). For proper ZSSC3240 function, the directly applied supply voltage should not exceed the maximum  $V_{DD}$  limit.

The ZSSC3240 also supports applications with higher application-inherent supply voltages greater than 5.5V. The ZSSC3240 provides a voltage regulation signal at the LDOctrl pin and a programmable IC supply, i.e.  $V_{DD}$ -level regulation target level,  $VDD\_ldoctrl\_target$  in the SSF2 register. The use of an additional external regulator transistor (by means of, for example JFET, depletion MOSFET, or comparable) further improves the power-supply rejection ratio (PSRR); i.e., it reduces effects from the external supply voltage onto the sensor measurement results in addition to the ZSSC3240-internal regulator properties. If the external extra supply regulation is not used or needed, the respective feature should be disabled by  $disable\_ldoctrl = 1_{BIN}$ .

| VDD_ldoctrl_target |        | V Torrect Level              | Notes                          |  |
|--------------------|--------|------------------------------|--------------------------------|--|
| Bit[1]             | Bit[0] | V <sub>DD</sub> Target Level | Notes                          |  |
| 0                  | 0      | 4.8V                         |                                |  |
| 0                  | 1      | 5.0V                         |                                |  |
| 1                  | 0      | 5.2V                         | Pagemented typical cottings    |  |
| 1                  | 1      | 5.4V                         | Recommended, typical settings. |  |

Table 37. IC Supply, VDD Target Level Selection with External Voltage Regulation, External LDO

Recommendation: Use the clamping diode at  $V_{DD}$  (to FB for current-loop output configurations or to VSS in all other cases with external LDO as shown by gray dashed line in Figure 24) to ensure over-voltage protection at the initial application power-on. The external transistor, depicted as JFET¹ can be a real JFET type, or, for example, depletion MOSFET and comparable. It must be selected such that the drain-source voltage can be at least  $V_{DDext} - 5V$ .

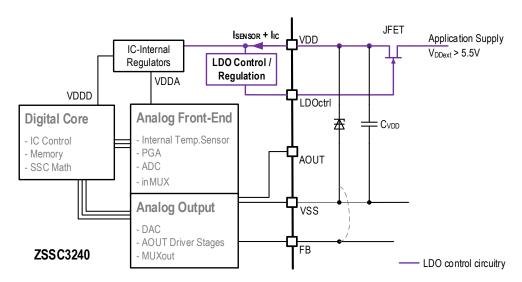


Figure 25. LDOctrl Application Topology

Table 38. External LDO Operating Conditions

| Symbol            | Parameter                                                 | Minimum | Typical | Maximum | Units |
|-------------------|-----------------------------------------------------------|---------|---------|---------|-------|
| C <sub>ctrl</sub> | Allowed parasitic capacitance at LDOctrl pin              | -       | 150     | 500     | pF    |
| $C_{VDD}$         | Buffer/filter capacitance between V <sub>DD</sub> and VSS | 80      | 100     | 120     | nF    |

Depending on the V<sub>DDext</sub>>5.5V application main supply, different external transistors can be applied, for example BSS169 (Infineon), DN3545N8 (Microchip-Supertex), MMBF4392LT1G (Fairchild), etc.

## 7. Calibration

Calibration essentially involves collecting raw signal and temperature data from the sensor-ZSSC3240 system for different known sensor-element values (i.e., for a resistive bridge or an absolute voltage source) and temperatures. This raw data can then be processed by the calibration master (assumed to be the user's computer), and the calculated calibration coefficients can then be written to on-chip memory.

Brief overview of the three mains steps involved in calibrating the ZSSC3240:

- 1. Assigning a unique identification to the ZSSC3240. This identification is written to shadow RAM and programmed in NVM. This unique identification can be stored in the two 16-bit registers dedicated to the customer ID. It can be used as an index into a database stored on the calibration PC. This database will contain all the raw values of the connected sensor-element readings and temperature readings for that part, as well as the known sensor-element measurand conditions and temperature to which the sensor-element was exposed.
- 2. Data collection. Data collection involves getting uncorrected (raw) data from the external sensor at different known measurand values and temperatures. Then this data is stored on the calibration master using the unique identification of the device as the index to the database.
- 3. Coefficient calculation and storage in NVM. After enough data points have been collected to calculate all the desired coefficients, the coefficients can be calculated by the calibration master. Then the coefficients can be programmed to the memory.
- 4. *Result.* The sensor signal and the characteristic temperature effect on output will be linearized according to the setup-dependent maximum output range.

It is essential to perform the calibration with a fixed programming setup during the data collection phase.

Strong recommendation: To prevent any accidental misprocessing, keep the sensor front-end NVM setup (registers SSF1, SSF2, SM\_config1, SM\_config2, extTemp\_config1, extTemp\_config2) stable during the entire calibration process as well as in the subsequent operation.

Note: A ZSSC3240 calibration only fits the setup used during its calibration. Changes of functional parameters after a successful calibration can decrease the precision and accuracy performance of the ZSSC3240 as well as of the entire application.

# 8. Package Outline Drawings

The package outline drawings are appended at the end of this document and are accessible from the link below. The package information is the most current data available.

https://www.idt.com/document/psc/24-vfqfpn-package-outline-drawing-40-x-40-x-085-mm-body05mm-pitchepad-25-x-25-wettable-flank-side

# 9. Marking Diagram



- 1. Line 1 is the truncated part number.
- 2. Line 2 "YYWW" are the last two digits of the year and week that the part was assembled.
- 3. Line 3 "XXXXX" denotes assembly lot number.

# 10. Ordering Information

| Orderable Part Number | Description and Package                                                                                                                                                                                                         | MSL Rating | Carrier Type | Temperature  |  |  |
|-----------------------|---------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------|------------|--------------|--------------|--|--|
| ZSSC3240CC1B          | DICE on 304µm wafer no inking                                                                                                                                                                                                   |            | Wafer Box    | -40 to 85°C  |  |  |
| ZSSC3240CC2B          | DICE on 725µm wafer no inking                                                                                                                                                                                                   |            | Wafer Box    | -40 to 85°C  |  |  |
| ZSSC3240CC5B          | DICE on 304µm wafer with inking                                                                                                                                                                                                 |            | Wafer Box    | -40 to 85°C  |  |  |
| ZSSC3240CC6B          | DICE on 725µm wafer with inking                                                                                                                                                                                                 |            | Wafer Box    | -40 to 85°C  |  |  |
| ZSSC3240CC3R          | 4 × 4 mm² 24-QFN                                                                                                                                                                                                                | MSL1       | 13 inch Reel | -40 to 85°C  |  |  |
| ZSSC3240CI1B          | DICE on 304µm wafer no inking                                                                                                                                                                                                   |            | Wafer Box    | -40 to 125°C |  |  |
| ZSSC3240CI2B          | DICE on 725µm wafer no inking                                                                                                                                                                                                   |            | Wafer Box    | -40 to 125°C |  |  |
| ZSSC3240CI5B          | DICE on 304µm wafer with inking                                                                                                                                                                                                 |            | Wafer Box    | -40 to 125°C |  |  |
| ZSSC3240CI6B          | DICE on 725µm wafer with inking                                                                                                                                                                                                 |            | Wafer Box    | -40 to 125°C |  |  |
| ZSSC3240Cl3R          | 4 × 4 mm² 24-QFN                                                                                                                                                                                                                | MSL1       | 13 inch Reel | -40 to 125°C |  |  |
| ZSSC3240CI3W          | 4 × 4 mm² 24-QFN                                                                                                                                                                                                                | MSL1       | 7 inch Reel  | -40 to 125°C |  |  |
| ZSSC3240CL1B          | DICE on 304µm wafer no inking, pre-configured for Current-Loop                                                                                                                                                                  |            | Wafer Box    | -40 to 125°C |  |  |
| ZSSC3240CL3R          | 4 × 4 mm² 24-QFN, pre-configured for Current-Loop                                                                                                                                                                               | MSL1       | 13 inch Reel | -40 to 125°C |  |  |
| ZSSC3240KIT           | Modular ZSSC3240 SSC Evaluation Kit including three interconnecting boards, five ZSSC3240 24-VFPQFN samples, and cable. Software is available for download on <a href="https://www.IDT.com/ZSSC3240">www.IDT.com/ZSSC3240</a> . |            |              |              |  |  |

# 11. Glossary

| Term   | Description                                                                                          |
|--------|------------------------------------------------------------------------------------------------------|
| A2D    | Analog-to-Digital                                                                                    |
| ACK    | Acknowledge (interface's protocol indicator for successful data/command transfer)                    |
| ADC    | Analog-to-Digital Converter or Conversion                                                            |
| AGND   | Analog-Ground, ZSSC3240-internal VDDA <sub>int</sub> /2                                              |
| AZ     | Auto-Zero (unspecific)                                                                               |
| AZS    | Auto-Zero Measurement for (External) Sensor Path                                                     |
| AZT    | Auto-Zero Measurement for (External or Internal) Temperature Path                                    |
| CLK    | Clock                                                                                                |
| DAC    | Digital-to-Analog Converter or Conversion                                                            |
| EMC    | Electromagnetic Compatibility                                                                        |
| EMI    | Electromagnetic Immision (Immunity), i.e. immunity on spuriously coupled high-frequency disturbances |
| EOC    | End of Conversion                                                                                    |
| FSO    | Full Scale Output (value in percent relative to the ADC maximum output code; resolution dependent)   |
| LFSR   | Linear Feedback Shift Register                                                                       |
| LSB    | Least Significant Bit                                                                                |
| MSB    | Most Significant Bit                                                                                 |
| MSL    | Moisture Sensitivity Level                                                                           |
| NACK   | Not Acknowledge (interface's protocol indicator for unsuccessful data/command transfer)              |
| NVM    | Nonvolatile Memory                                                                                   |
| Op amp | Operating Amplifier                                                                                  |
| PGA    | Programmable Gain Amplifier                                                                          |
| POR    | Power-On Reset                                                                                       |
| PPT    | Parts-per-Thousand, 1PPT=1/1000                                                                      |
| PSRR   | Power Supply (Disturbance) Rejection Ratio                                                           |
| PTC    | Positive Temperature Coefficient (sensing element)                                                   |
| S      | SSC-corrected Sensor Readout / Result                                                                |
| SM     | Sensor Measurement                                                                                   |
| SOT    | Second Order Term                                                                                    |
| SSF    | Smart-Sensor Function (specific NVM registers)                                                       |
| Т      | SSC-corrected (extra) Temperature Readout / Result                                                   |
| TC     | Temperature Coefficient                                                                              |

# 12. Revision History

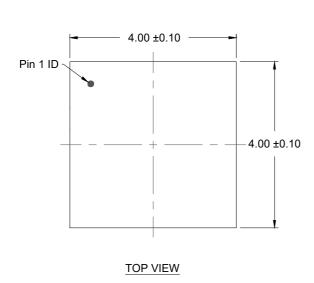
| Revision Date | Description of Change                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                               |
|---------------|-----------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------|
| Dec.12.24     | Clarifying distinction between load resistor and filter circuitry in Table 30                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                       |
| Feb.2.24      | <ul> <li>QFN Exposed PAD recommendation changed</li> <li>AOUT short circuit information added in pin description</li> <li>Additional note to DAC-Diagnostic</li> </ul>                                                                                                                                                                                                                                                                                                                                                                                                                              |
| Sep. 19.23    | AOUT short circuit information added in pin description Additional note to DAC-Diagnostic                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                           |
| Jul.14.23     | Threshold value correction of V <sub>high,I2C;</sub> V <sub>low,I2C</sub> and V <sub>high,SPI;</sub> V <sub>low,SPI</sub>                                                                                                                                                                                                                                                                                                                                                                                                                                                                           |
| Apr.28.21     | Description for T <sub>EXT</sub> corrected                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                          |
| Nov.27.20     | <ul> <li>Explanations for EOC</li> <li>New product version ZSSC3240CL* pre-configured NVM for current-loop applications</li> <li>Correction of Marking Diagram corrected for "3240C"</li> <li>slots_S corrected to be up to 15<sub>DEC</sub>, slots_AZS definition updated</li> <li>Added note, not to apply sensor-open/short diagnostic checks together with Thermopile sensors</li> <li>Corrected Equation 1</li> <li>Reduced conversion time for internal temp. sensor and typ. SSC-conversion time</li> <li>Added figure and explanation for digital output behavior in cyclic mode</li> </ul> |
| Mar.13.20     | Initial release                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                     |

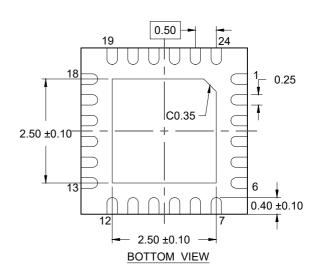
# **Package Outline Drawing**

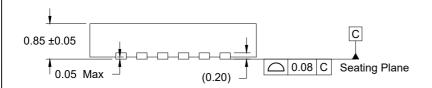


PSC-4192-04 NLG24S1

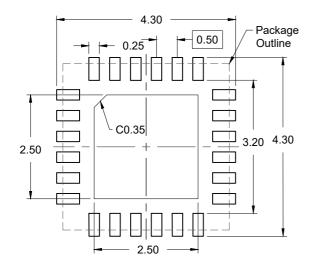
24-VFQFPN 4.0 x 4.0 x 0.85 mm Body, 0.5mm Pitch Rev.04, May 07, 2025







SIDE VIEW



RECOMMENDED LAND PATTERN (PCB Top View, NSMD Design)

#### NOTES:

- 1. JEDEC compatible.
- 2. All dimensions are in mm and angles are in degrees.
- 3. Use ±0.05 mm for the non-toleranced dimensions.
- 4. Numbers in ( ) are for references only.
- 5. Wettable flank (side plate).

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